

A B C D E

## COMPAL CONFIDENTIAL

MODEL NAME : VAQ10

PCB NO : LA-9771P

BOM P/N : 4319MF31L01(TPM HDMI LVDS)

4319MF31L02(TPM HDMI QHD)

4319MF31L03(DTP HDMI LVDS)

4319MF31L04(DTP HDMI QHD)

GPIO MAP:

## Diesel 15"

REV : 0.2 (X01)

2013.XX.XX

1@ : LVDS panel

2@ : eDP(QHD) panel

EMC@ : EMI/ESD/RF part

@ : Nopop Component

CONN@ : Connector Component

CXDP@,PXDP@ : Total debug Component (pop them until ST)

MB PCB	Description
DAA0006I000	PCB OMF LA-9771P REVO MB

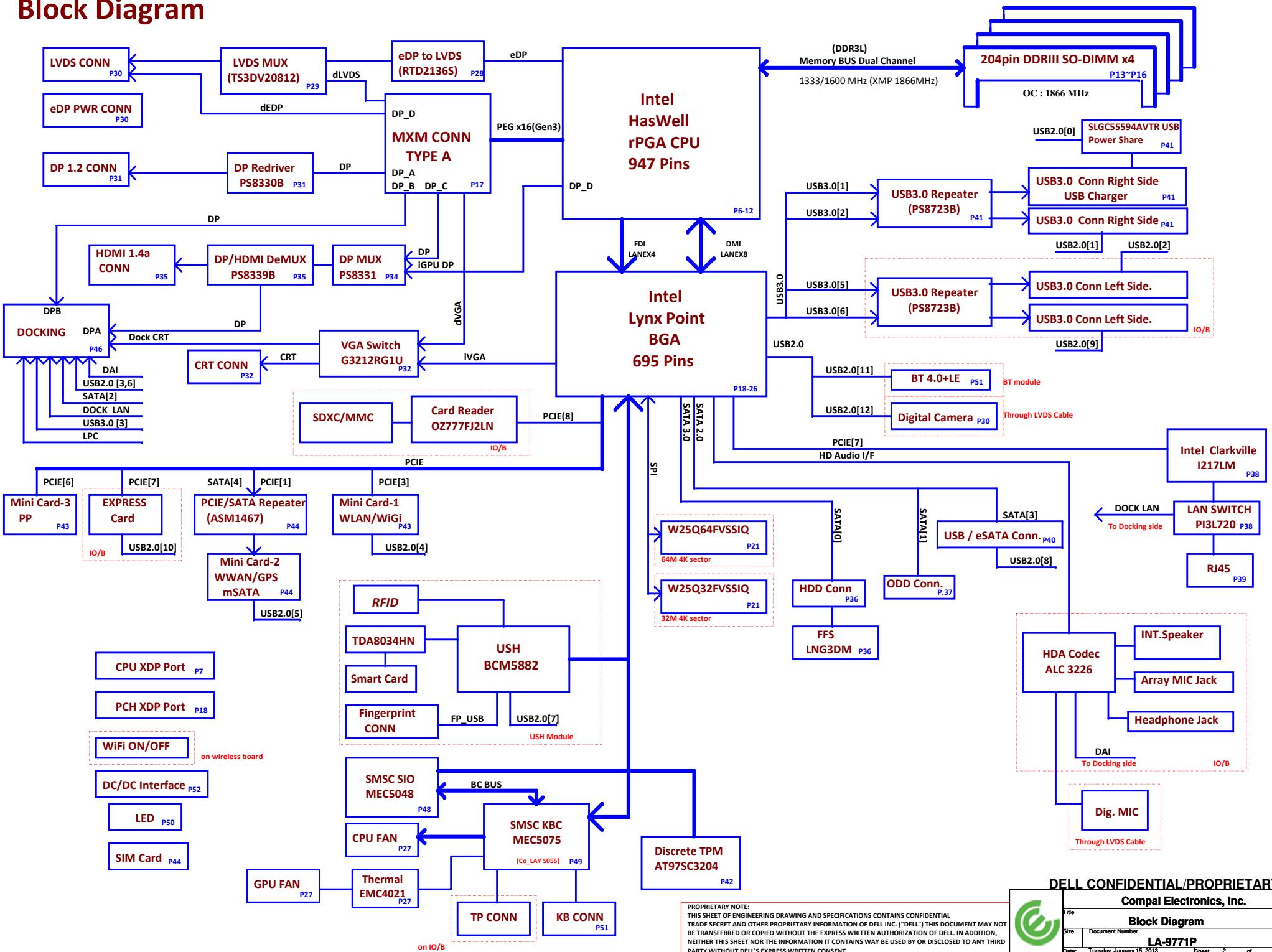
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

**DELL CONFIDENTIAL/PROPRIETARY**

Compal Electronics, Inc.	
Cover Sheet	
Size	Document Number
	LA-9771P
Date:	Tuesday, January 15, 2013
Sheet	1 of 65

**E**

# Block Diagram



## POWER STATES

Signal State \ State	SLP S3#	SLP S4#	SLP S5#	S4 STATE#	SLP M#	ALWAYS PLANE	M PLANE	SUS PLANE	RUN PLANE	CLOCKS
S0 (Full ON) / M0	HIGH	HIGH	HIGH	HIGH	HIGH	ON	ON	ON	ON	ON
S3 (Suspend to RAM) / M1	LOW	HIGH	HIGH	HIGH	HIGH	ON	ON	ON	OFF	OFF
S4 (Suspend to DISK) / M1	LOW	LOW	HIGH	LOW	HIGH	ON	ON	OFF	OFF	OFF
S5 (SOFT OFF) / M1	LOW	LOW	LOW	LOW	HIGH	ON	ON	OFF	OFF	OFF
S3 (Suspend to RAM) / M-OFF	LOW	HIGH	HIGH	HIGH	LOW	ON	OFF	ON	OFF	OFF
S4 (Suspend to DISK) / M-OFF	LOW	LOW	HIGH	LOW	LOW	ON	OFF	OFF	OFF	OFF
S5 (SOFT OFF) / M-OFF	LOW	LOW	LOW	LOW	LOW	ON	OFF	OFF	OFF	OFF

## PM TABLE

power plane \ State	+5V_ALW +3.3V_ALW2 +3.3V_ALW +3.3V_ALW_PCH +3.3V_RTC_LDO	+3.3V_SUS +1.35V_MEM	+5V_RUN +3.3V_RUN +1.5V_RUN +0.675V_DDR_VTT +VCC_CORE +1.05V_RUN	+3.3V_M +1.05V_M	+3.3V_M +1.05V_M (M-OFF)
S0	ON	ON	ON	ON	ON
S3	ON	ON	OFF	ON	OFF
S5 S4/AC	ON	OFF	OFF	ON	OFF
S5 S4/AC don't exist	OFF	OFF	OFF	OFF	OFF

## Stack up

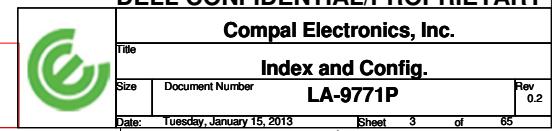
Layer No.	Name	Er	Material	Thickness (Material SPEC.) Unit : mil	Thickness (Actuality) Unit : mil
			SolderMask	IT-158	0.50
			Add Plating		1.00
1	Top	3.7	Prepreg	0.5oz	0.65
2	GND1	3.7	Copper foil	1oz	1.35
3	Sig 1	4.1	Core	4mil	3.91
4	GND/PWR	4.1	Preprep	1080Hx2	8.26
5	Sig 2	3.7	Copper foil	1oz	1.35
6	Sig 3	3.8	Preprep	1080Hx2	4.80
7	GND/PWR	4.1	Copper foil	1oz	1.35
8	Sig 4	3.7	Preprep	2116Mx2	8.26
9	GND 3	3.7	Copper foil	1oz	1.35
10	Bottom	3.7	Preprep	0.5oz	0.65
			Add Plating		1.00
			SolderMask		0.50
Overall Thickness (1.45mm ± 10%)		57.09		57.26000	1.454404

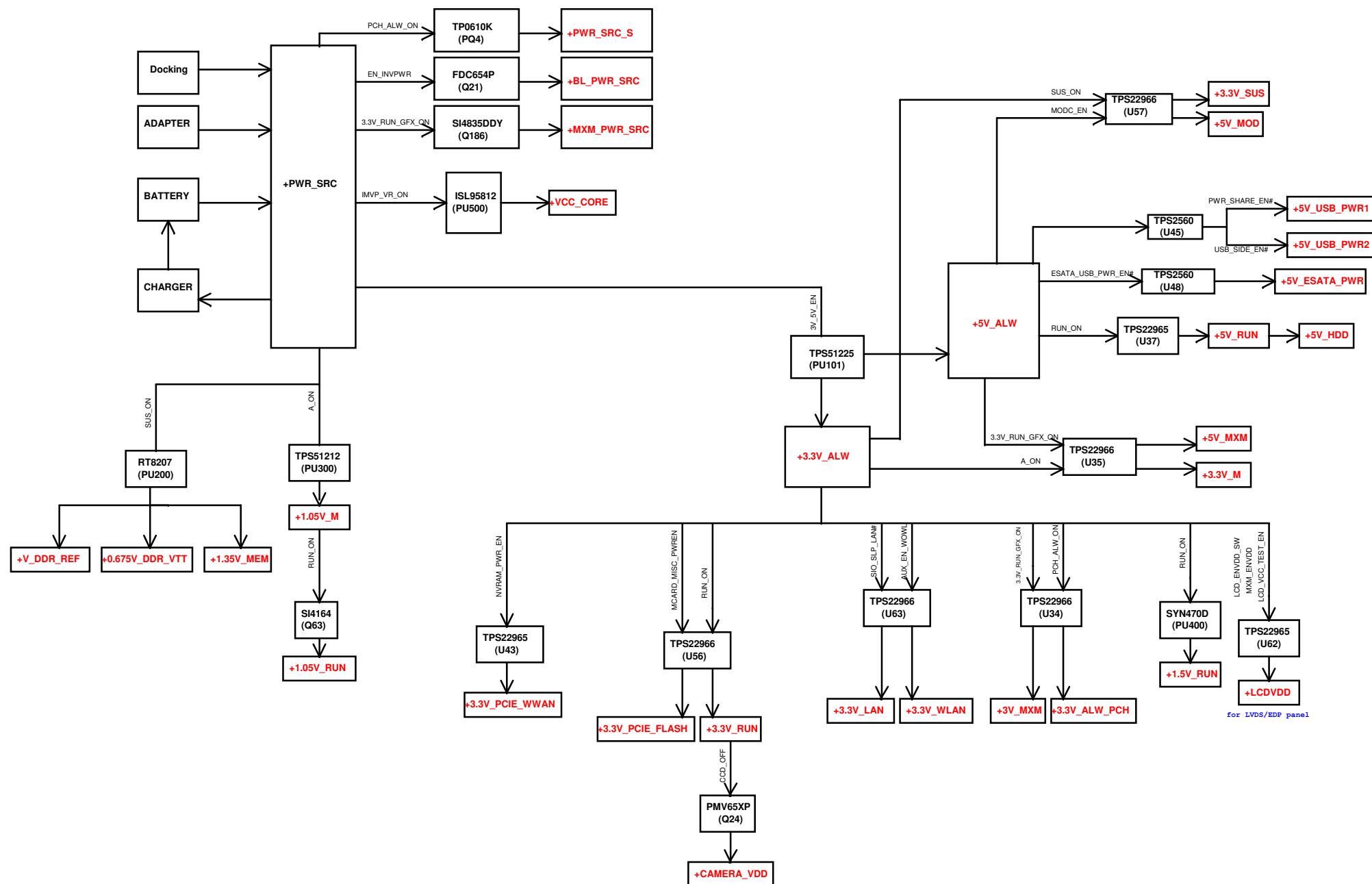
SATA	DESTINATION
SATA 0	HDD1
SATA 1	ODD
SATA 2	Dock
SATA 3	ESATA
SATA 4	mSATA
SATA 5	NA

PCH	USB PORT#	DESTINATION
	0	JUSB1 (Ext Right Side)
	1	JUSB2 (Ext Right Side)
	2	IO Board- JUSB1 (Ext Left Side)
	3	Docking USB3.0
	4	WLAN/WIGIG
	5	WWAN/GPS/LTE/UWB/mSATA
	6	Docking USB 2.0
	7	USH
	8	ESATA
	9	IO Board- JUSB2 (Ext Left Side)
	10	Express Card
	11	NA
	12	Carmera
	13	NA
USH	0	BIO
	1	NA

PCI EXPRESS	DESTINATION
Lane 1	mSATA/WWAN
Lane 2	10/100/1G LOM
Lane 3	MINI CARD-2 (WLAN)
Lane 4	NA
Lane 5	NA
Lane 6	NA
Lane 7	EXPRESS CARD
Lane 8	MMI(Card reader)

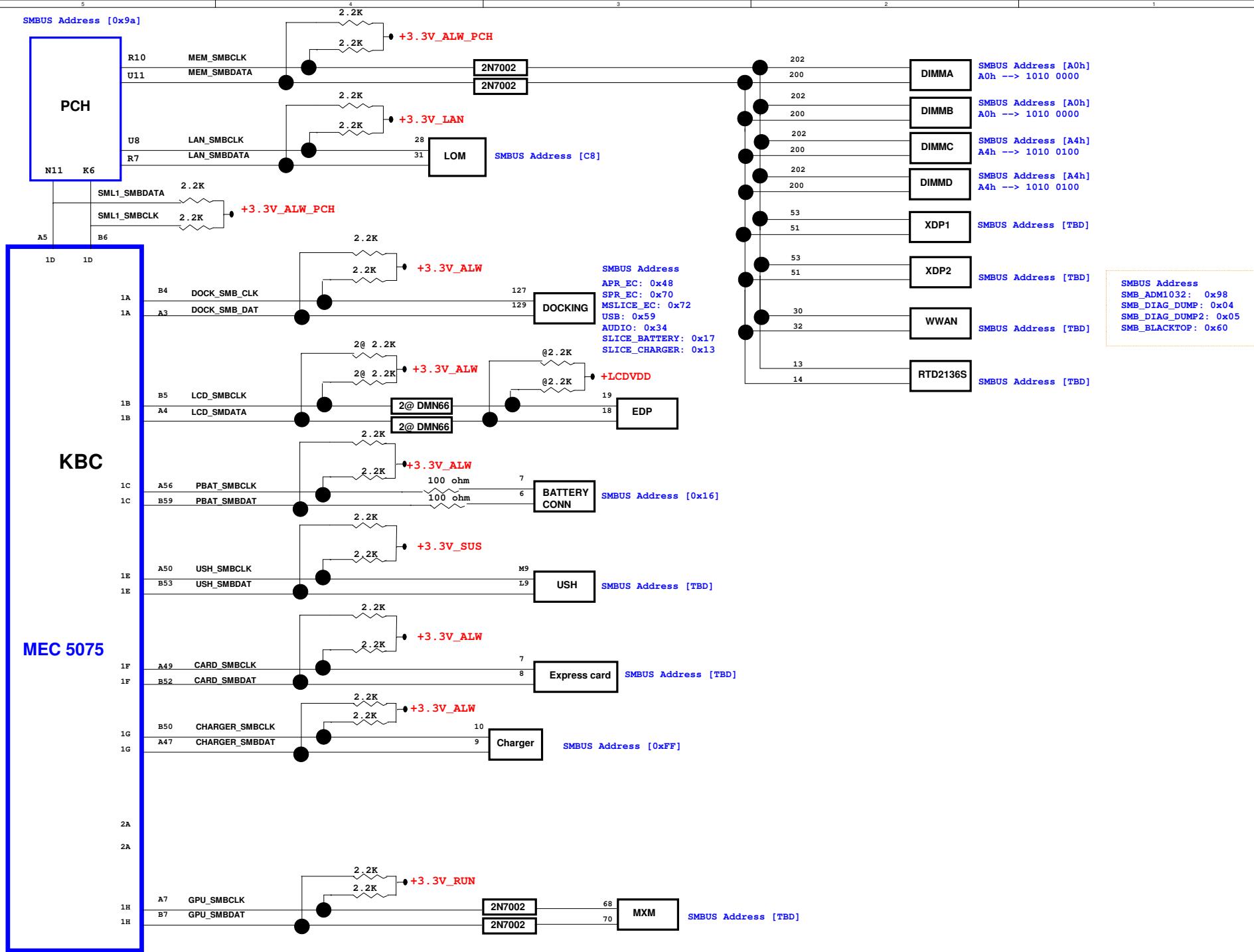
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

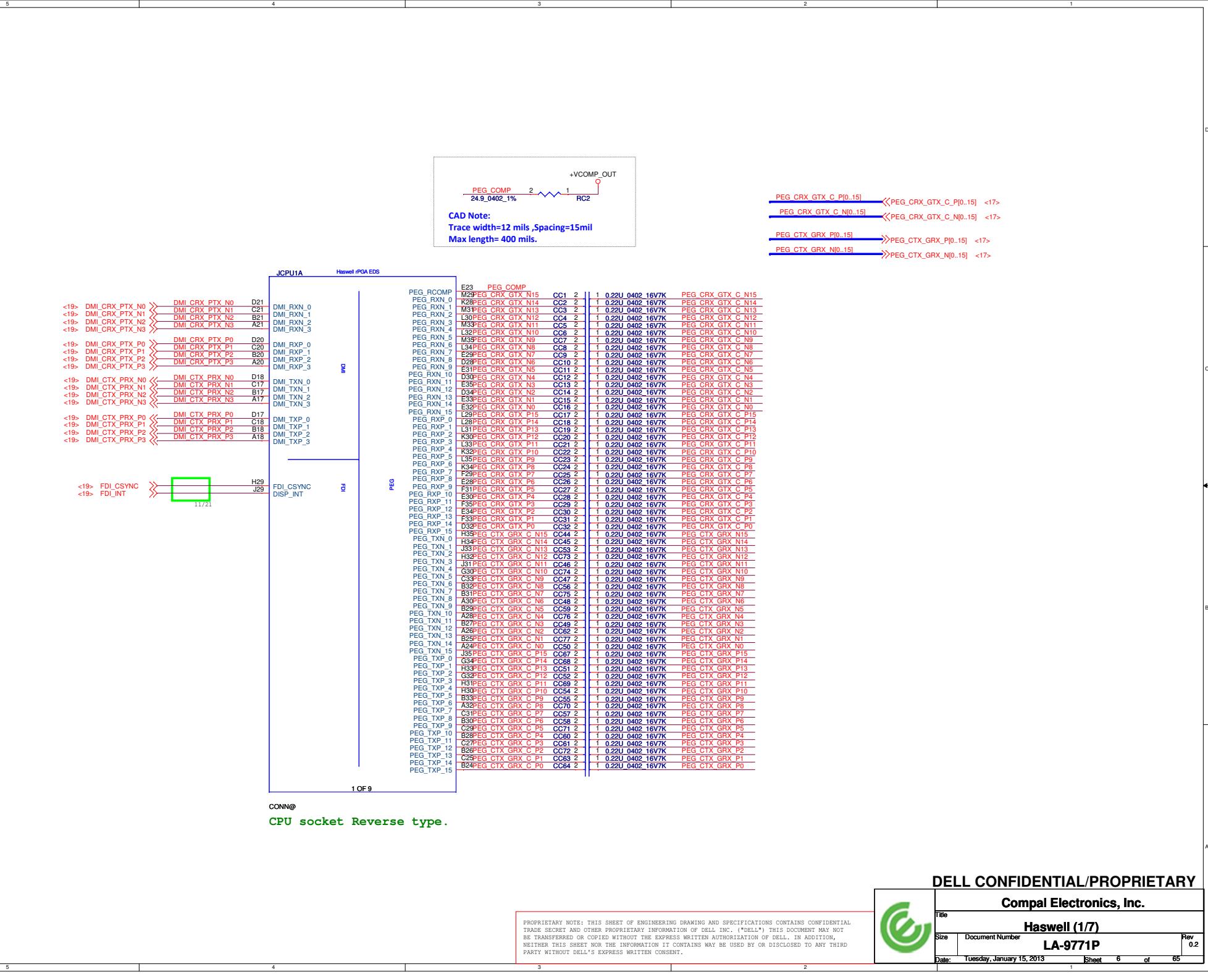




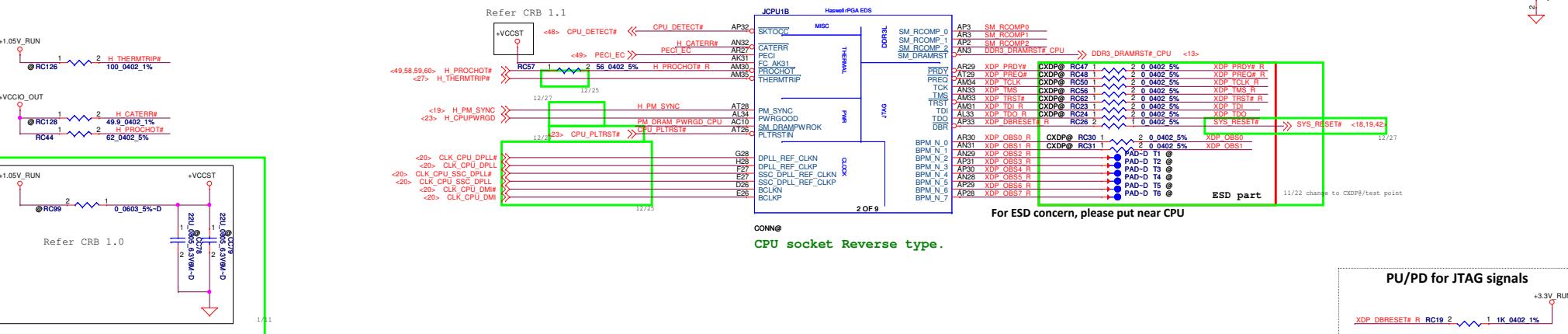
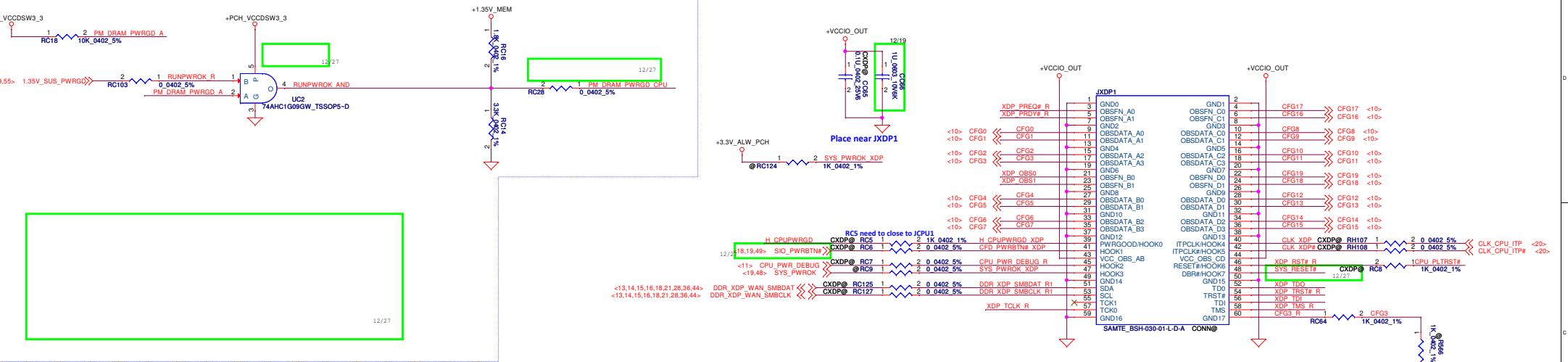
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY	
Compal Electronics, Inc.	
Power Rail	LA-9771P
Document Number	Rev. 0.2
Date: Tuesday, January 15, 2013	Page 4 of 65





## SM\_DRAMPWROK with DDR Power Gating Topology

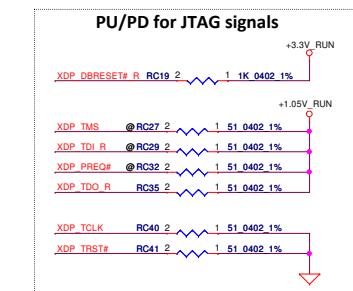


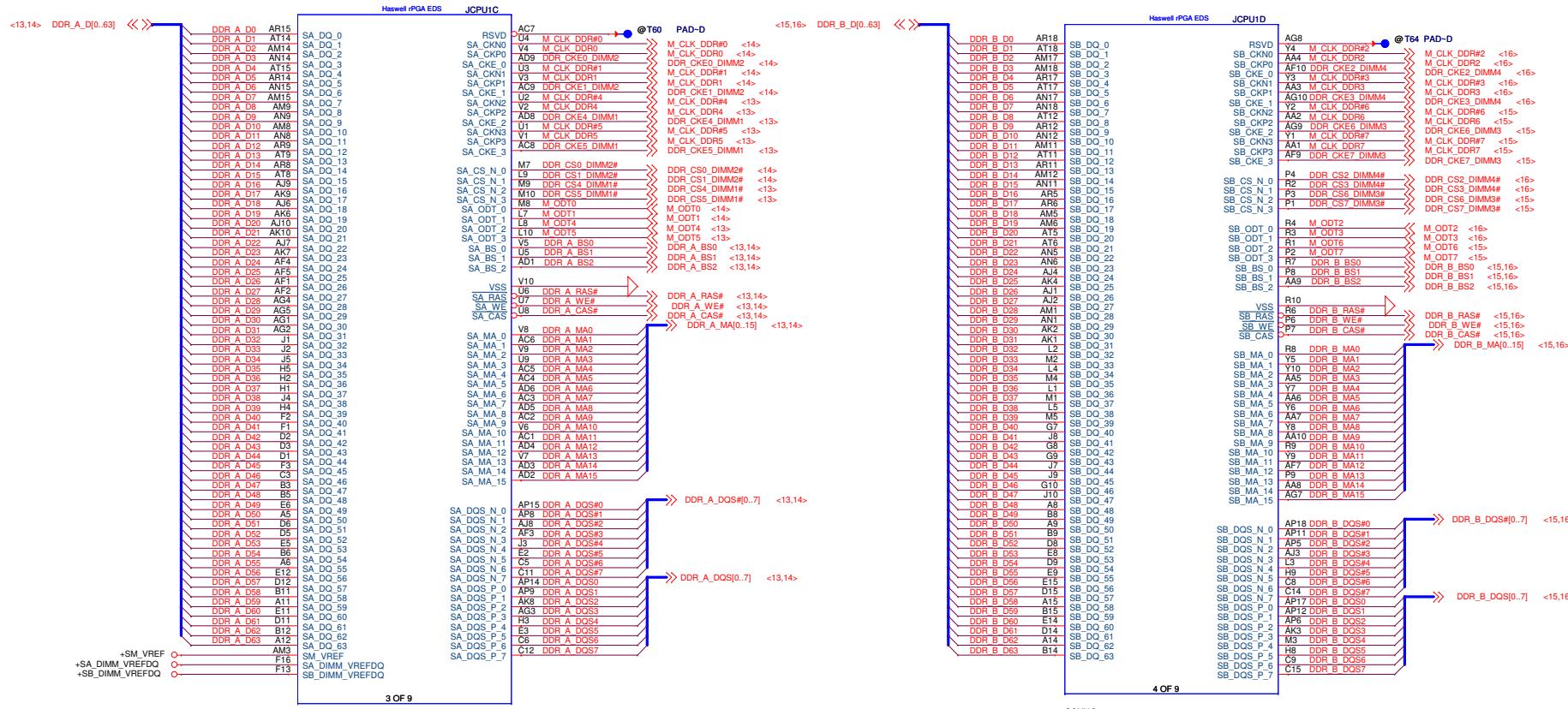
### **Buffered reset to CPU**

**CAD Note:**  
Avoid stub in the PWRGD path

DDR3 COMPENSATION SIGNAL

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELI'S EXPRESS WRITTEN CONSENT.





CONN@  
CBII socket Reverse type

CPU socket Reverse type.

DELL CONFIDENTIAL / PROPRIETARY



Compal Electronics, Inc.

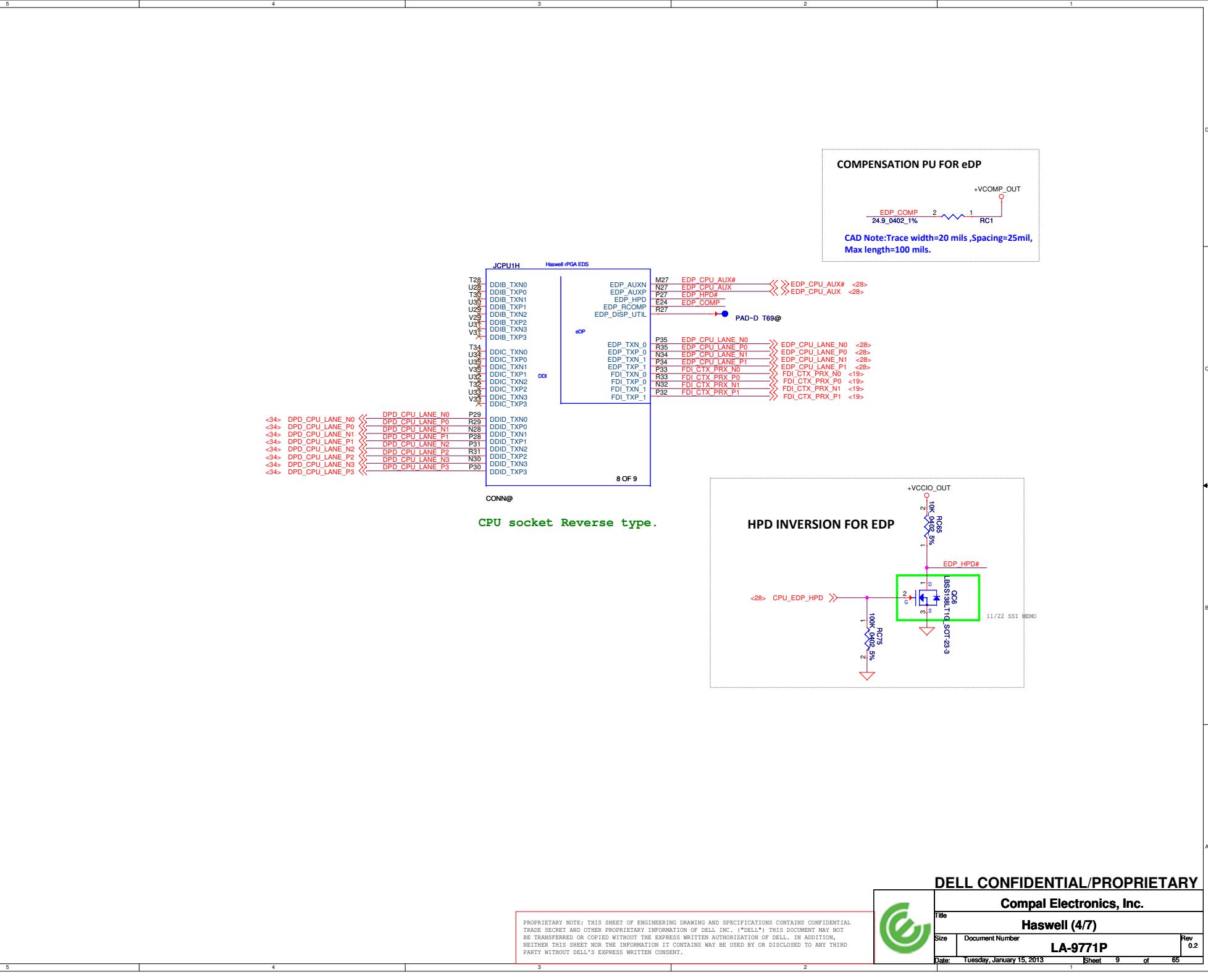
Haswell (3/4)

Document Number  
LA 8771B

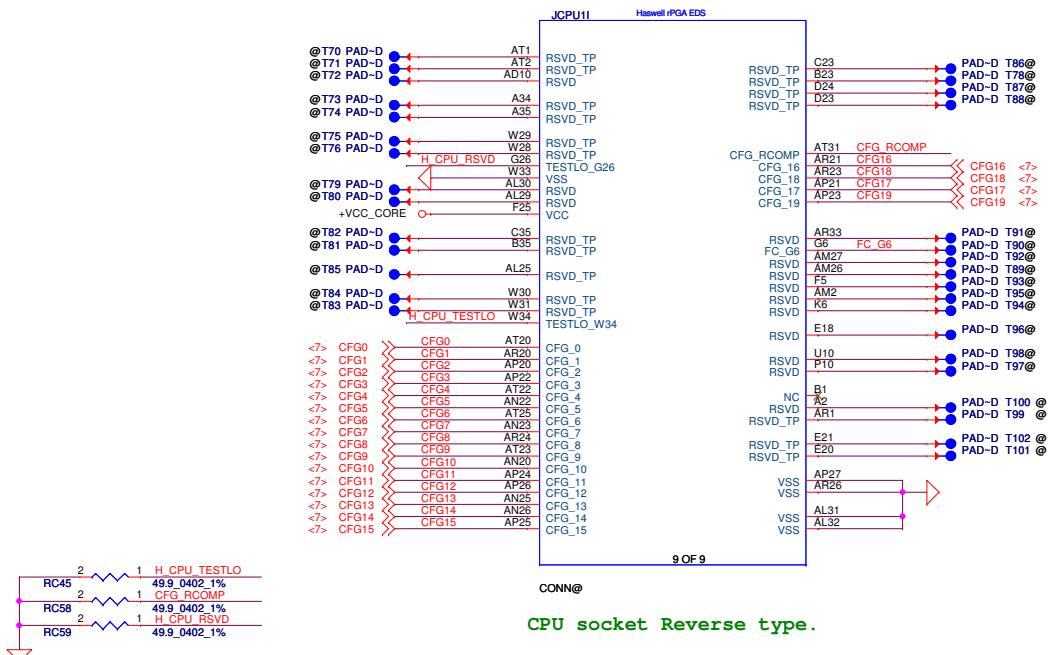
LA-977

Wednesday, January 16, 2013 Street -

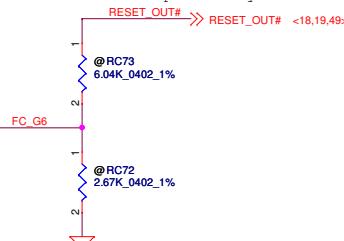
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



# CFG STRAPS for CPU

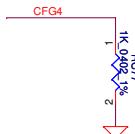


Note: Reserve this circuit for future compatibility



PEG Static Lane Reversal - CFG2 is for the 16x

CFG2	1:(Default) Normal Operation; Lane # definition matches socket pin map definition 0:Lane Reversed
------	--



Display Port Presence Strap

CFG4	1 : Disabled; No Physical Display Port attached to Embedded Display Port 0 : Enabled; An external Display Port device is connected to the Embedded Display Port
------	--

12/26

PCIE Port Bifurcation Straps(PEG)

CFG[6:5]	11: (Default) x16 - Device 1 functions 1 and 2 disabled 10: x8, x8 - Device 1 function 1 enabled ; function 2 disabled 01: Reserved - (Device 1 function 1 disabled ; function 2 enabled) 00: x8,x4,x4 - Device 1 functions 1 and 2 enabled
----------	--

12/26

PEG DEFER TRAINING

CFG7	1: (Default) PEG Train immediately following xxRESETB de assertion 0: PEG Wait for BIOS for training
------	---

12/26

DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

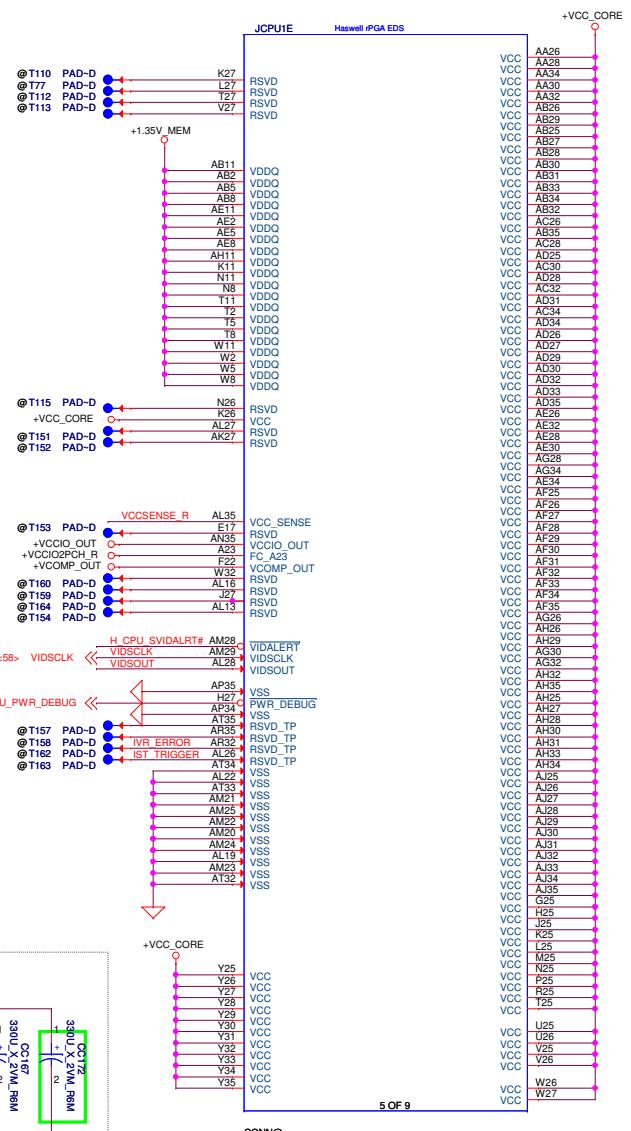
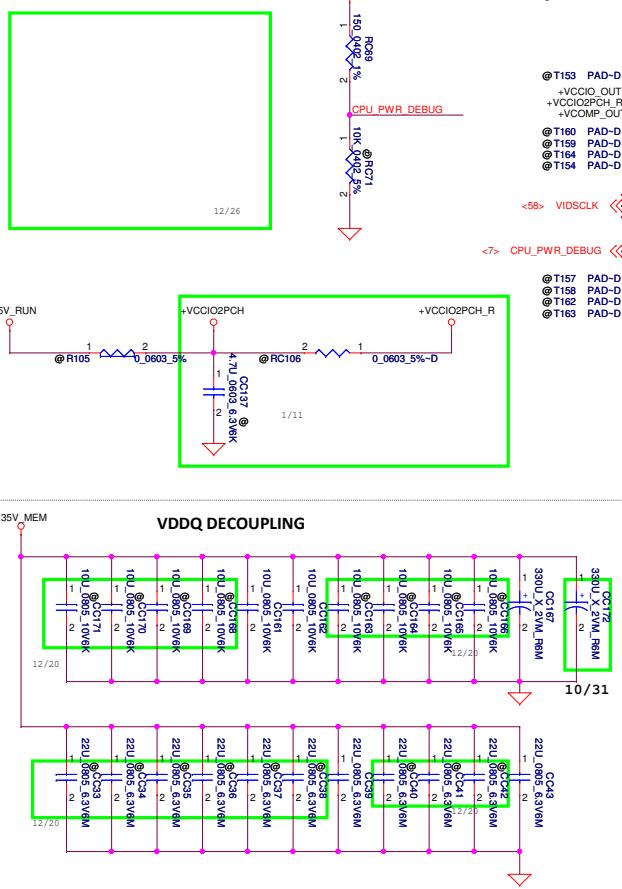
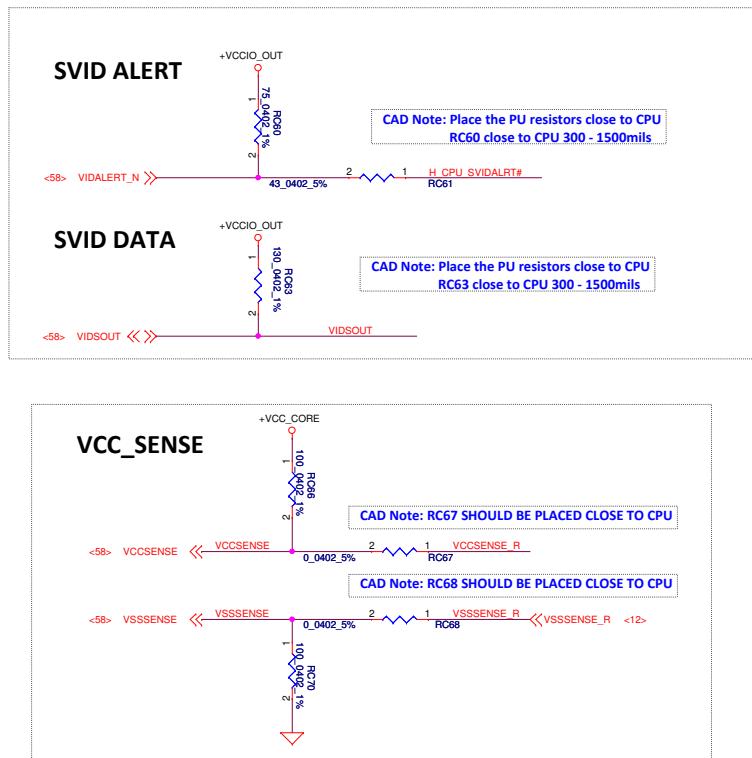
Haswell (5/7)

LA-9771P



Title: Haswell (5/7)  
Size: Document Number: LA-9771P Rev: 0.2  
Date: Tuesday, January 15, 2013 Sheet 10 of 65

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



DELL CONFIDENTIAL/PROPRIETARY



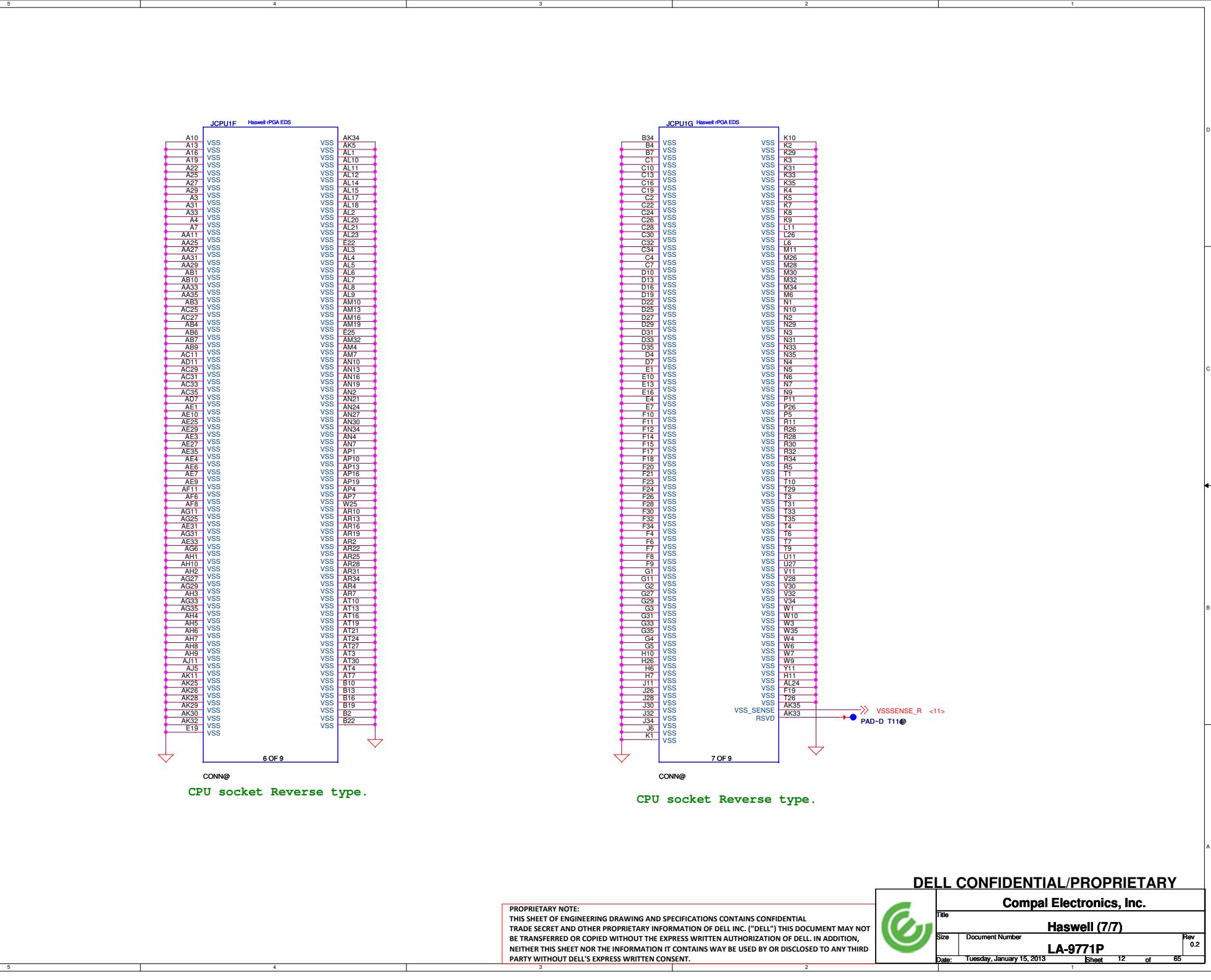
**Compal Electronics, Inc.**

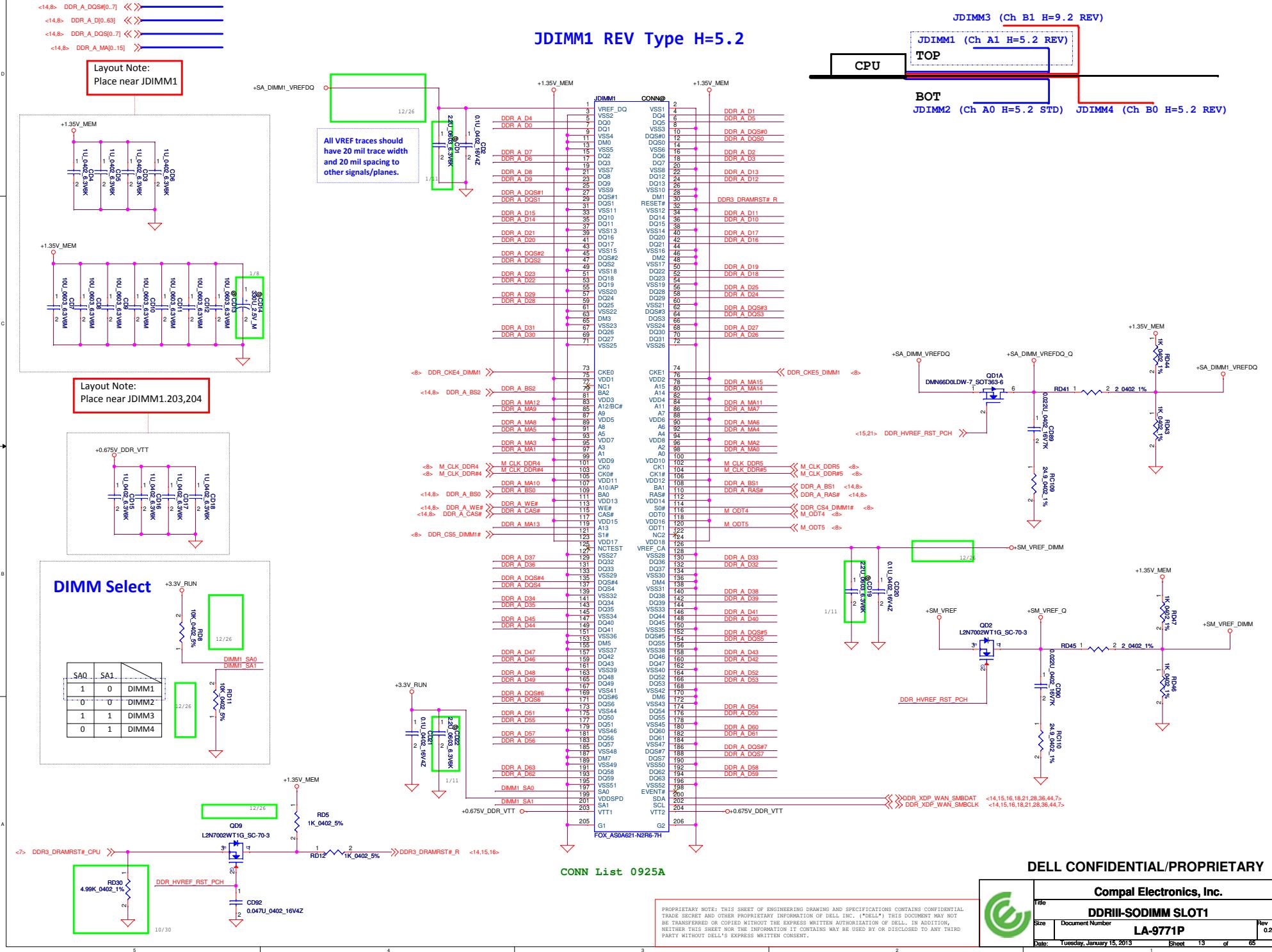
Haswell (6/7)

LA-9771P

2013 Sheet 1

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

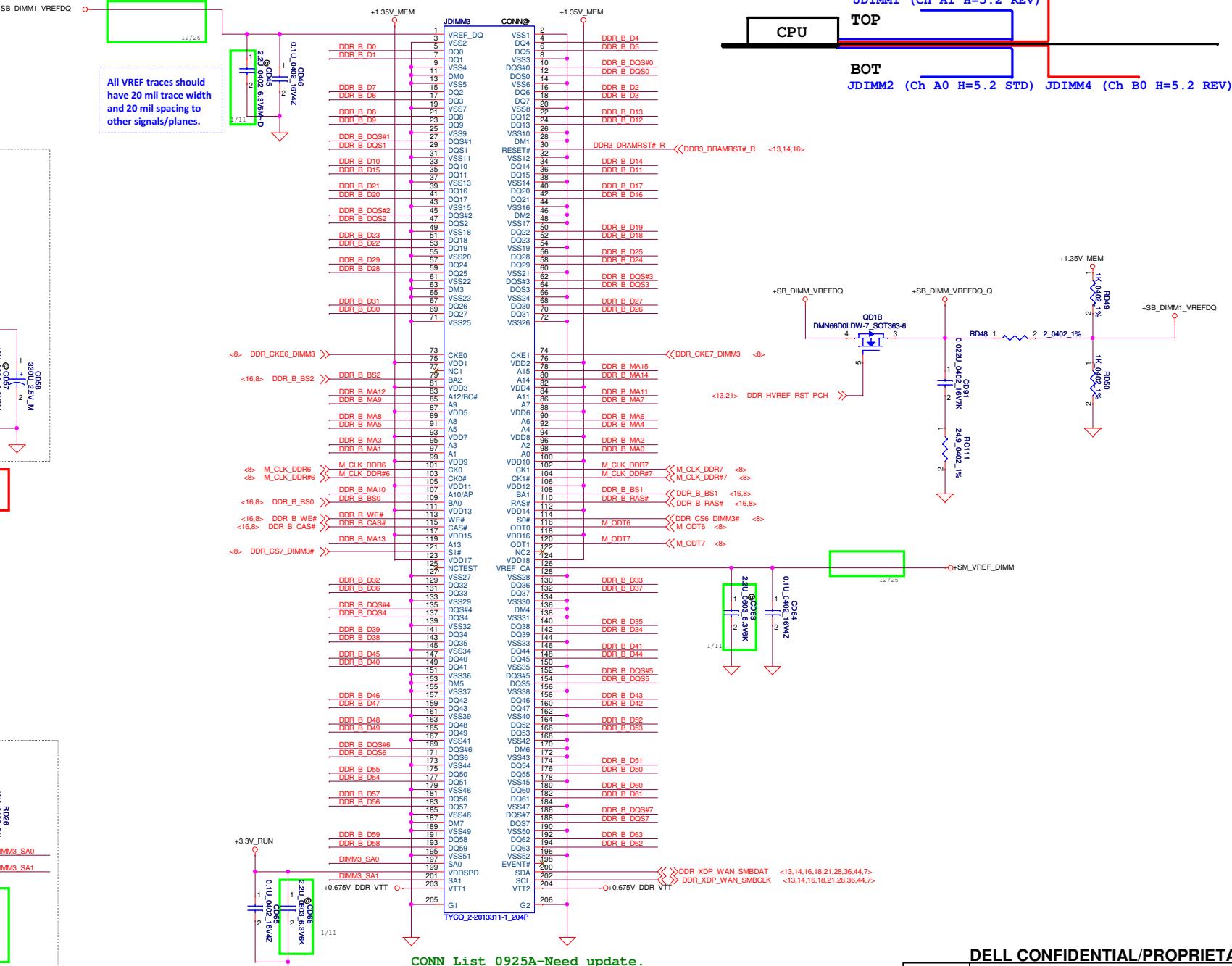






# JDIMM3 REV Type H=9.2

<16.8> DDR\_B\_DQS#(0..7) <>  
<16.8> DDR\_B\_D[0..63] <>  
<16.8> DDR\_B\_DQS0(0..7) <>  
<16.8> DDR\_B\_MA[0..15] >



DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

DDRIII-SODIMM SLOT3

LA-9771P

Rev 0.2

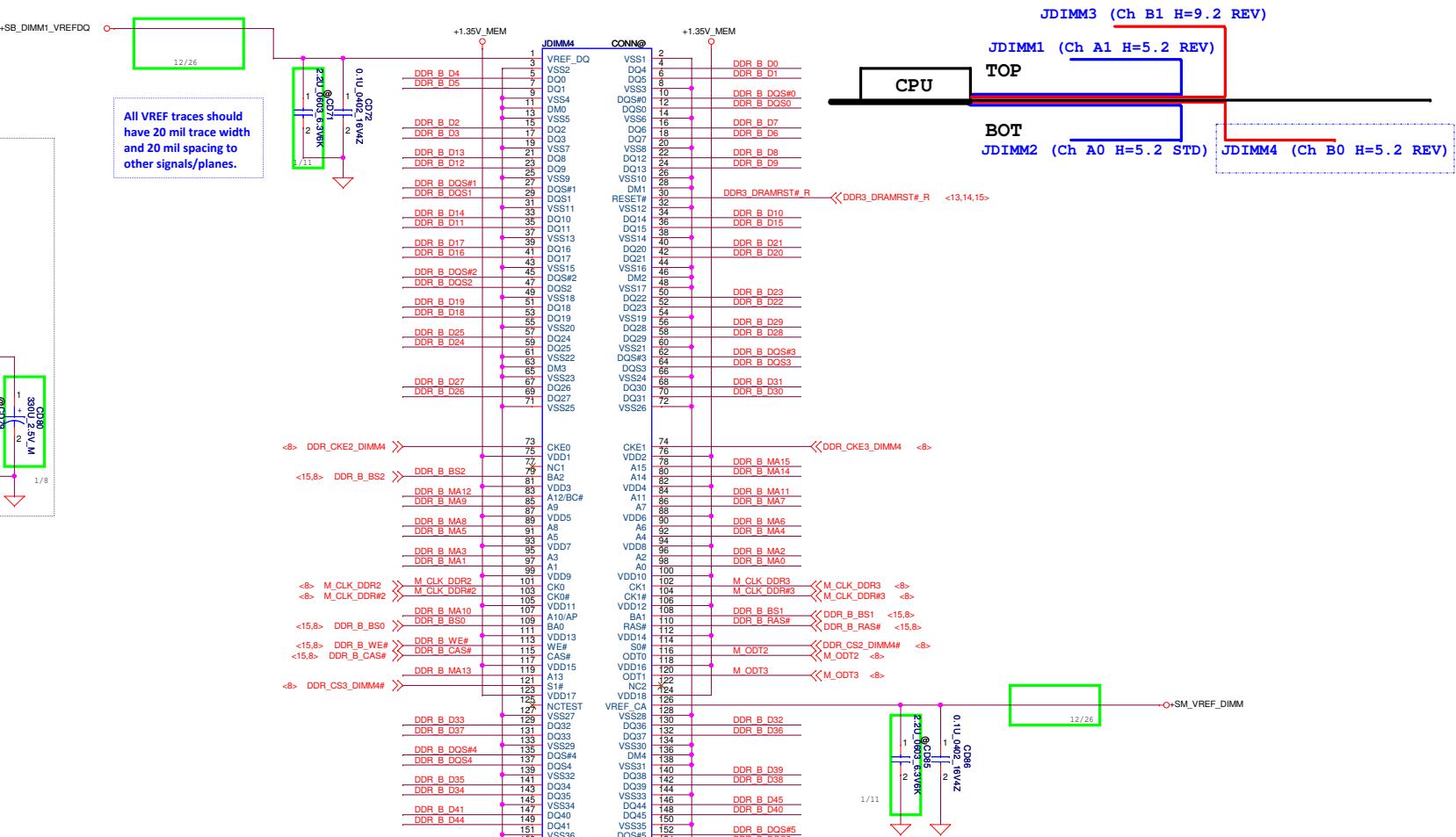
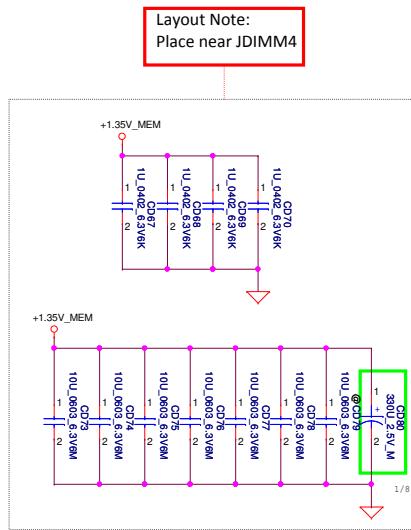
Date: Tuesday, January 15, 2013

Sheet 15 of 69

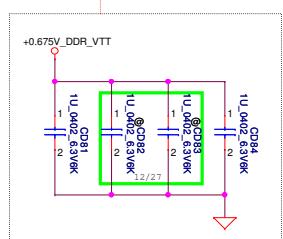
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE REPRODUCED OR COPIED IN WHOLE OR IN PART WITHOUT WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

<15,8> DDR\_B\_DQS#(0..7] <>  
 <15,8> DDR\_B\_D[0..63] <>  
 <15,8> DDR\_B\_DQS(0..7] <>  
 <15,8> DDR\_B\_MA[0..15] <>

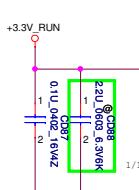
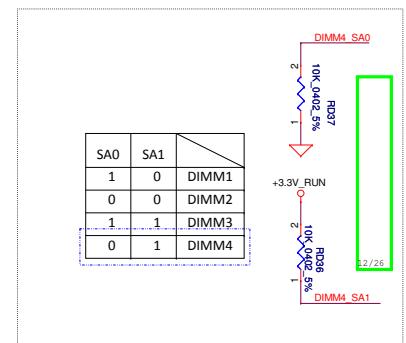
## JDIMM4 REV Type H=5.2



**Layout Note:** Place near JDIMM4.Pin 203,204



## DIMM Select



CONN List 0925A

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE REPRODUCED OR COPIED EXCEPT WITH THE WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

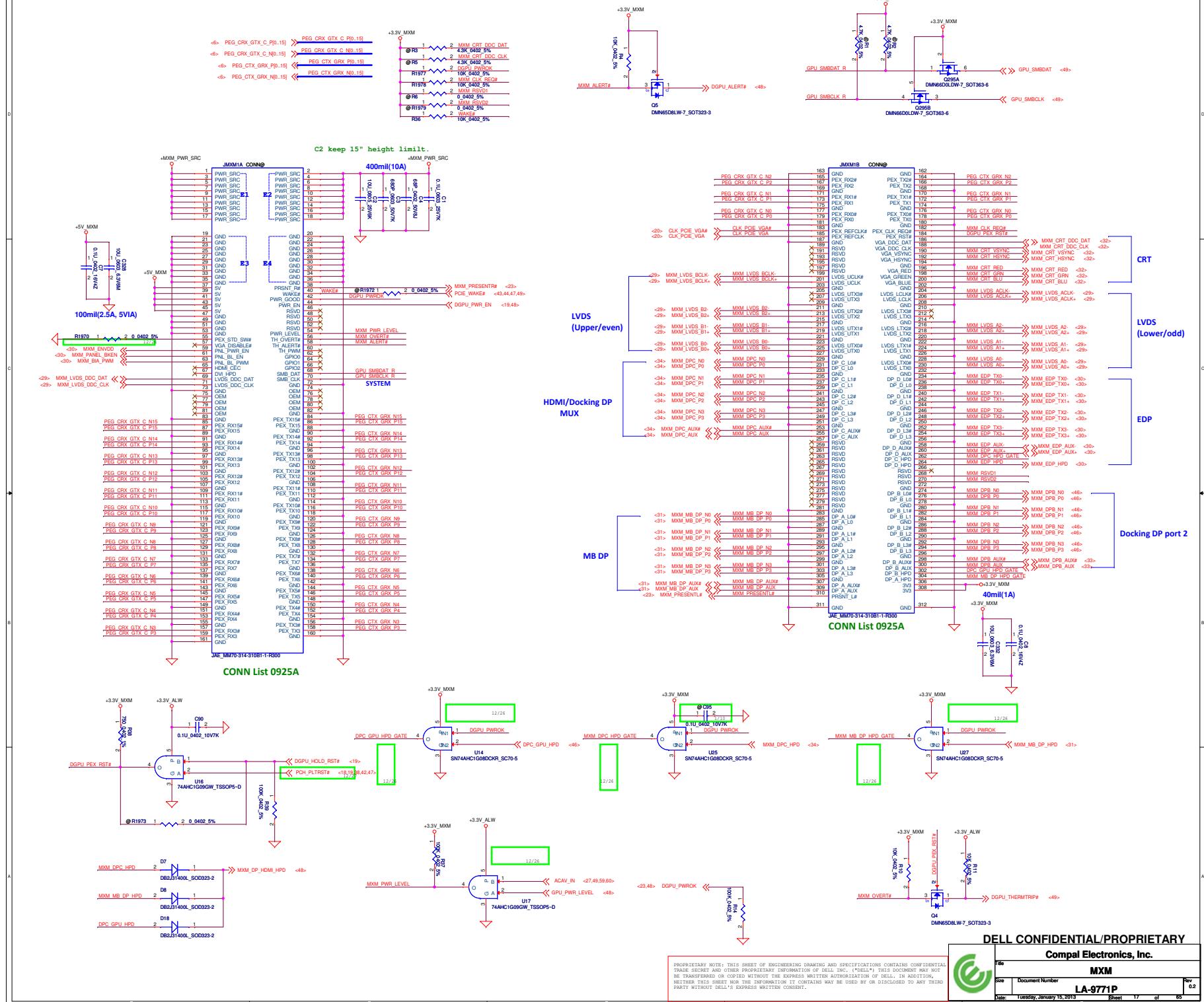
DELL CONFIDENTIAL/PROPRIETARY

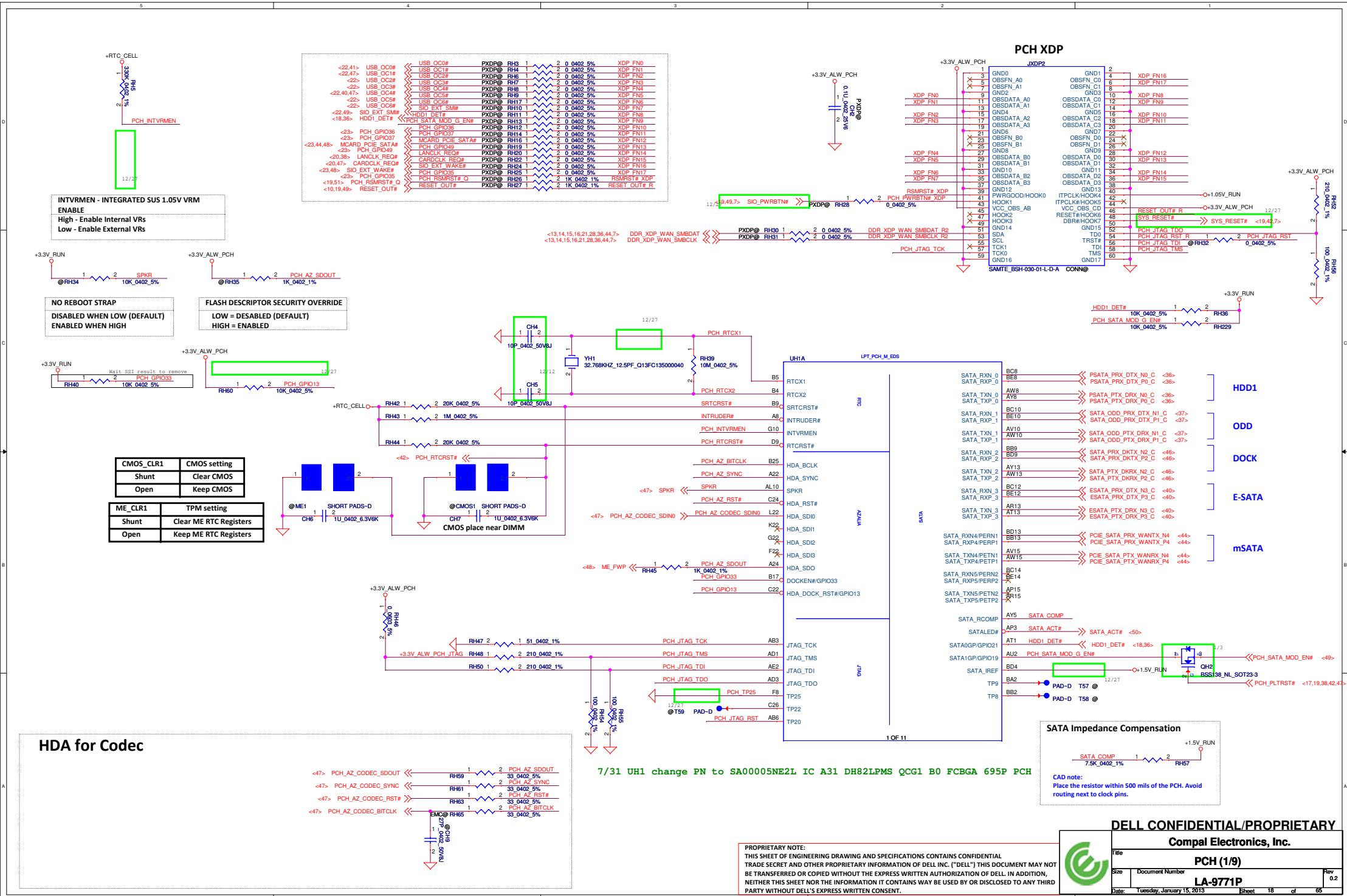
Compal Electronics, Inc.

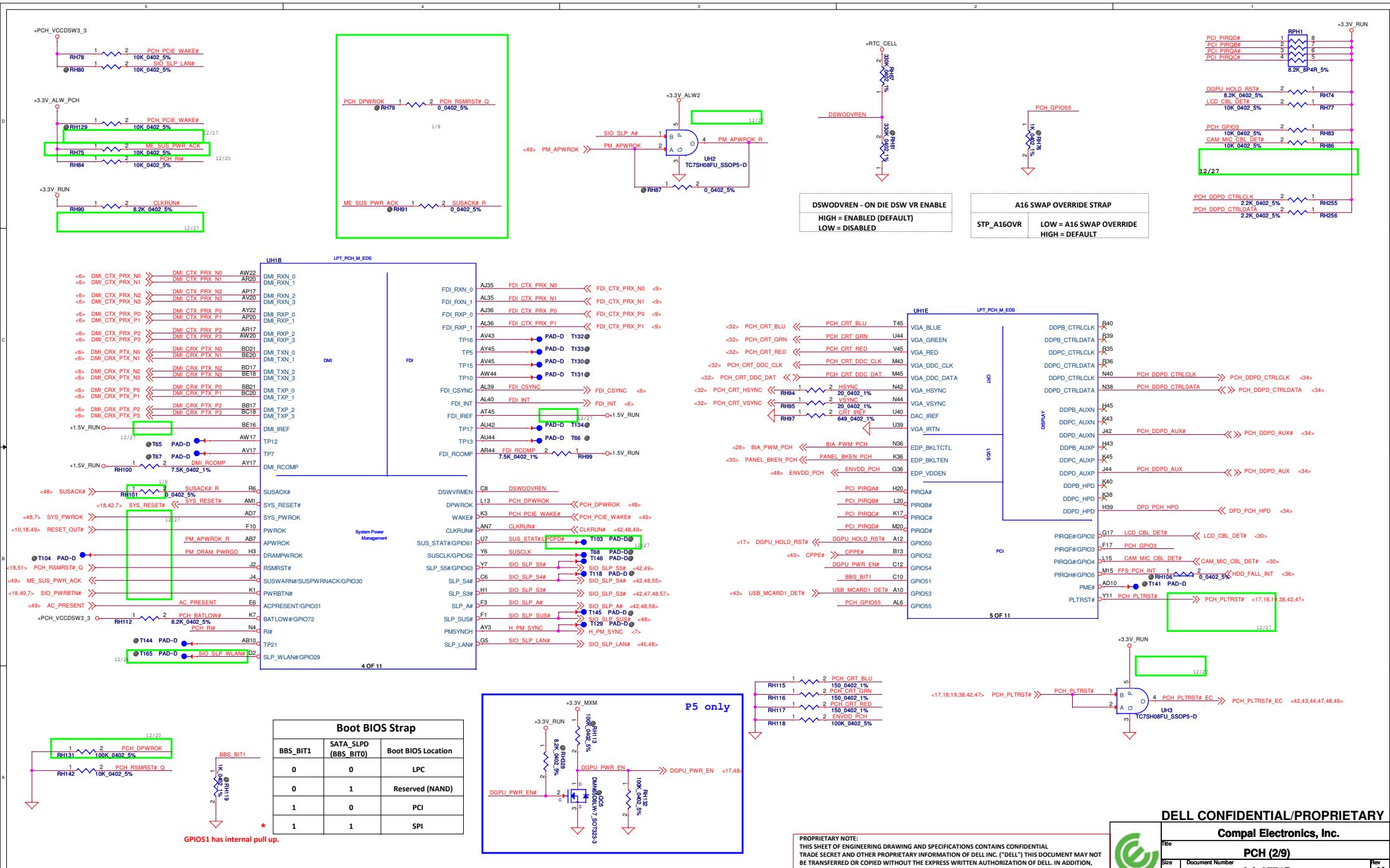
DDRIII-SODIMM SLOT4

LA-9771P Rev 0.2

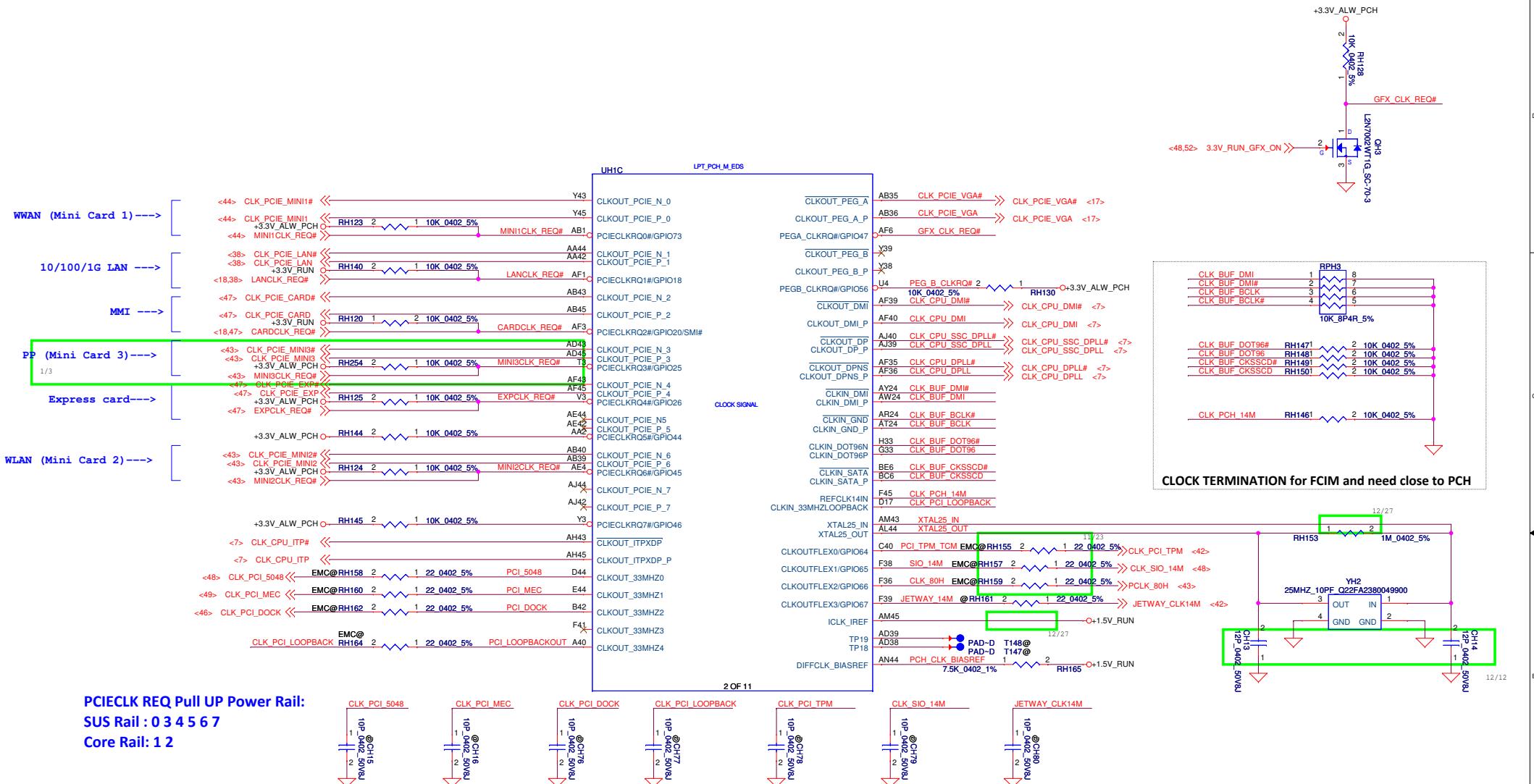
Date: Tuesday, January 15, 2013 Sheet 16 of 69





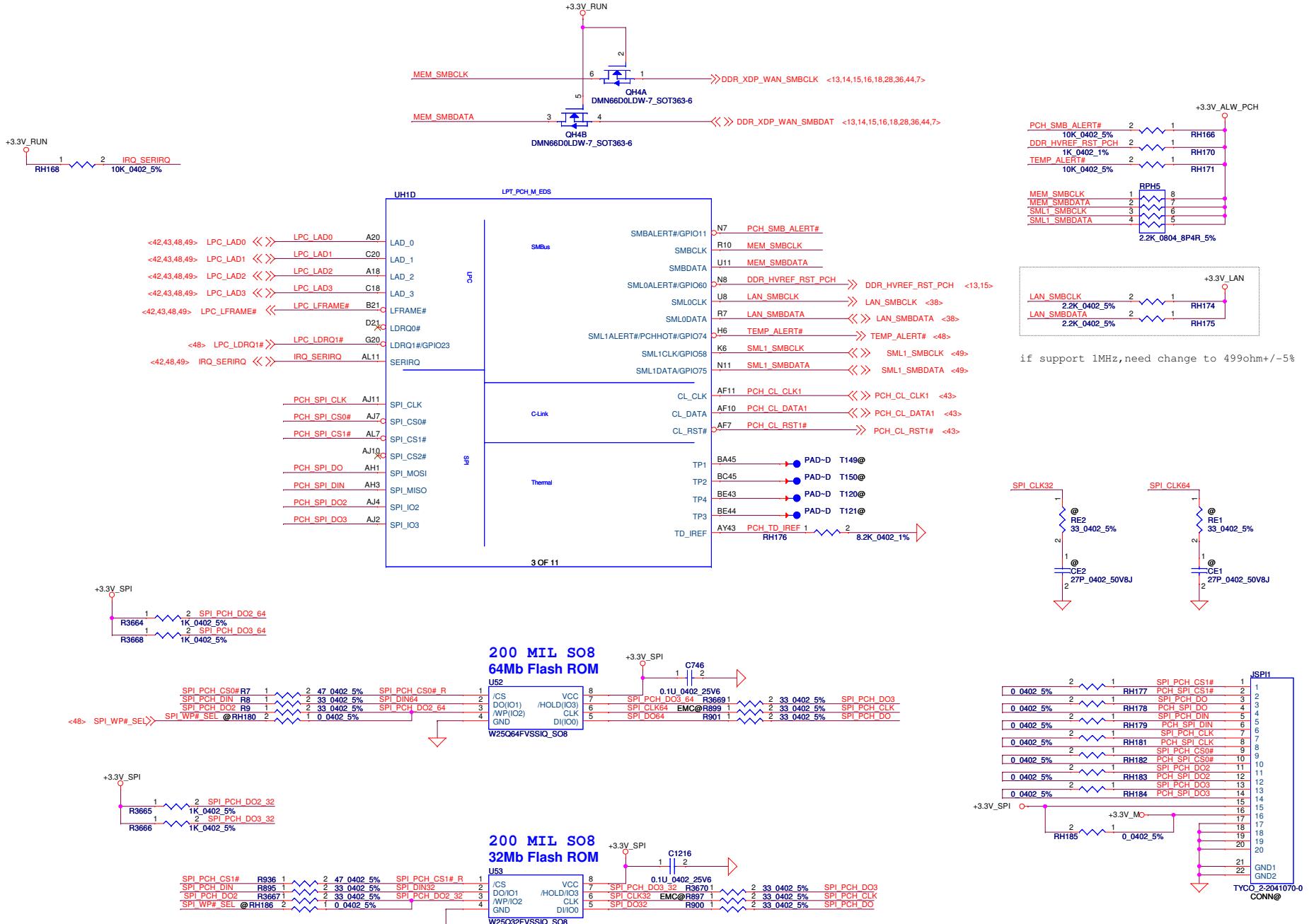


PROPRIETARY NOTE:  
THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL  
TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT  
BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION,  
NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD  
PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



**PROPRIETARY NOTE:**  
THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL  
TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT  
BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION,  
NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD  
PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

<b>DELL CONFIDENTIAL/PROPRIETARY</b>		
<b>Compal Electronics, Inc.</b>		
Title		
<b>PCH (3/9)</b>		
<b>Size</b>	<b>Document Number</b>	<b>Rev</b>
	<b>LA-9771P</b>	0.2



DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

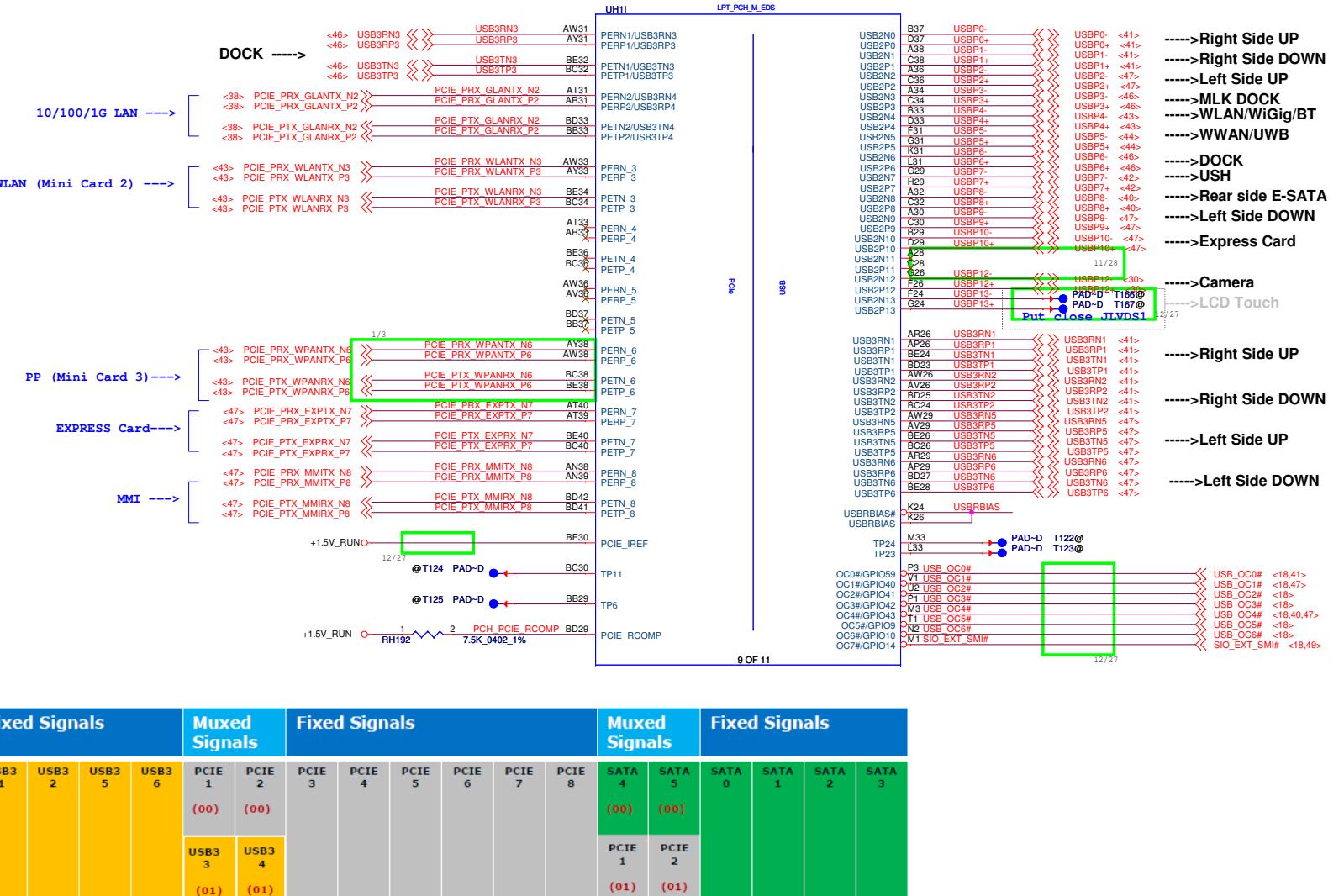
Title \_\_\_\_\_

PCH (4/9)

Size \_\_\_\_\_ Document Number \_\_\_\_\_ Rev. 0.2

LA-9771P

Date: Tuesday, January 15, 2013 Sheet 21 of 65



**PROPRIETARY NOTE:**  
THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL  
TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT  
BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION,  
NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD  
PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY

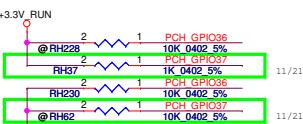
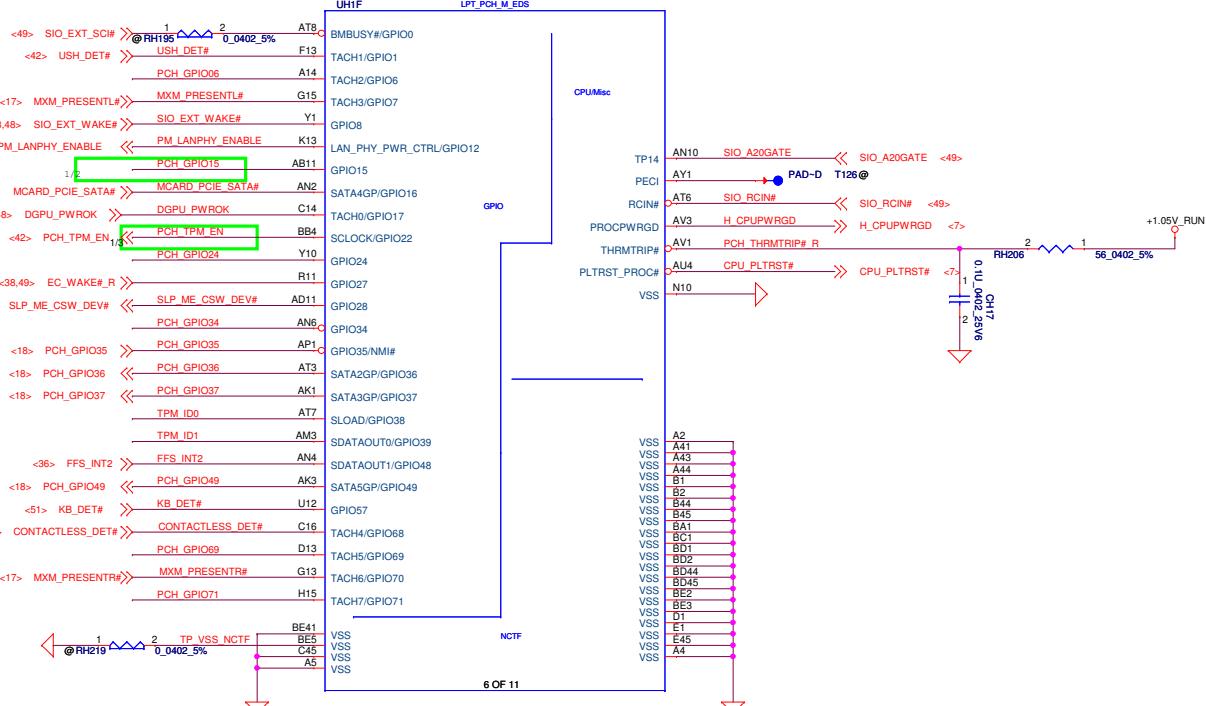
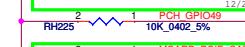
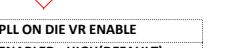
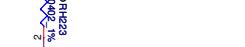
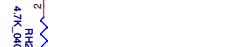
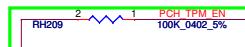
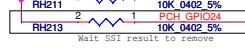
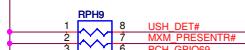
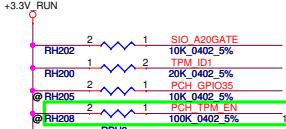
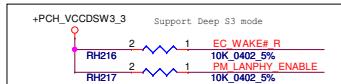
**Compal Electronics, Inc.**

PCH (5/9)

ent Number

January 15, 2013





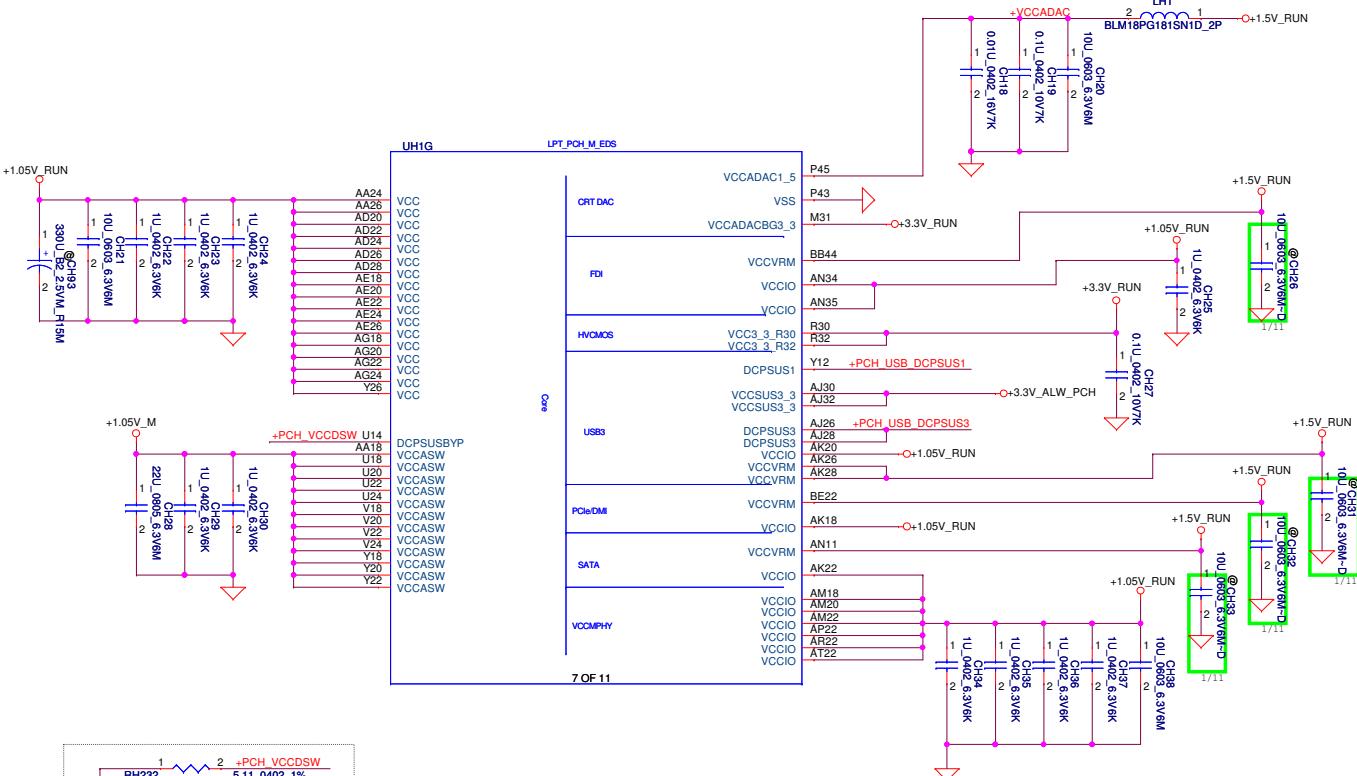
**SATA2GP/GPIO36 ,SATA3GP/GPIO37 SAMPLED AT RISING EDGE OF PWROK.  
WEAK INTERNAL PULL-DOWN.(WEAK INTERNAL PULL-DOWN IS DISABLED AFTER  
PLRST\_N DE-ASSERTS).**  
**NOTE: THIS SIGNAL SHOULD NOT BE PULLED HIGH WHEN STRAP IS SAMPLED.**

**Note: GPIO strap option is only available for SATA/PCIE muxed signals to support mSATA/mini PCIE port switching**

<b>GPIO16</b>	<b>GPIO49</b>
<b>0: PCIE1</b>	<b>0: PCIE2</b>
<b>1: SATA4</b>	<b>1: SATA5</b>

- 00b or 01b: Assign muxed signal to desired port
- 10b: Reserved
- 11b: Assign desired port based on GPIO

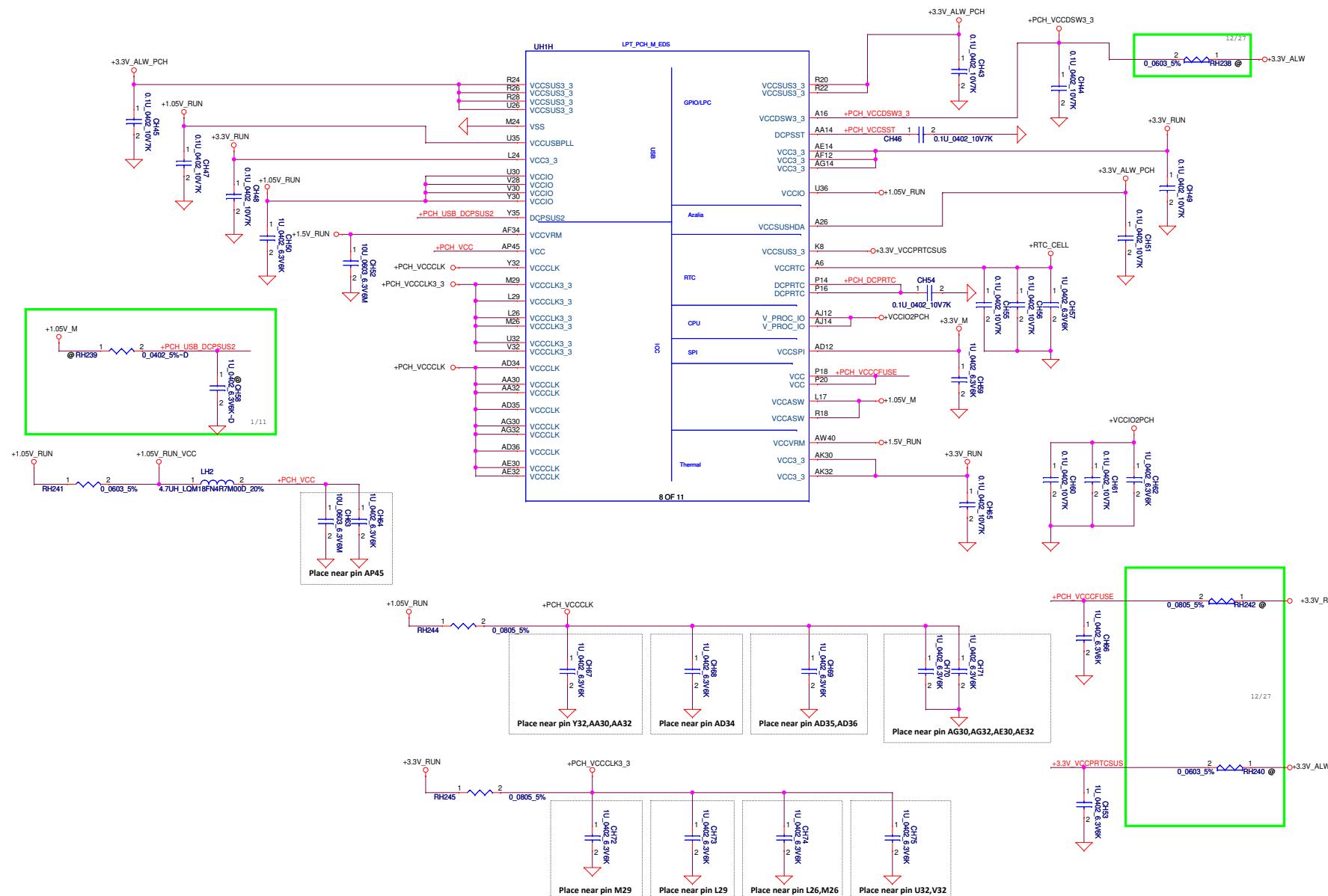
**PROPRIETARY NOTE:**  
THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



PCH Power Rail Table		
Voltage Rail	Voltage	50 Iccmax Current (A)
VCC	1.05V	1.29 A
VCCIO	1.05V	3.629 A
VCCADAC1_5	1.5V	0.070 A
VCCADAC3_3	3.3V	0.0133 A
VCCCLK	1.05V	0.306 A
VCCCLK3_3	3.3V	0.055 A
VCCVRM	1.5V	0.179 A
VCC3_3	3.3V	0.133 A
VCCASW	1.05V	0.67 A
VCCSUSHDA	3.3V	0.01 A
VCCSPI	3.3V	0.022 A
VCCSUS3_3	3.3V	0.261 A
VCCDSW3_3	3.3V	0.015 A
V_PROC_IO	1.05V	0.004 A

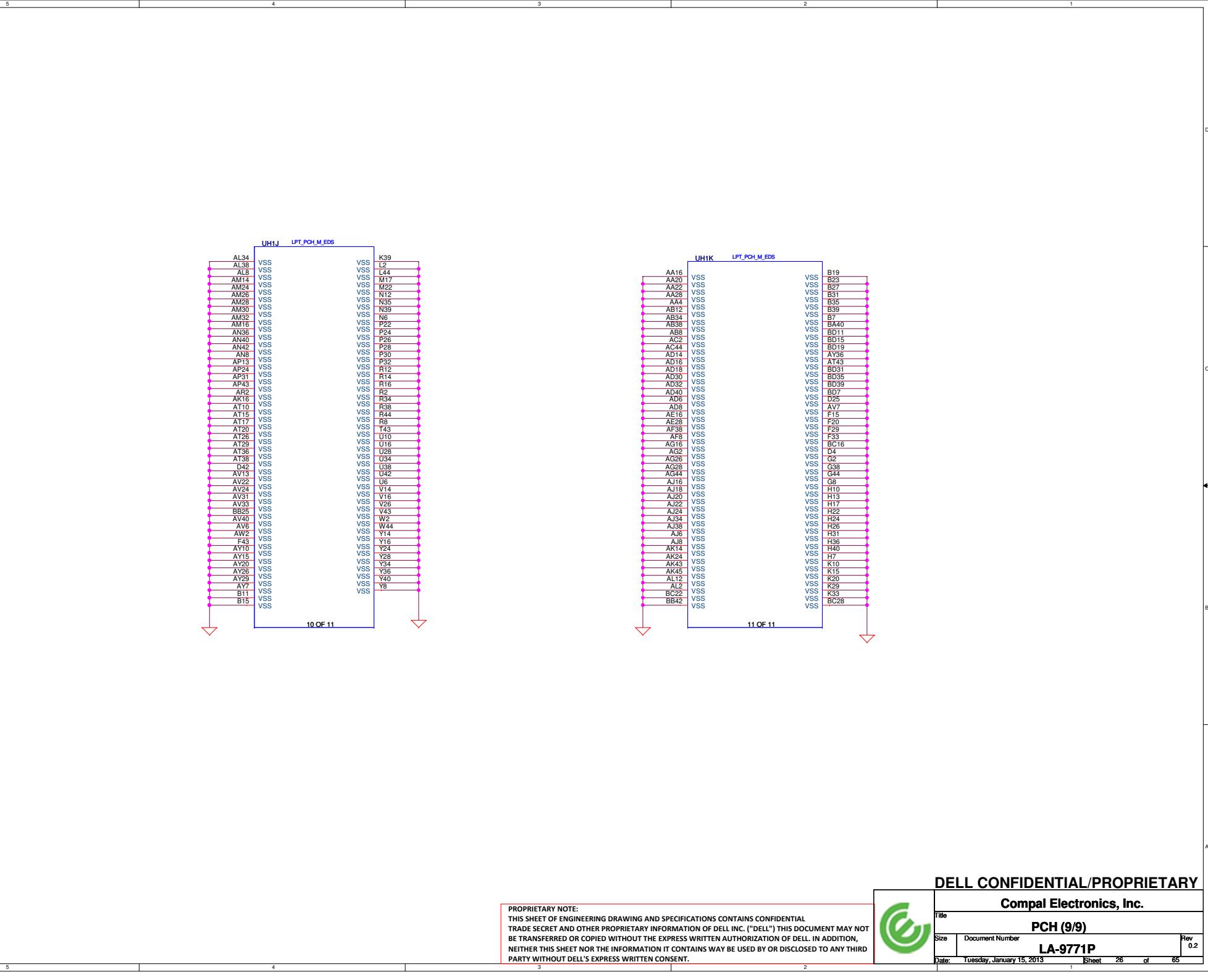
PROPRIETARY NOTE:  
THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

PCH Power Rail Table		
Voltage Rail	Voltage	S0 Iccmax Current (A)
VCC	1.05V	1.29 A
VCCIO	1.05V	3.629 A
VCCADAC1_5	1.5V	0.070 A
VCCADAC3_3	3.3V	0.0133 A
VCCCLK	1.05V	0.306 A
VCCCLK1_3	3.3V	0.055 A
VCCVRM	1.5V	0.179 A
VCC3_3	3.3V	0.133 A
VCCASW	1.05V	0.67 A
VCCSUSHDA	3.3V	0.01 A
VCCSPI	3.3V	0.022 A
VCCSUS3_3	3.3V	0.261 A
VCCDSW3_3	3.3V	0.015 A
V_PROC_IO	1.05V	0.004 A

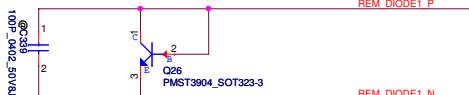


**PROPRIETARY NOTE:**  
THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

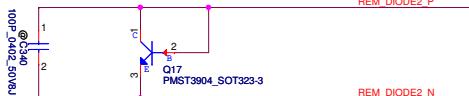




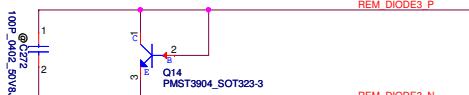
Place Q26 under CPU  
Place C339 close to the Q26



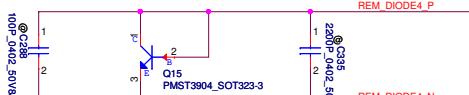
**DP/DN2 for SODIMM on Q17(TOP),  
place Q17 close to SODIMM and C340 close to Q2**



**DP3/DN3 for Butterfly CHA on Q14(BOT),  
place Q14 close to Butterfly CHA and C272 close to Q14**



**DP4/DN4 for Skin on Q15,  
place Q15 close to Vcore VR choke and C288 close to Q15**

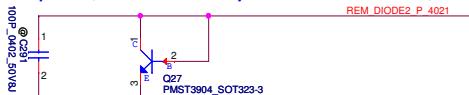


REM DIODE1 N      REM DIODE1 N <49>  
REM DIODE2 N      REM DIODE2 P <49>  
REM DIODE2 P      REM DIODE2 N <49>  
REM DIODE3 N      REM DIODE3 P <49>  
REM DIODE3 P      REM DIODE3 N <49>  
REM DIODE4 N      REM DIODE4 P <49>  
REM DIODE4 P      REM DIODE4 N <49>

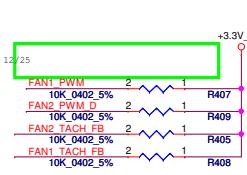
**Place Q16 under MXM(TOP side)  
Place C273 close to the Q16**



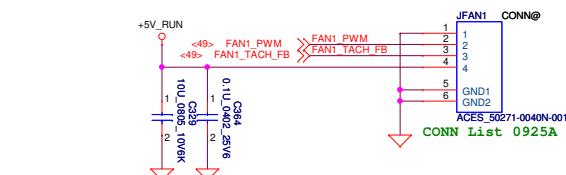
DP2/DN2 for MXM on Q27(BOT side),  
place Q27 close to Butterfly CHB and C291 close to Q27



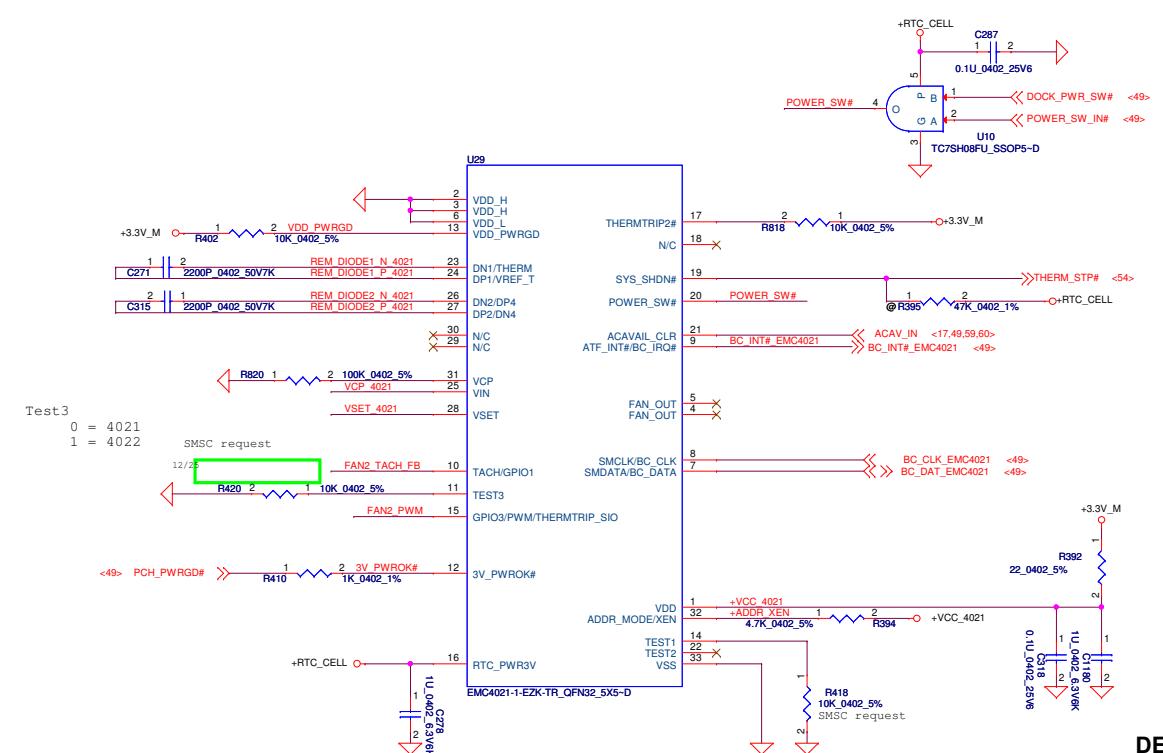
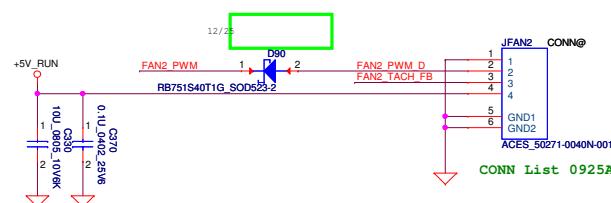
The diagram shows a bridge rectifier circuit. The top half consists of a blue zigzag line representing an AC source connected to a red downward-pointing triangle ground terminal. This is followed by a resistor labeled R430 (10K\_0402\_5%). A blue line then connects to a blue diamond component labeled VSET\_4021. The bottom half shows two parallel branches. The left branch contains a blue line with a small circle at its end, a blue rectangle labeled C319 (0.1U\_0402\_2516), and a blue line with a small circle at its end. The right branch contains a blue line with a small circle at its end, a blue rectangle labeled R424 (1.33K\_0402\_1%), and a blue line with a small circle at its end. Both branches lead to a red downward-pointing triangle ground terminal.



CPU FAN



MXM FAN



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

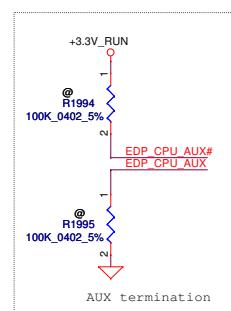
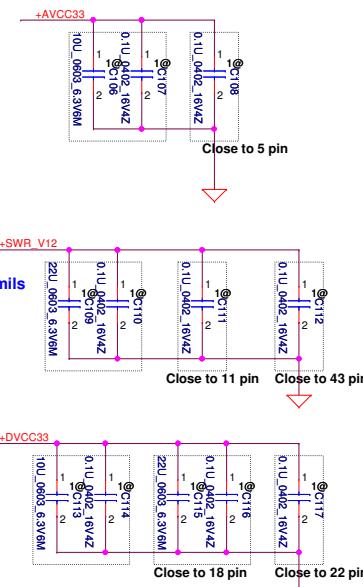
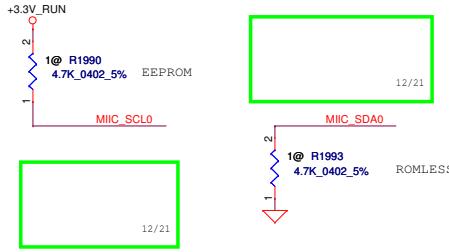
DELL CONFIDENTIAL/PROPRIETARY

**Compal Electronics, Inc.**

## FAN control

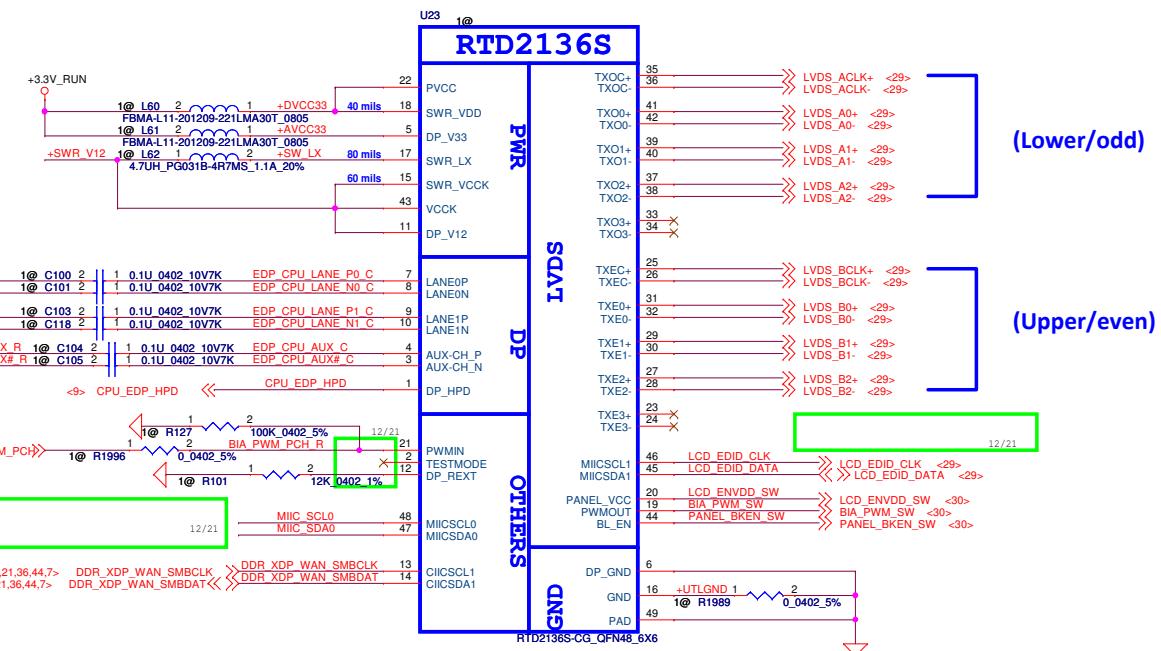
ent Number

EA-97711  
r, January 15, 2013 Sheet 2



### Power Consumption:

Pin5 (DPV33) < 20mA  
Pin 11 (DPV12) < 100mA  
Pin 15 (SWR\_VCCK) < 100mA (layout trace > 60 mil)  
Pin 17 (SWR\_LX) < 600mA (layout trace > 80 mil for LDO mode)  
Pin 18 (SWR\_VDD) < 200mA (layout trace > 40 mil)  
Pin 22 (PVCC) < 50 mA  
Pin 43 (VCCK) < 50mA

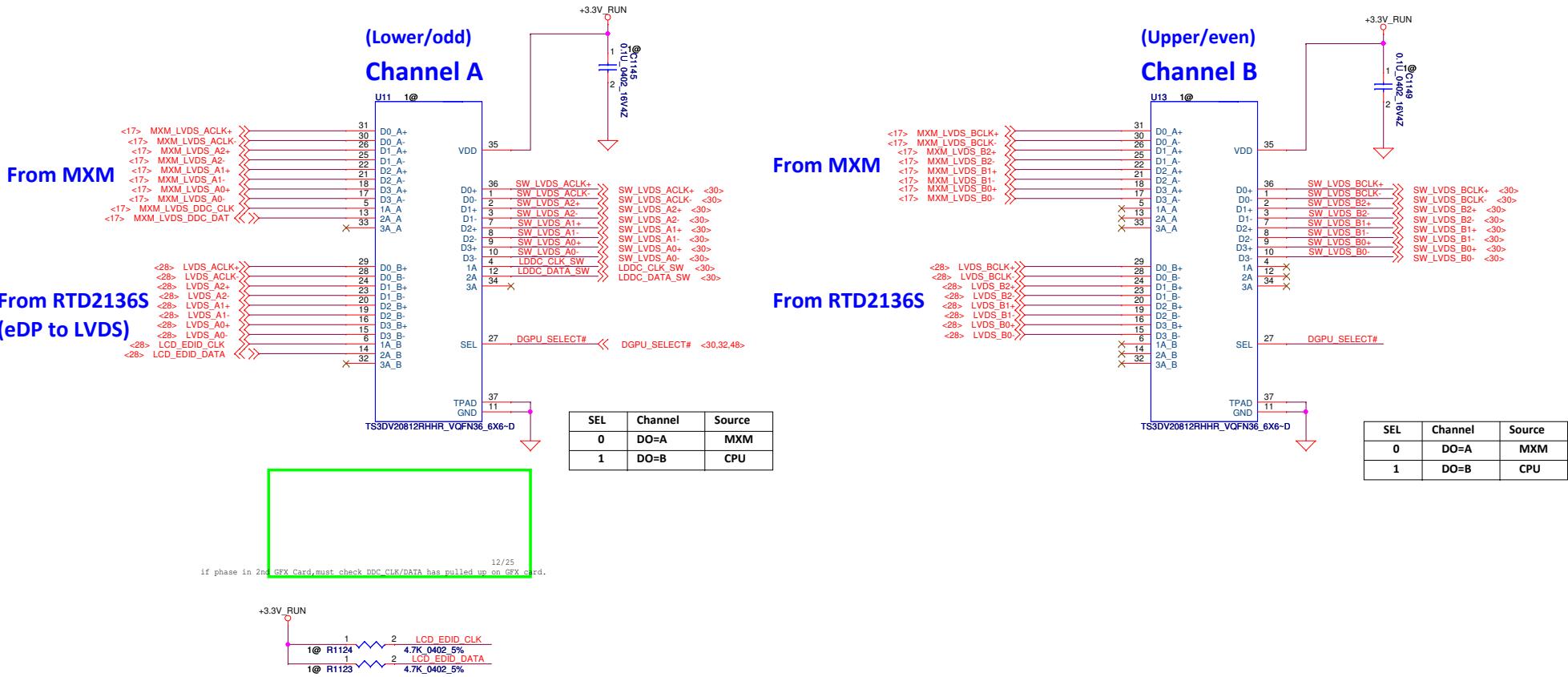


1009 change to SA000067100 (RTD2136R)

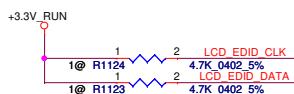
\* RTD2136R SA000067100 : Populate R1993

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY			
Compal Electronics, Inc.			
Title	Document Number	Rev	of
eDP to LVDS	LA-9771P	0.2	
Date: Tuesday, January 15, 2013	Sheet 28	of 65	



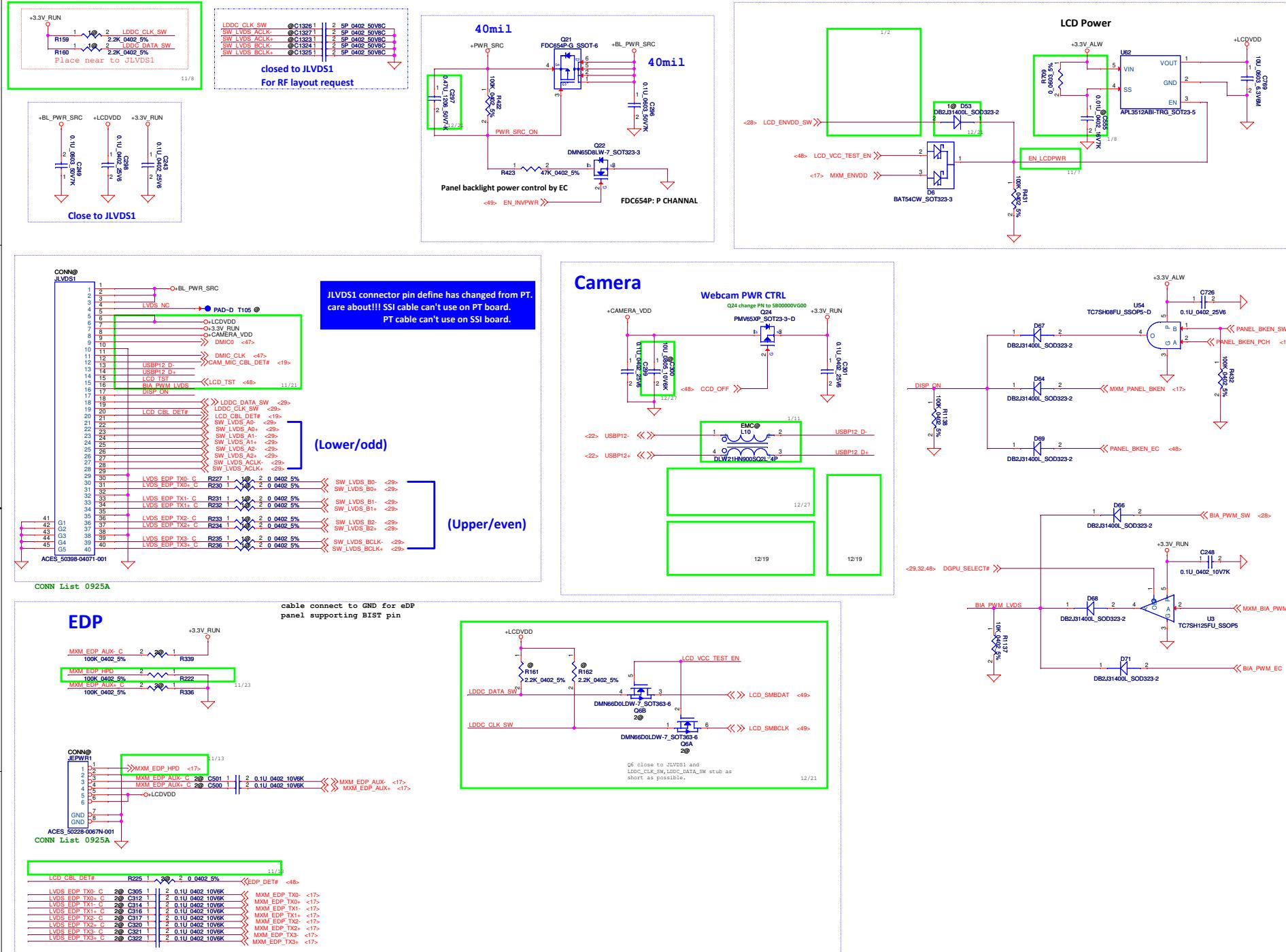
if phase in 2nd GFY Card, must check DDC CLK/DATA has pulled up on GFY card.



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

**DELL CONFIDENTIAL/PROPRIETARY**

Compal Electronics, Inc.		
Title	LVDS SW	
Size	Document Number	Rev
	LA-9771P	0.2
Date:	Tuesday, January 15, 2013	Sheet 29 of 65



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

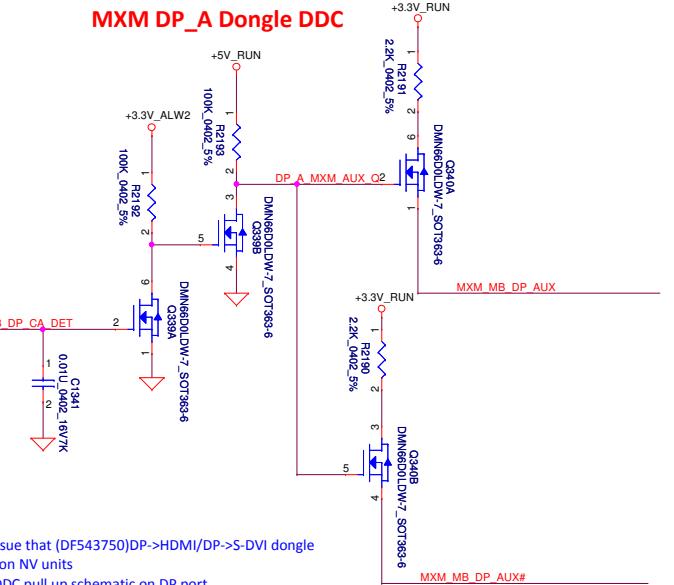
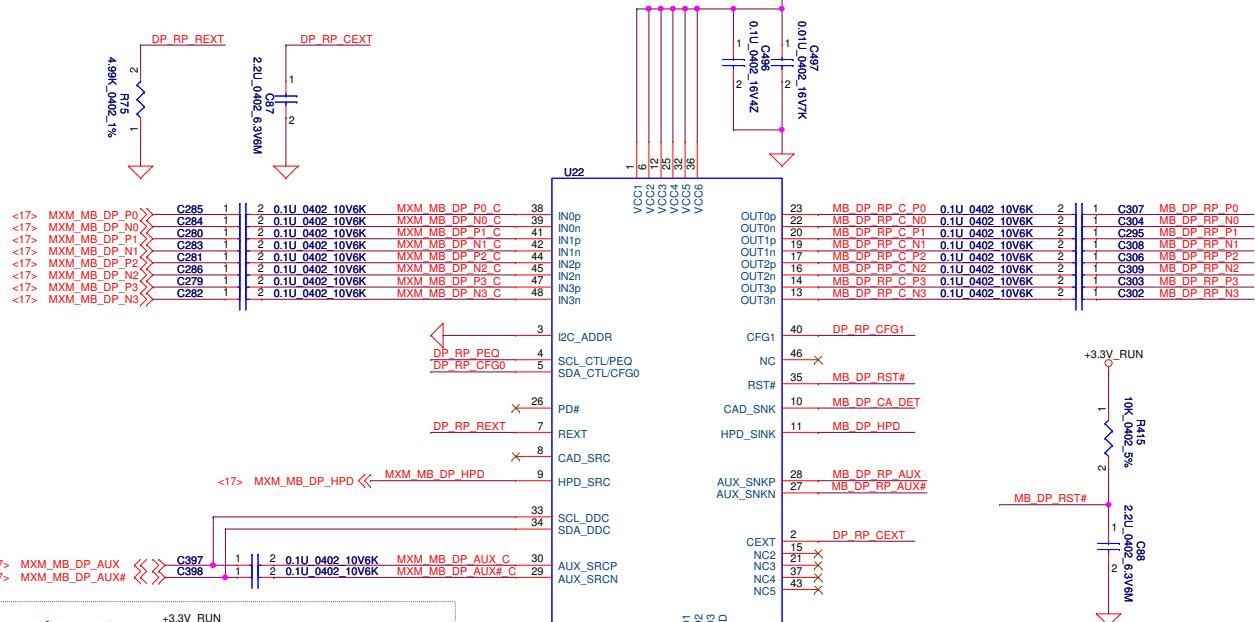


DELL CONFIDENTIAL/PROPRIETARY  
Compal Electronics, Inc.  
Title  
LVDS & CAM  
Size Document Number LA-9771P

Configuration pin for automatic EQ and AUX interception; Internal pull down at ~150kΩ, 3.3V I/O.  
L: default, automatic EQ enable & AUX interception enable  
H: automatic EQ disable & AUX interception enable  
M: automatic EQ disable & AUX interception disable, no pre-emphasis, 600mVpp swing

Configuration pin for auto test and input offset cancellation, 3.3V IO, internal pull up at ~150kΩ.  
H: default, auto test disable & input offset cancellation enable  
L: auto test enable & input offset cancellation enable  
M: auto test disable & input offset cancellation disable

Programmable input equalization levels; Internal pull down at ~150kΩ, 3.3V I/O.  
L: default, LEQ, compensate channel loss up to 12dB @ HBR2  
H: HEQ, compensate channel loss up to 15dB @ HBR2  
M: LLEQ, compensate channel loss up to 5dB @ HBR2



For debug issue that (DF543750)DP->HDMI/DP->S-DVI dongle no function on NV units

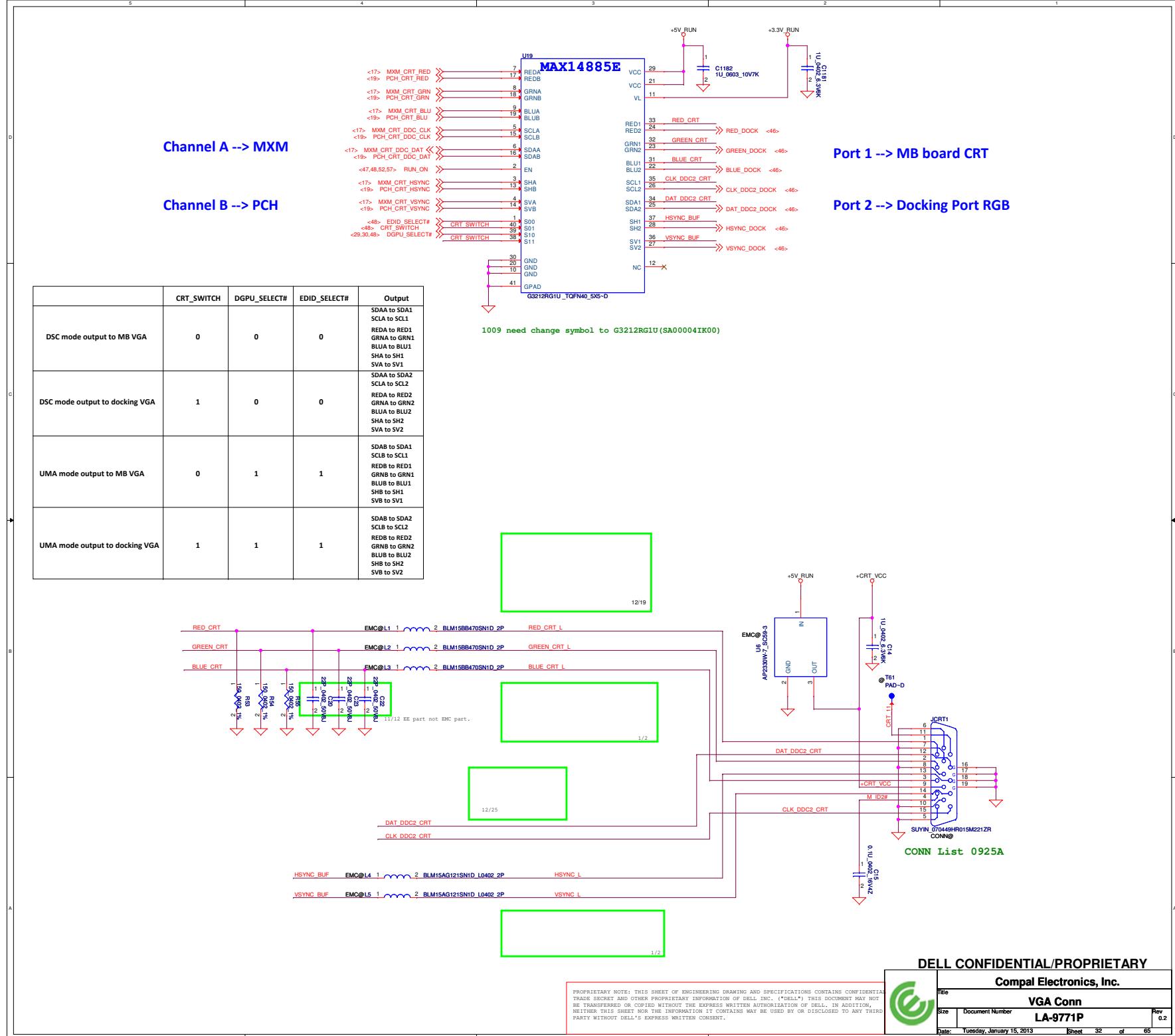
Add TMDS DDC pull up schematic on DP port

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

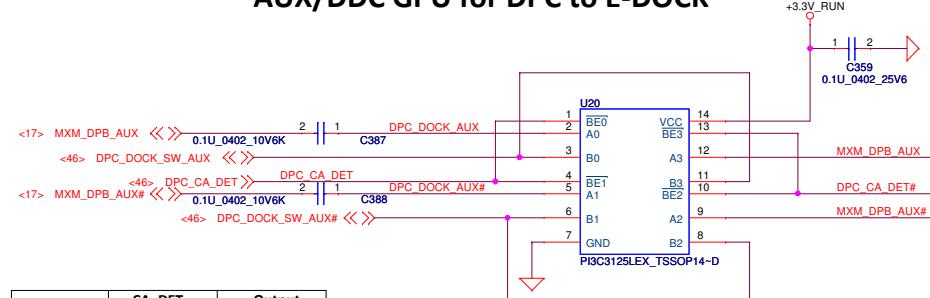
	Compal Electronics, Inc.
Title	DP Conn
Size	Document Number LA-9771P
Date: Tuesday, January 15, 2013	Rev. 0.2



Sheet 31 of 65

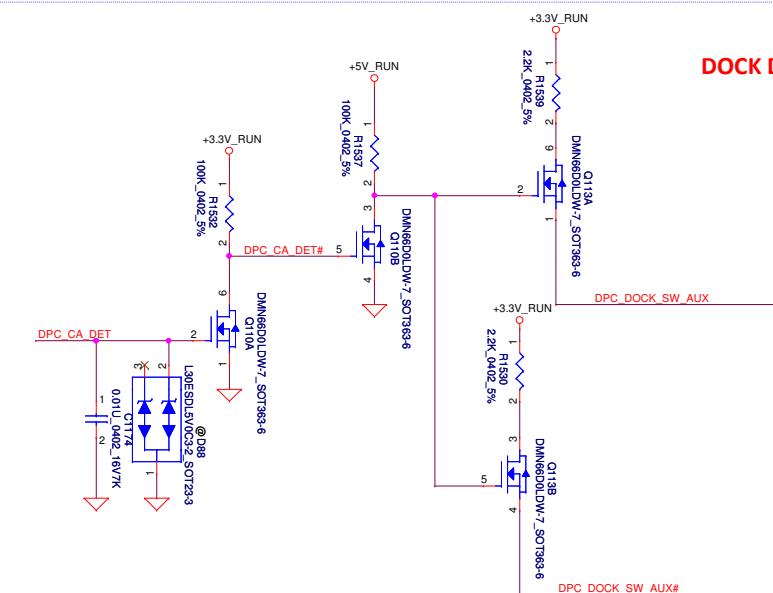


## AUX/DDC GPU for DPC to E-DOCK



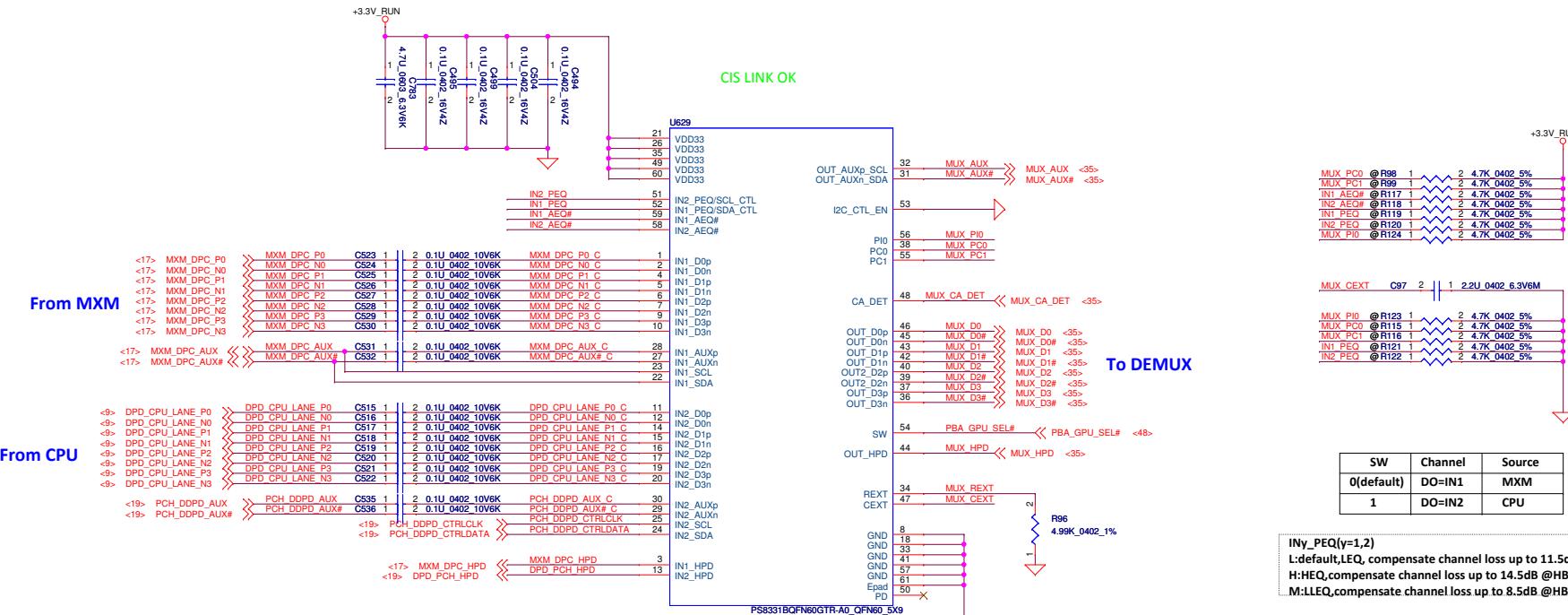
R492 1 2 DPC.CA\_DET

## DOCK DPB(PORT2) DDC



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY	
Compal Electronics, Inc.	
Title	DP DDC SW
Size	Document Number
	LA-9771P
Rev	0.2
Date	Tuesday, January 15, 2013
Sheet	33 of 65



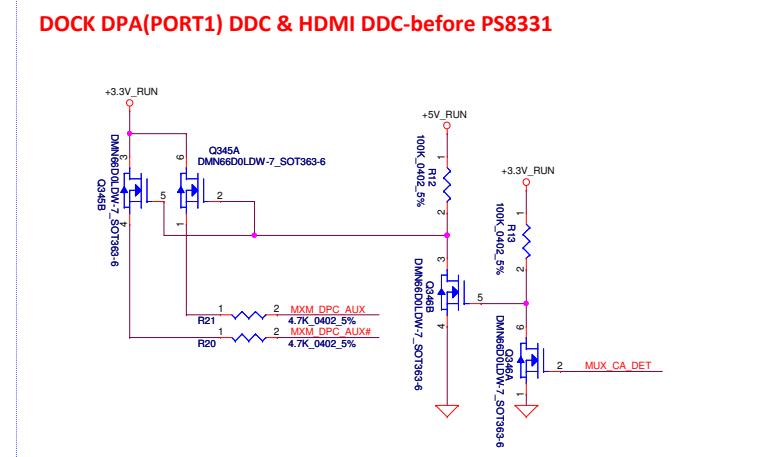
**INY\_EQ(y=1,2)**  
L:default,LEQ, compensate channel loss up to 11.5dB @HBR2  
H:HEQ,compensate channel loss up to 14.5dB @HBR2  
M:LLEQ,compensate channel loss up to 8.5dB @HBR2

**INY\_EQ#(y=1,2)**  
L: Automatic EQ enable (default)  
H: Automatic EQ disable

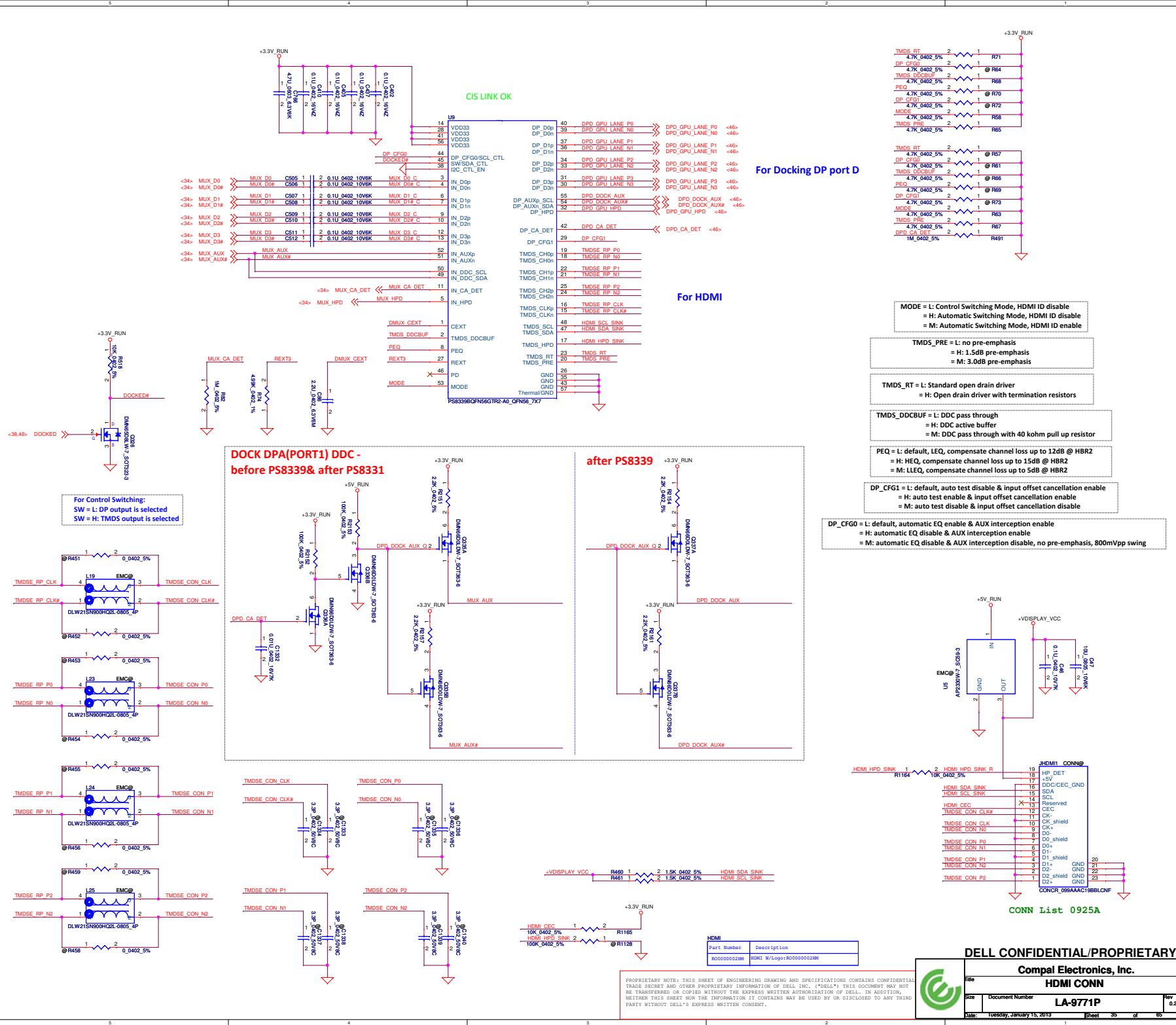
**P10**  
L: AUX test disable & input offset cancellation enable (default)  
H: Auto test enable & input offset cancellation enable  
M: Auto test disable & input offset cancellation disable

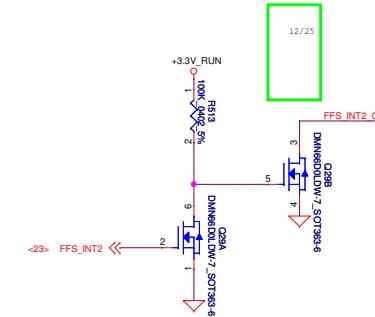
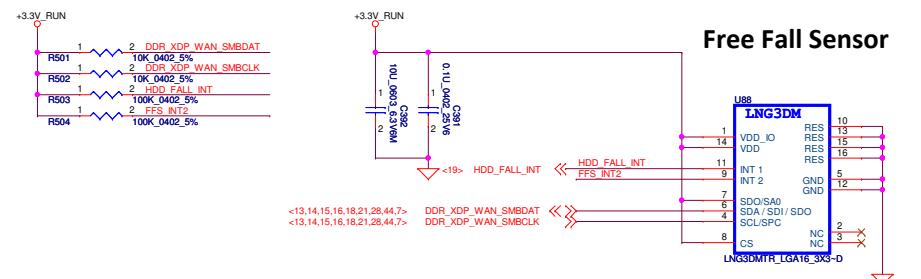
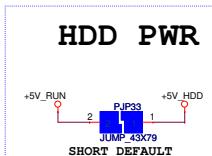
**PC0**  
L: AUX interception enable, driver configuration is set by link training (default)  
H: AUX interception disable, driver output with fixed 800mV and 0dB  
M: AUX interception disable, driver output with fixed 400mV and 0dB

**PC1**  
L: default  
H: Output swing +20%  
M: Output swing -16.7%

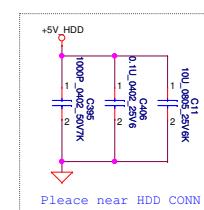
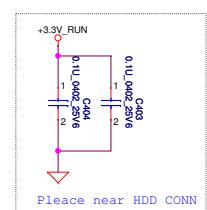
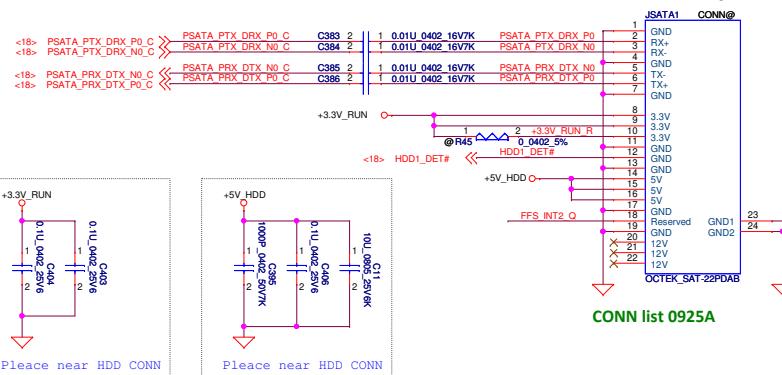


PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



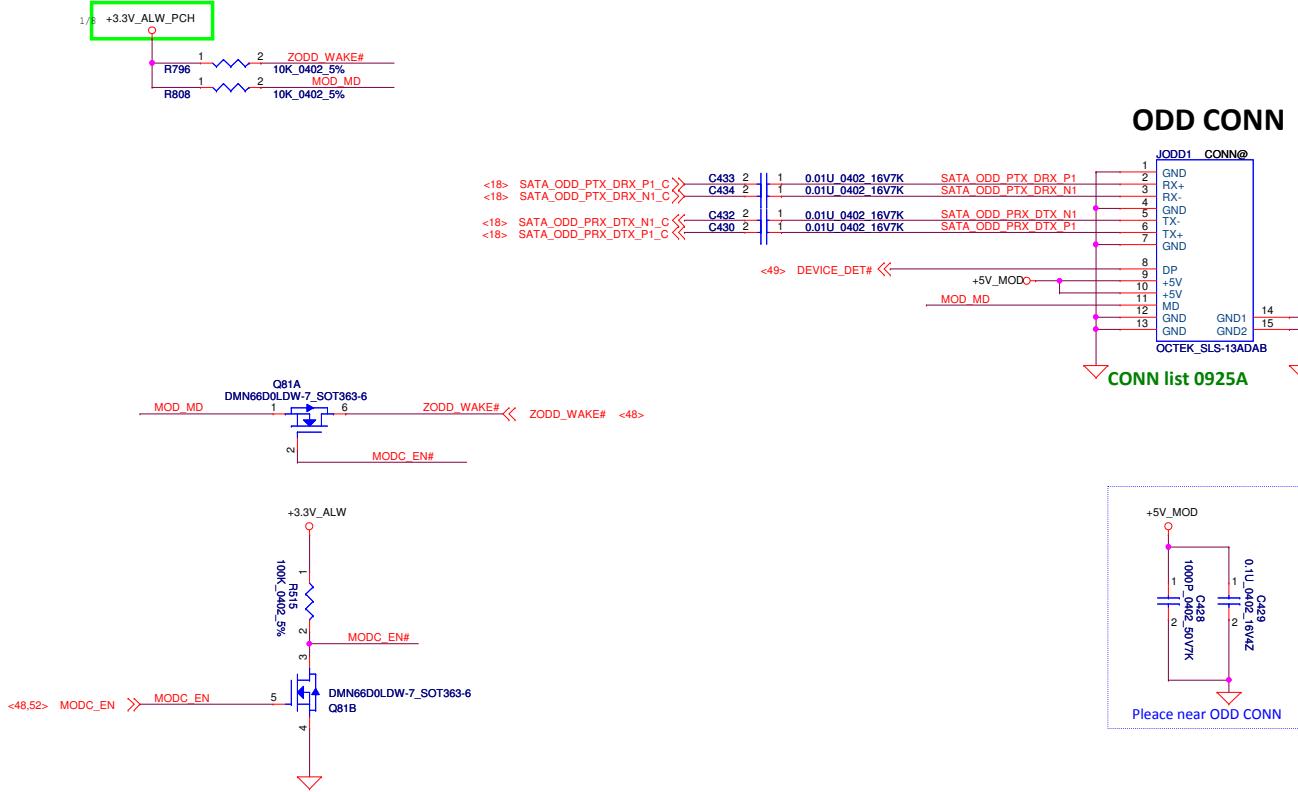


### For HDD Temp.



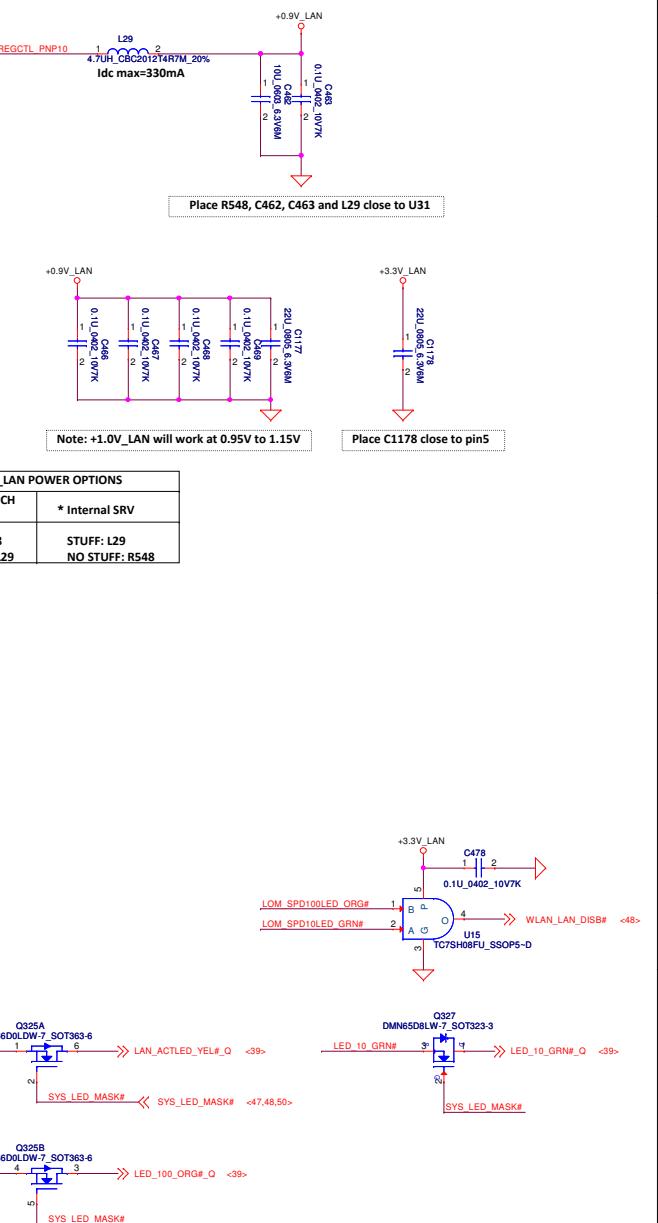
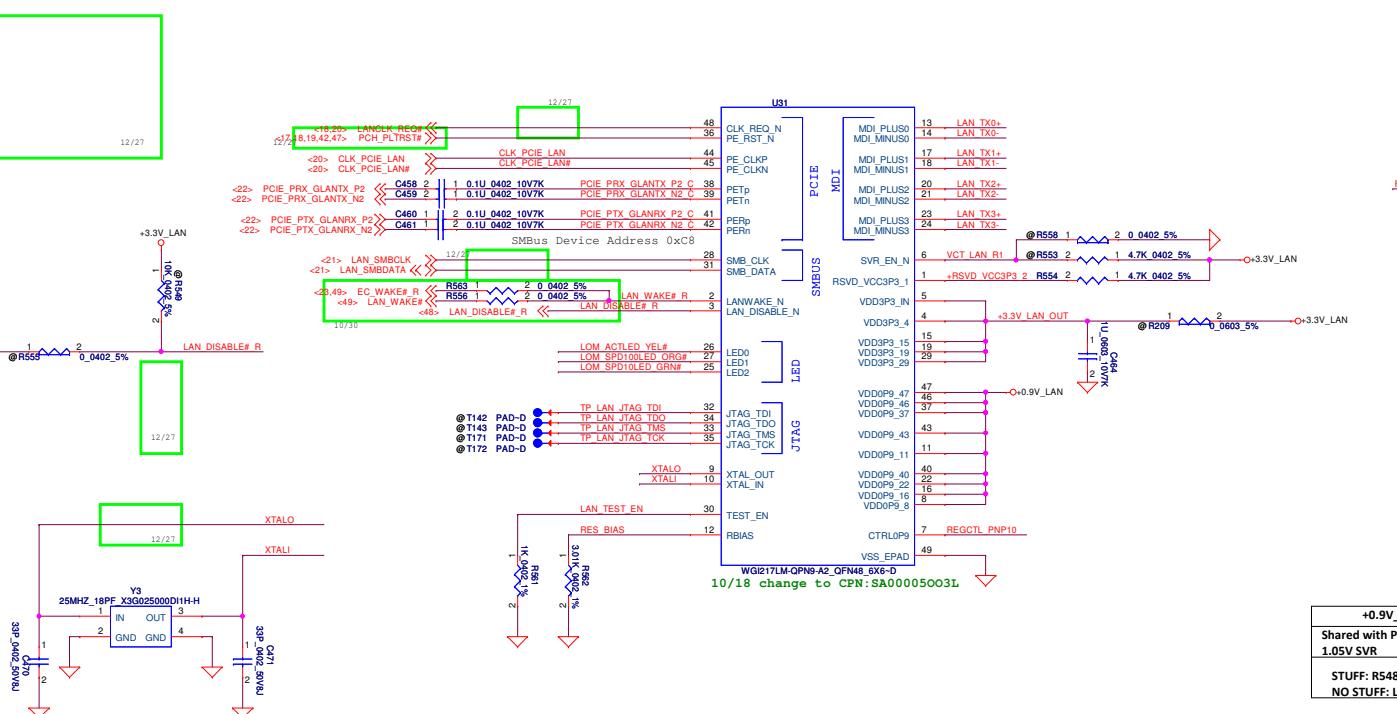
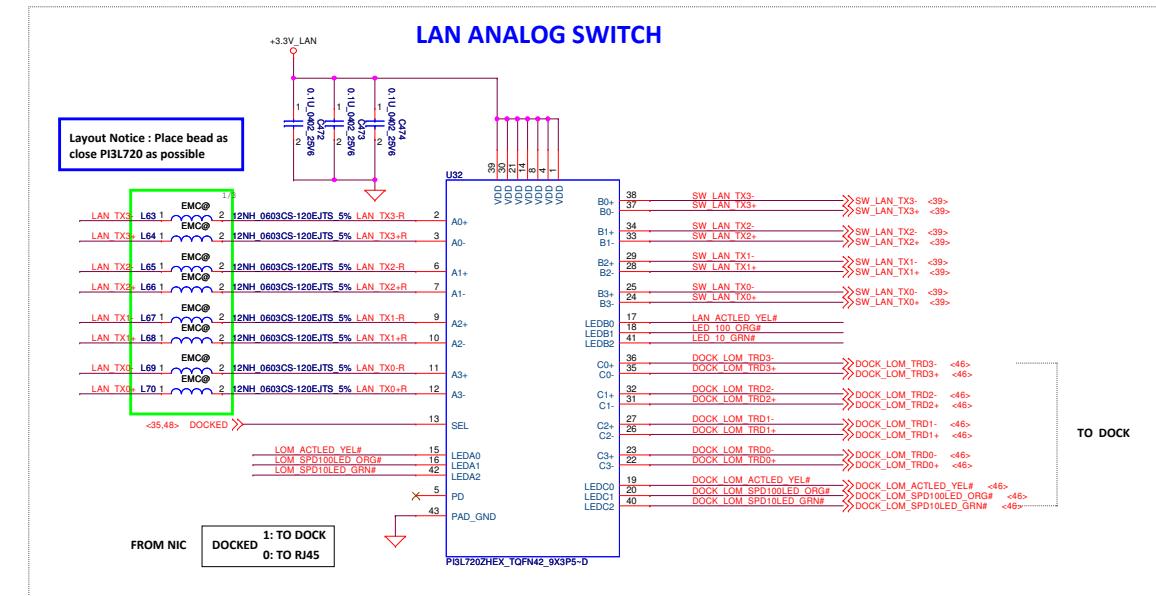
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY	
Compal Electronics, Inc.	
Title	
HDD CONN	Rev 0.2
Size	Document Number
LA-9771P	Date: Tuesday, January 15, 2013
Sheet 36 of 65	



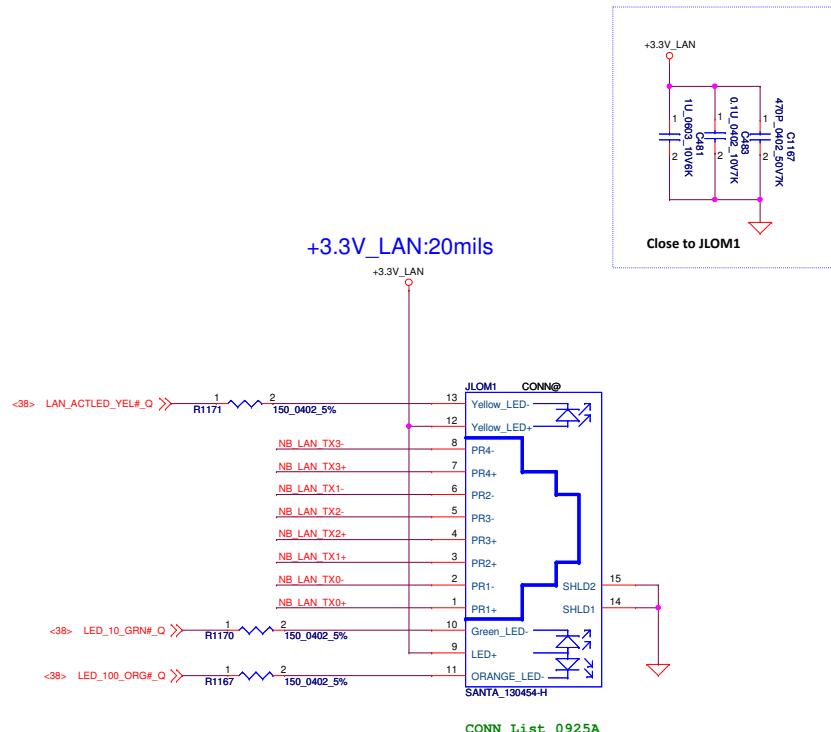
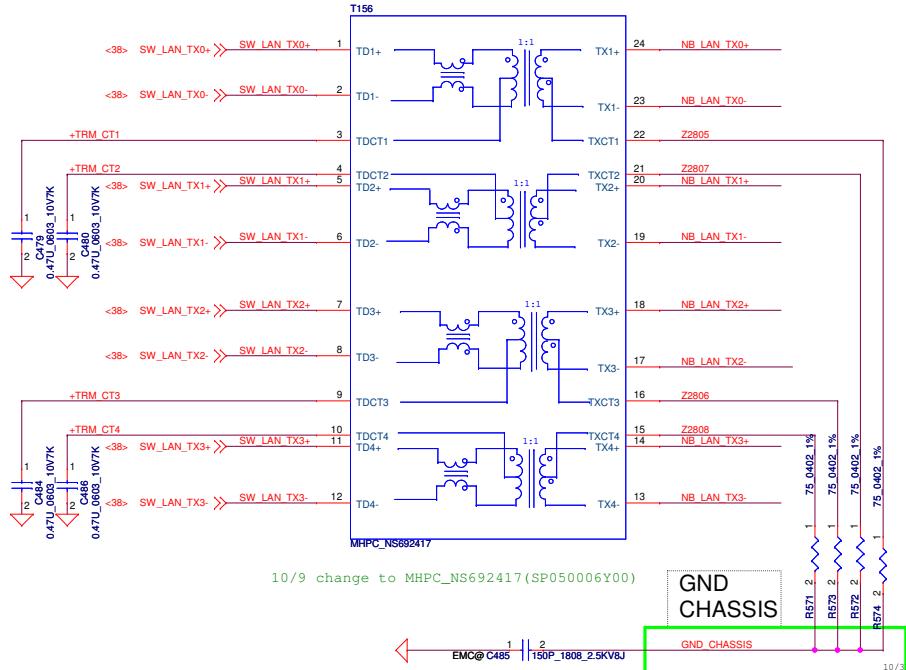
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY		
Compal Electronics, Inc.		
Title	Document Number	Rev
ODD CONN	LA-9771P	0.2
Date: Tuesday, January 15, 2013	Sheet 37 of 65	



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL, TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY					
Compaq Electronics, Inc.					
LAN/LAN SW					
Size	Document Number		<b>LA-9771P</b>		Rev 0.2
Date:	Tuesday, January 15, 2013		Sheet	38	of 65



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

**DELL CONFIDENTIAL/PROPRIETARY**

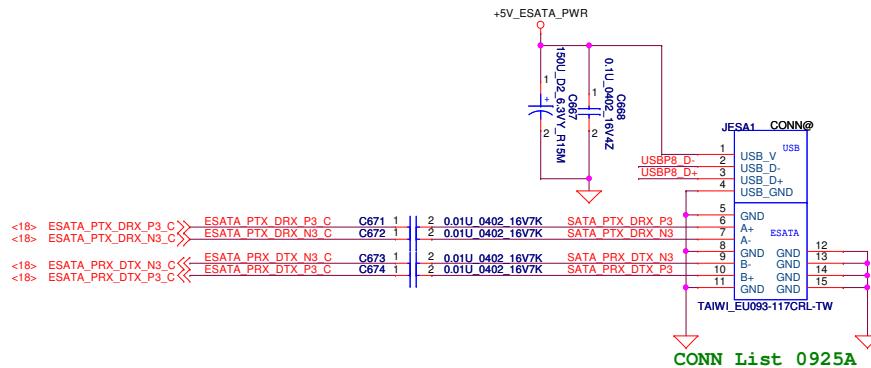
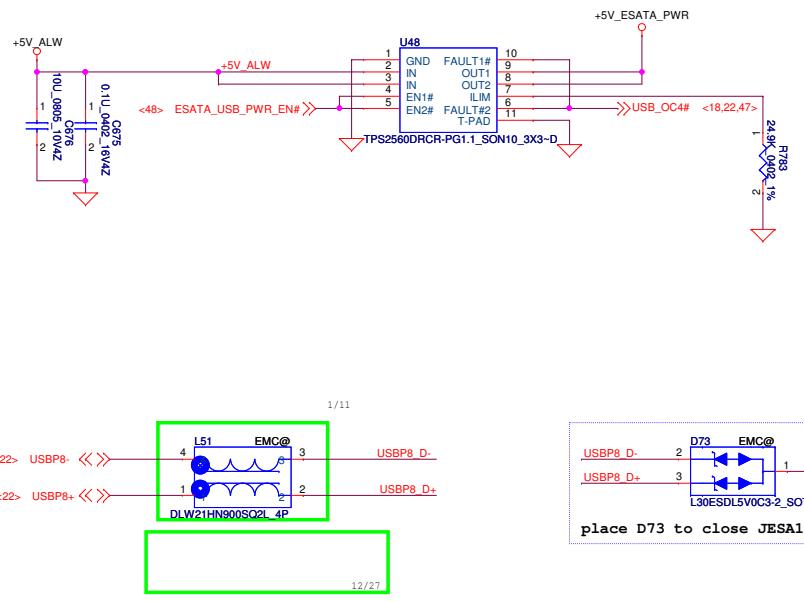
**Compal Electronics, Inc.**

**RJ45**

Size	Document Number	Rev
	LA-9771P	0.2

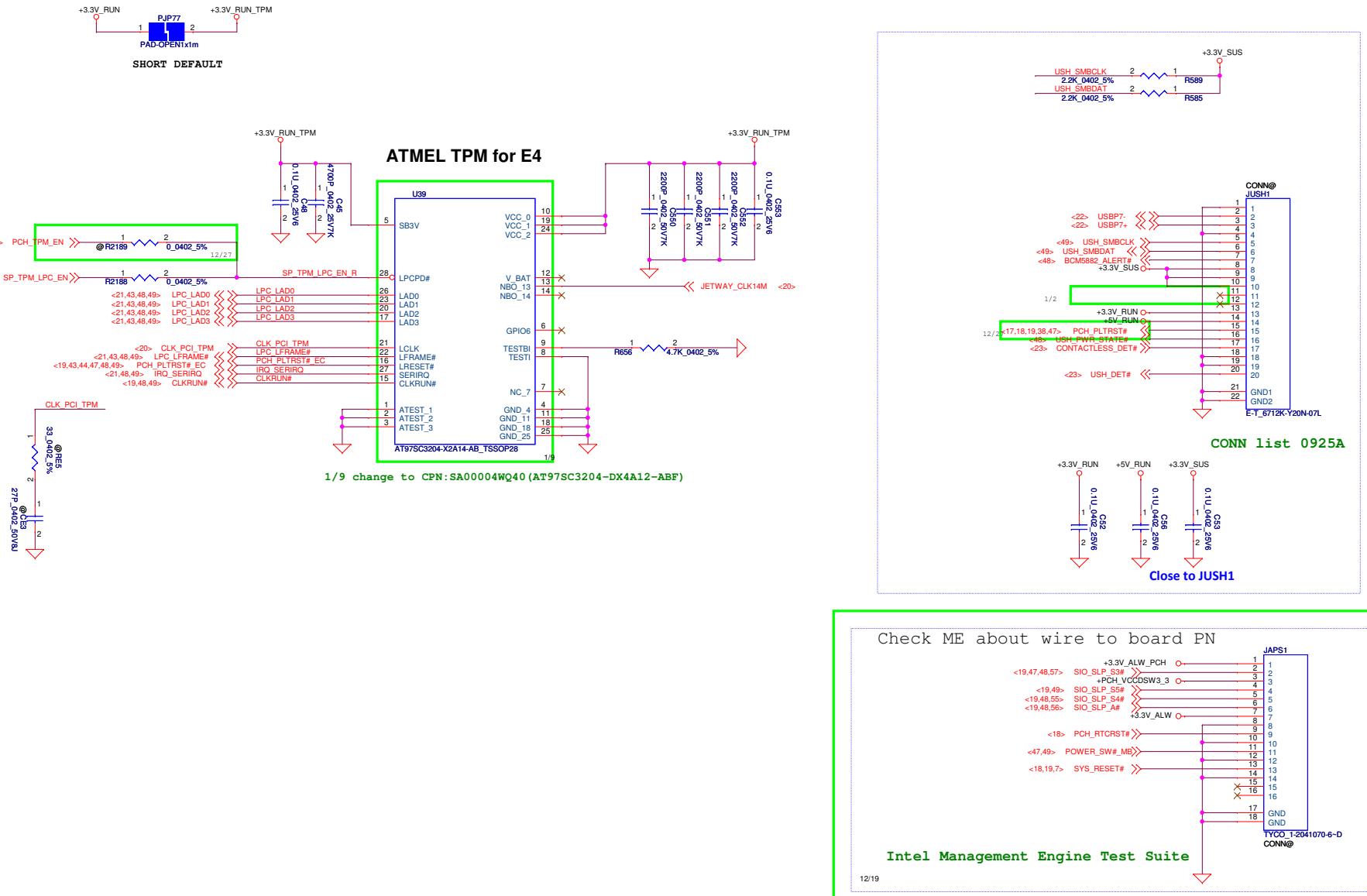
Date: Tuesday, January 15, 2013

Sheet 39 of 65



DELL CONFIDENTIAL/PROPRIETARY		
Compal Electronics, Inc.		
Title	Document Number	Rev
ESATA	LA-9771P	0.2
Date: Tuesday, January 15, 2013	Sheet 40 of 65	





PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

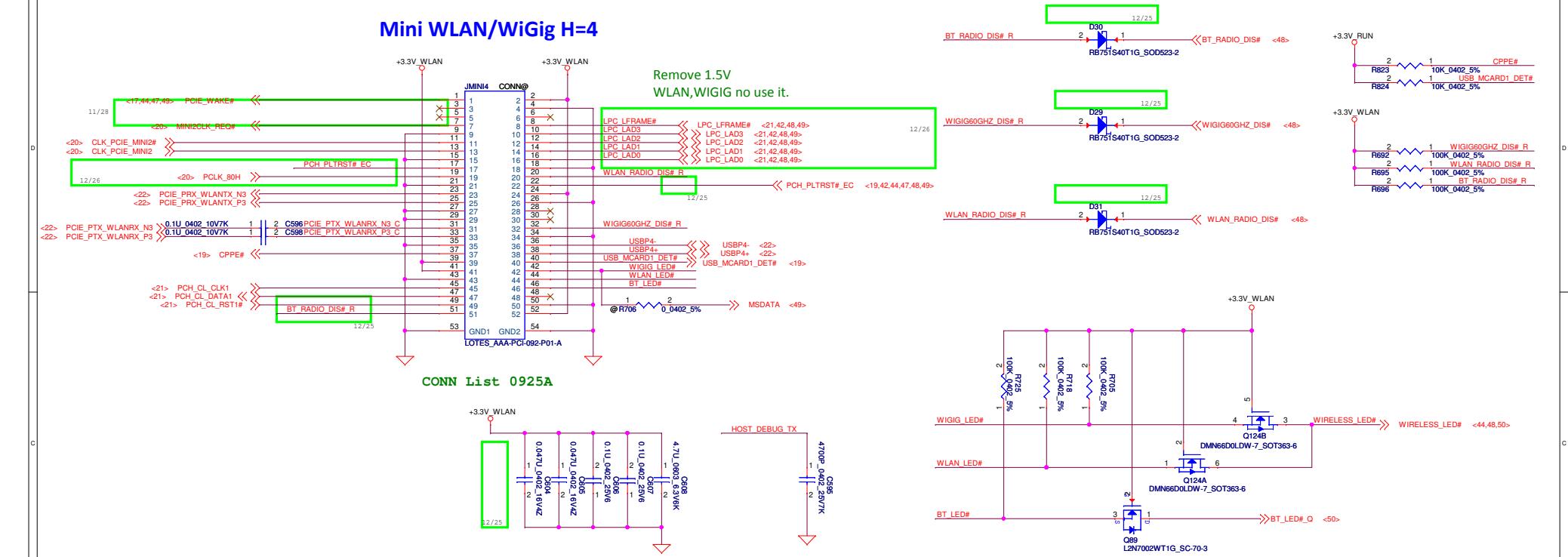
TPM

LA-9771P

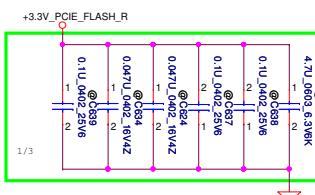
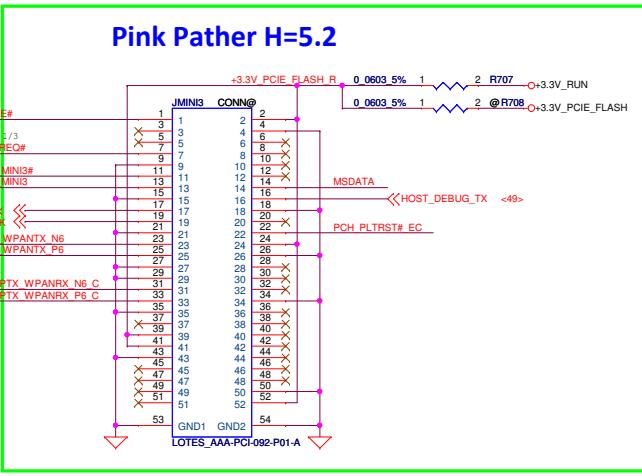
Tuesday, January 15, 2013

Sheet 42 of 85

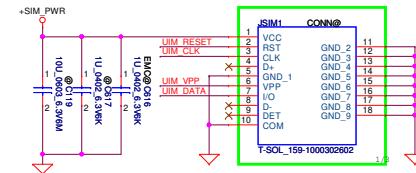
# Mini WLAN/WiGig H=4



# Pink Path H=5.2



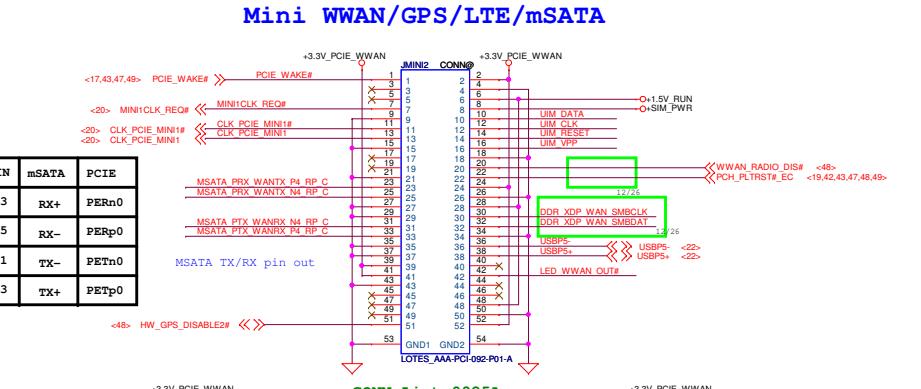
## SIM Card Push-Push



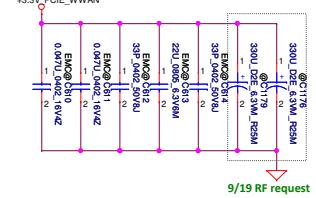
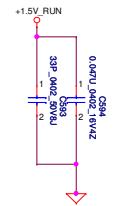
**CONN List 1217A**

PIN	mSATA	PCIE
23	RX+	PERn0
25	RX-	PERp0
31	TX-	PETn0
33	TX+	PETp0

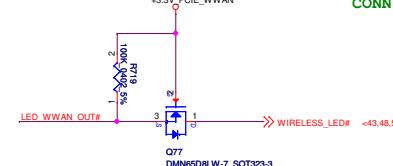
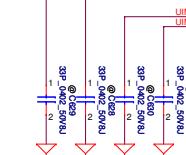
## Mini WWAN/GPS/LTE/mSATA



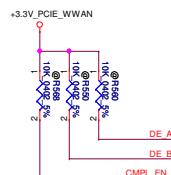
**CONN List 0925A**



**9/19 RF request**

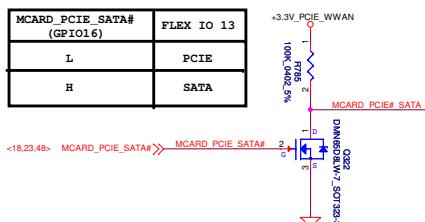


Q77  
DMN65D8LW-7\_SOT323-3



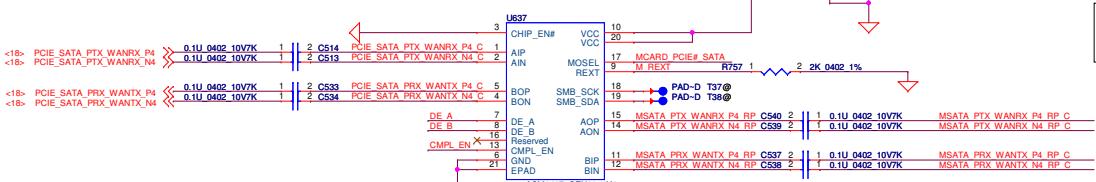
CHIP_EN#	Funtion
0	Normal mode
1	power down mode

MCARD_PCIE_SATA# (GP1016)	FLEX IO 13
L	PCIE
H	SATA



**MOSEL 1: PCIE redriver  
0: SATA redriver**

## PCIE/SATA Repeater

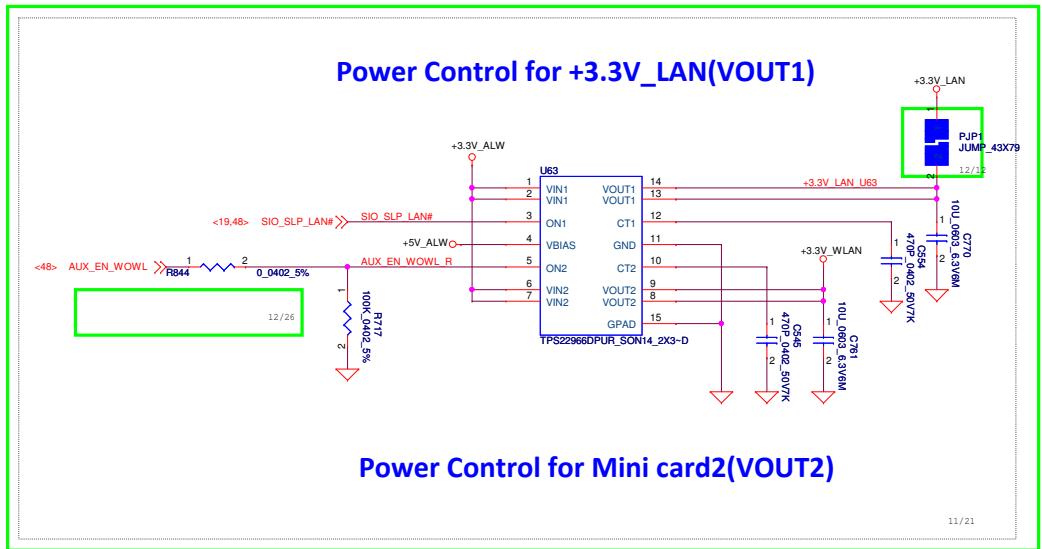


**10/16 symbol update ok.**

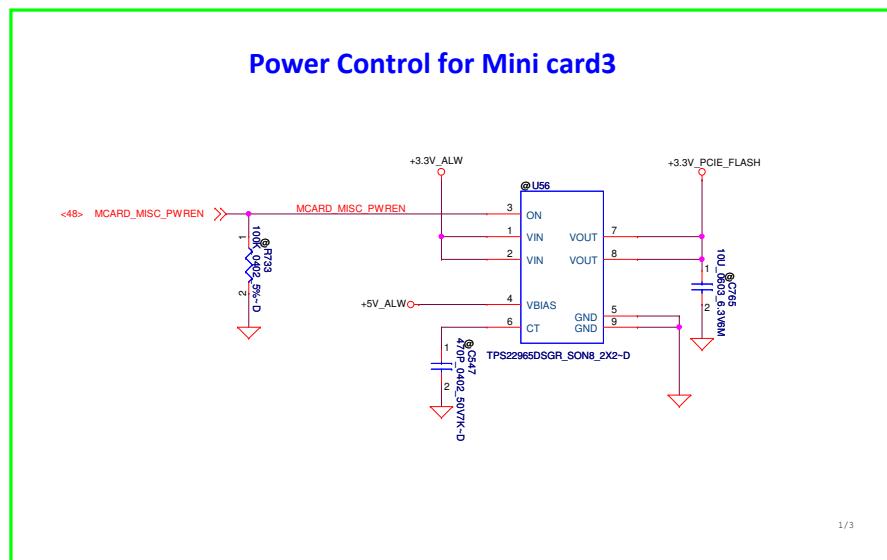
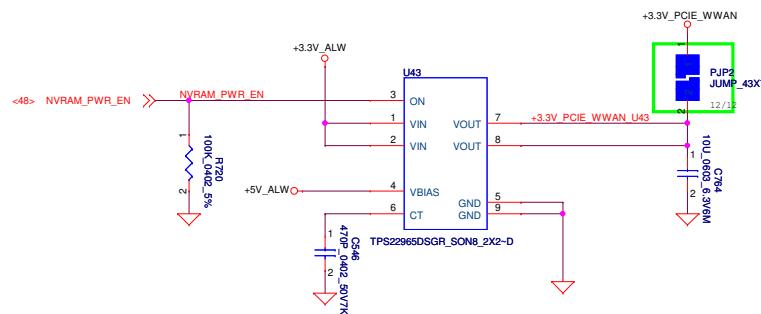
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

**DELL CONFIDENTIAL/PROPRIETARY**  
**Compal Electronics, Inc.**

Title	Size	Document Number	Rev
Mini Card-2/2		LA-9771P	0.2
	Date:	Tuesday, January 15, 2013	Sheet 44 of 65



**Power Control for Mini card1**



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

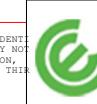
**DELL CONFIDENTIAL/PROPRIETARY**

**Compal Electronics, Inc.**

**Mini Card PWR**

**LA-9771P**

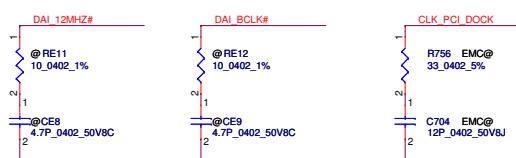
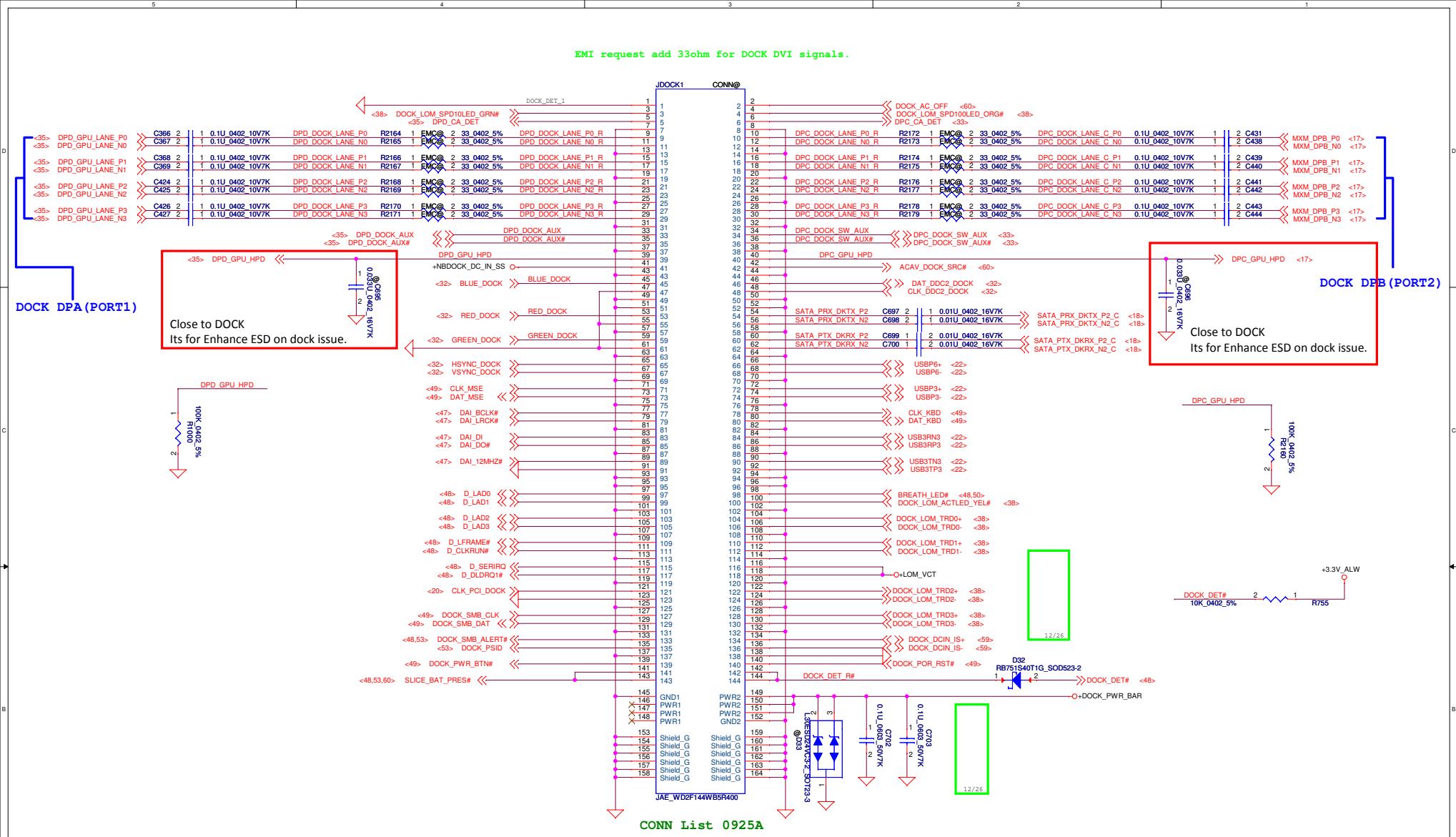
**Rev 0.2**



Date: Tuesday, January 15, 2013

Sheet 1

of 85



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY

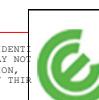
Compal Electronics, Inc.

Docking

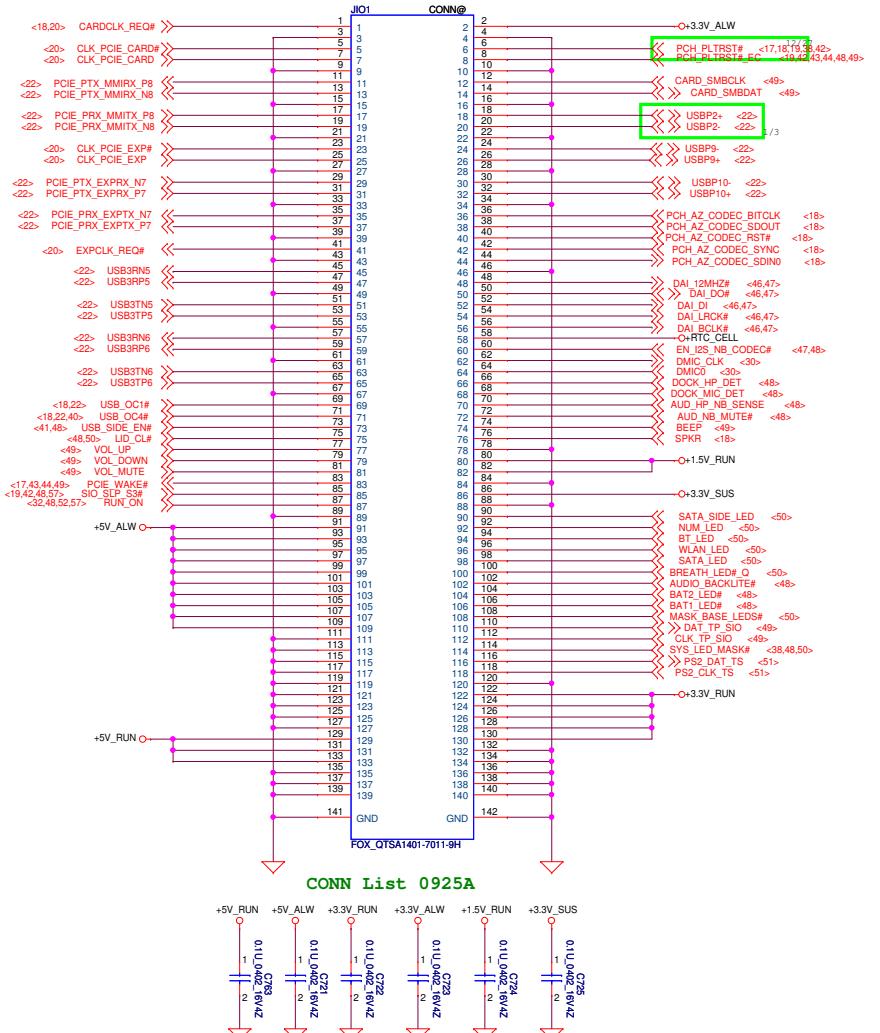
LA-9771P

Rev 0.2

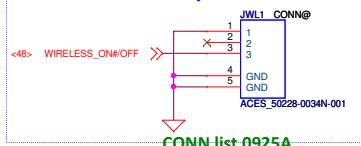
Date: Tuesday, January 15, 2013



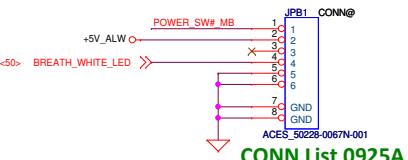
Sheet 46 of 89



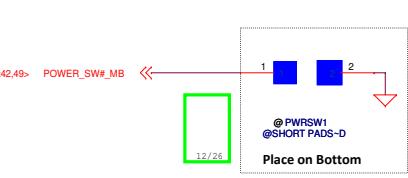
### Wireless ON/OFF CONN

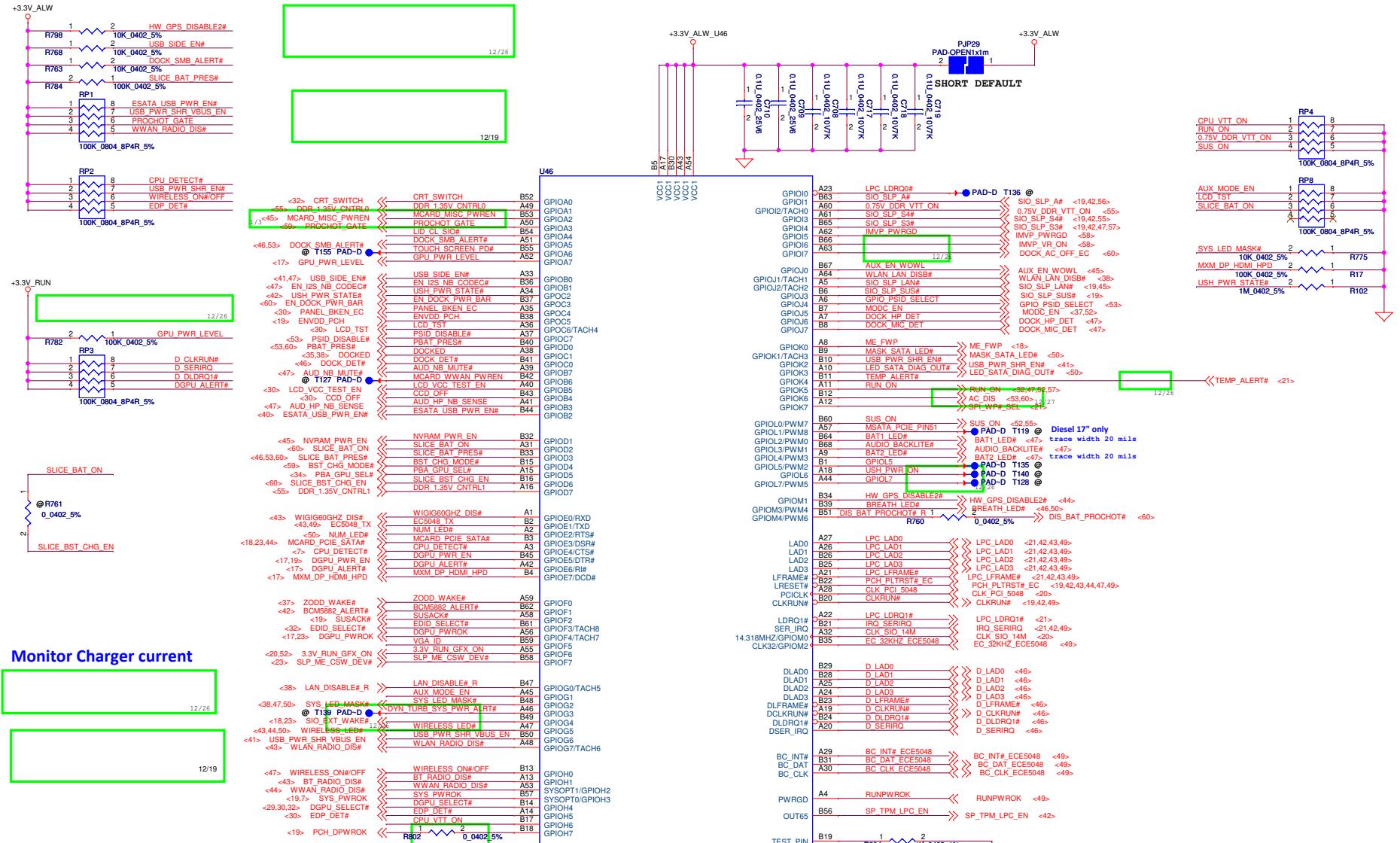


### Power Button CONN



### Power Switch for debug





## Monitor Charger current

DELL CONFIDENTIAL/PROPRIETARY



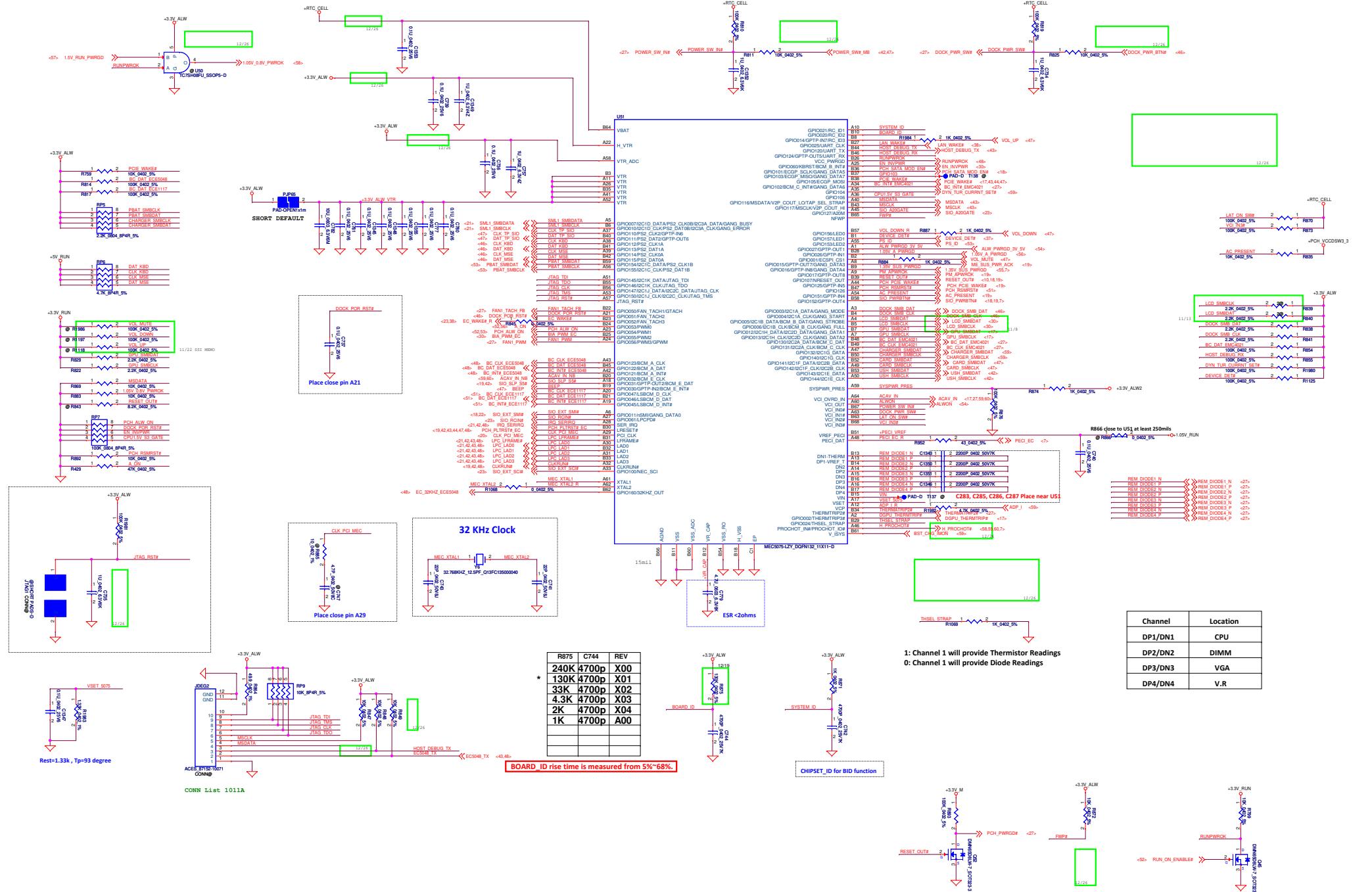
Compal Electronics, Inc.

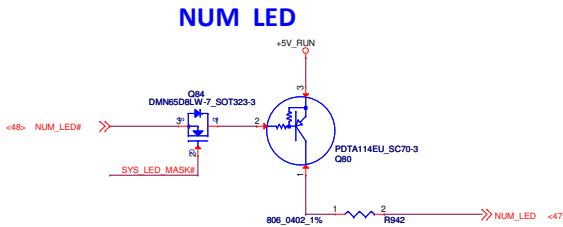
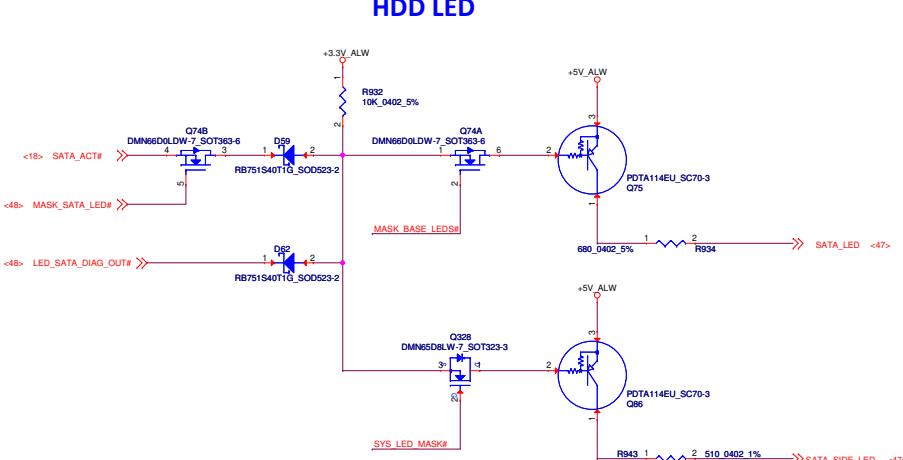
SIO

LA-977

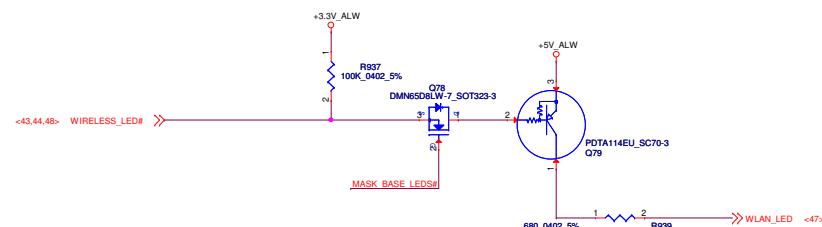
2013 Sheet 48 of

2013 Sheet 48 of 65

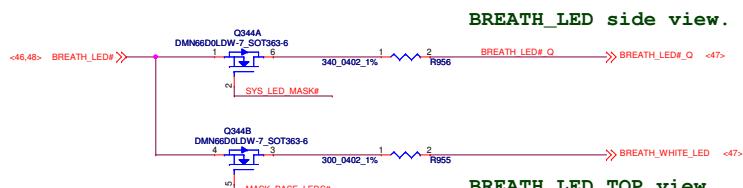




### WWAN/WLAN LED

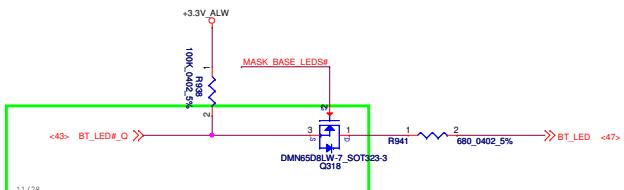


### Breath LED

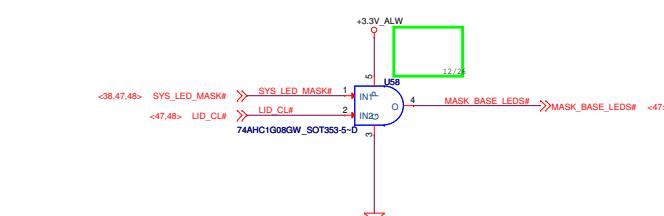
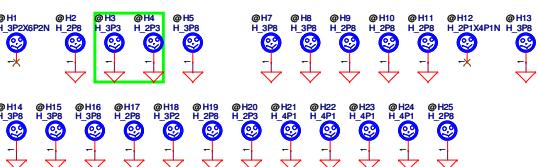
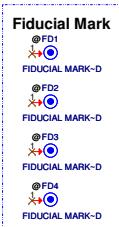


BREATH\_LED side view.

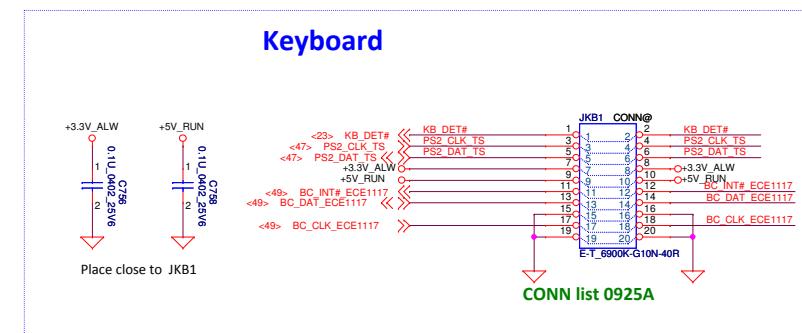
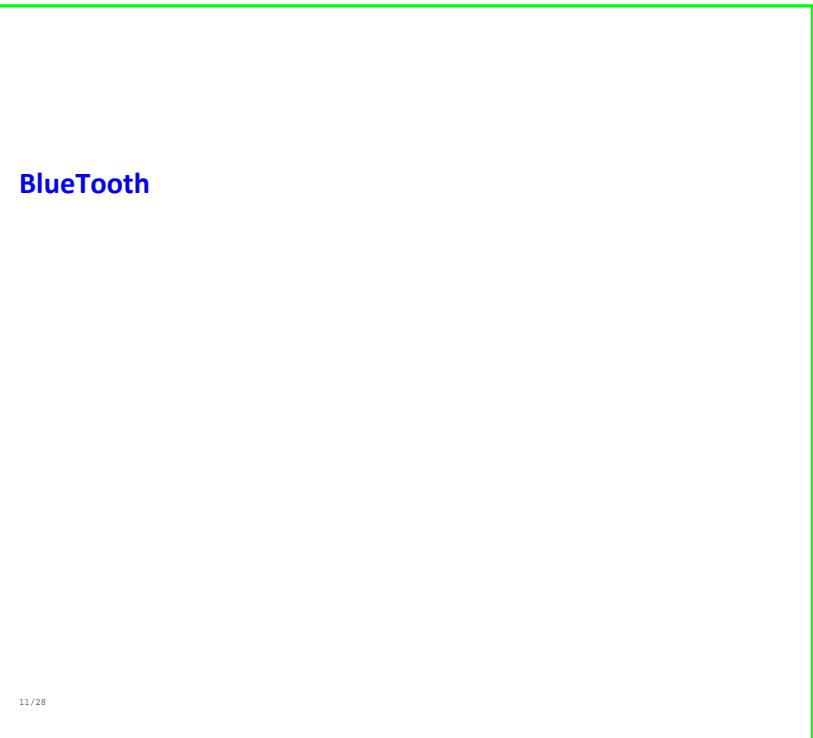
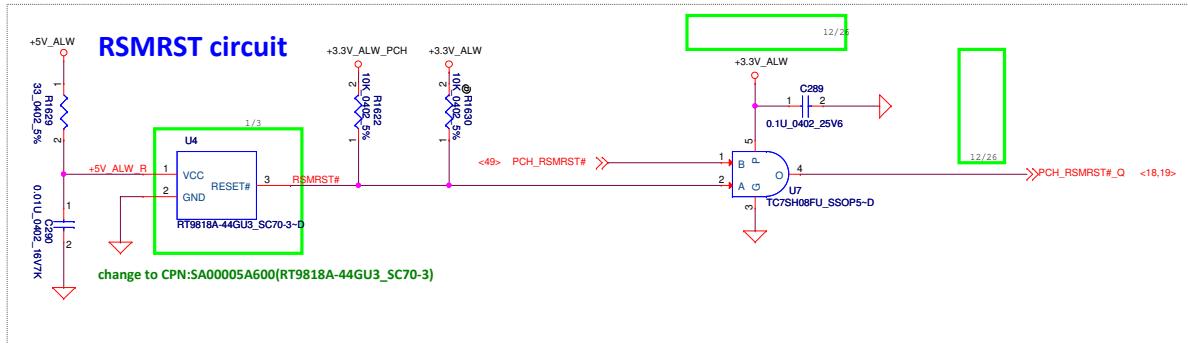
### BT LED



LED Circuit Control Table		
	SYS_LED_MASK#	LID_CL#
Mask All LEDs (Sniffer Function)	0	X
Mask Base MB LEDs (Lid Closed)	1	0
Do not Mask LEDs (Lid Opened)	1	1



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY

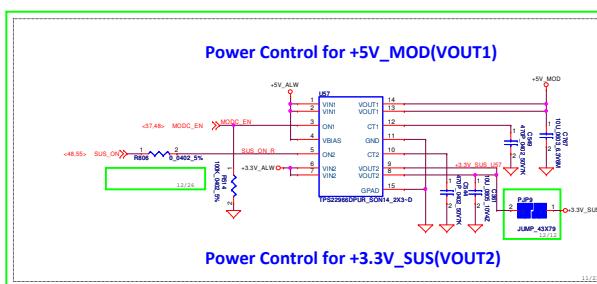
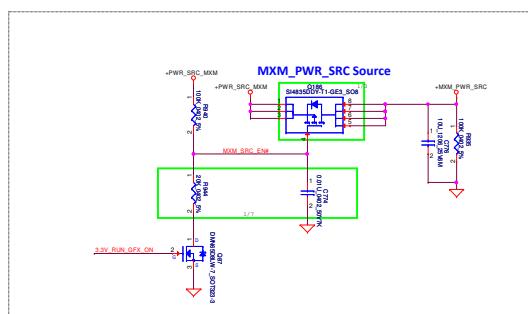
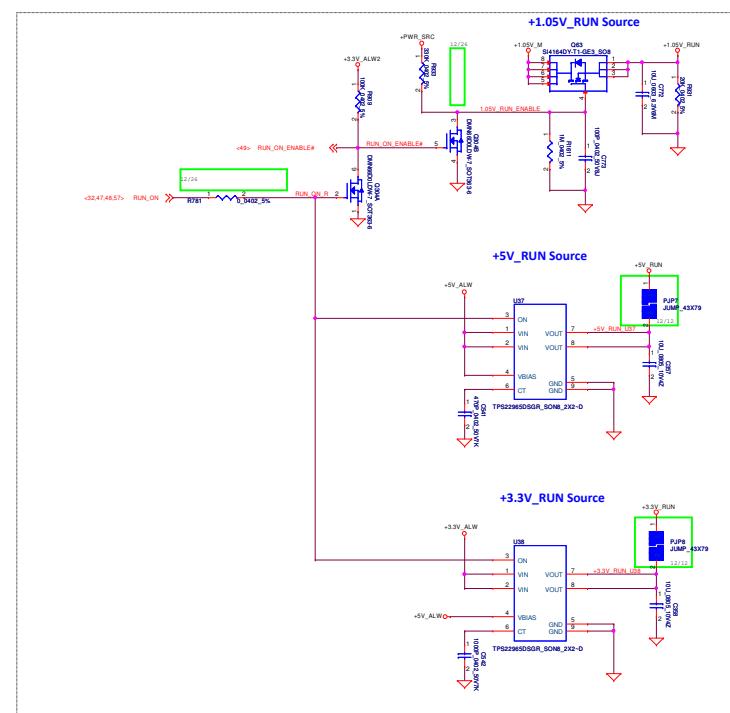
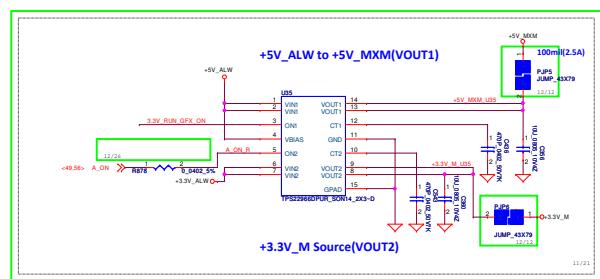
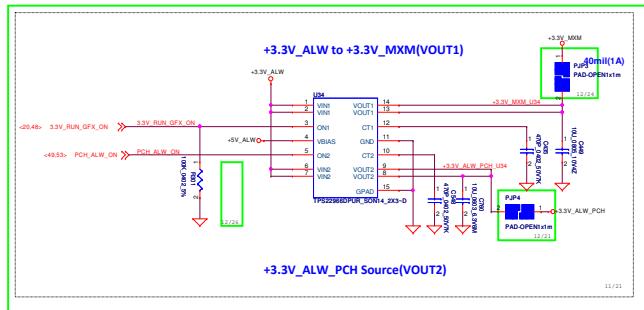
Compal Electronics, Inc.

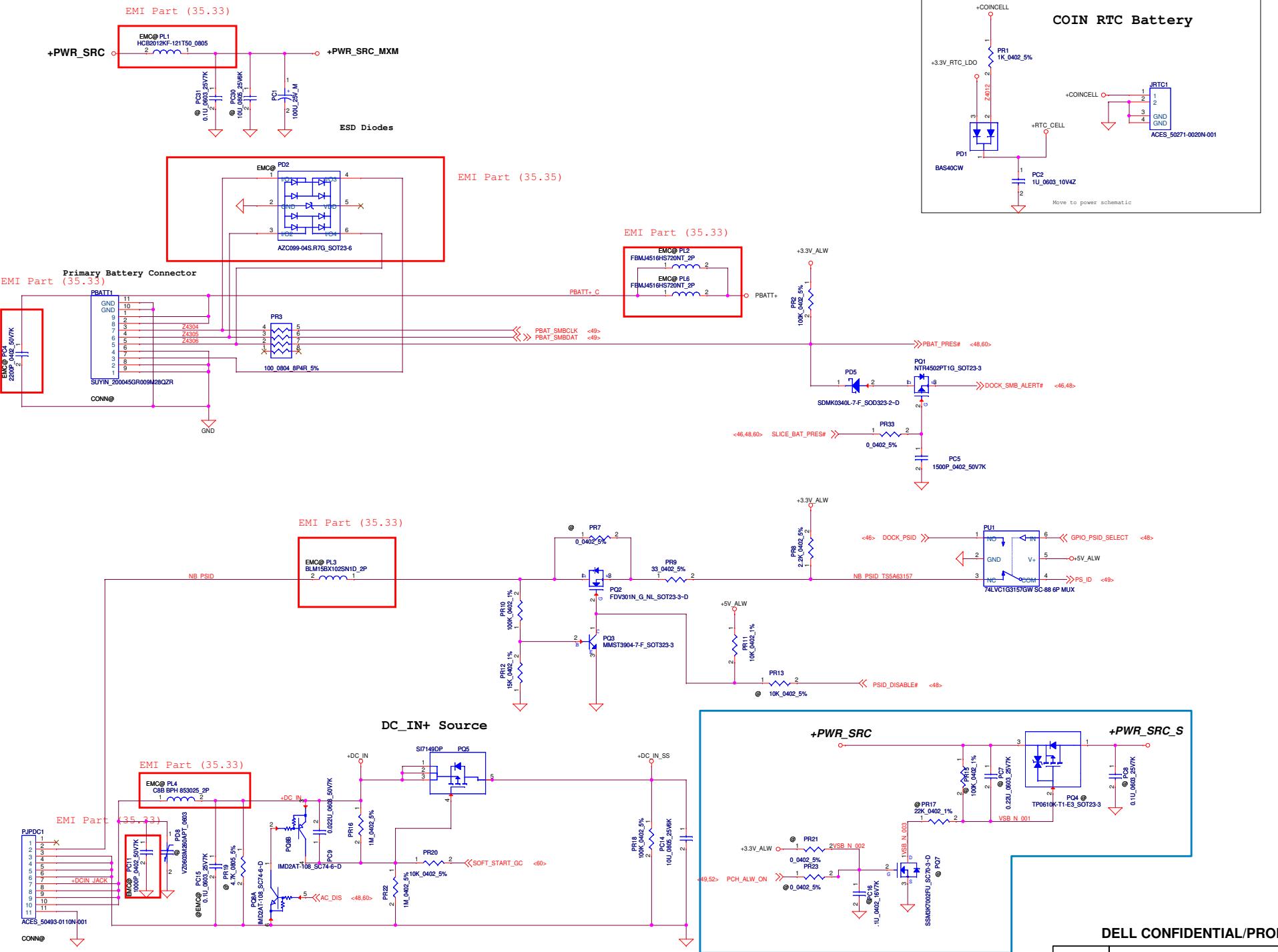
Touch PAD/Int KB

LA-9771P Rev 0.2

Date: Tuesday, January 15, 2013

Sheet 51 of 89

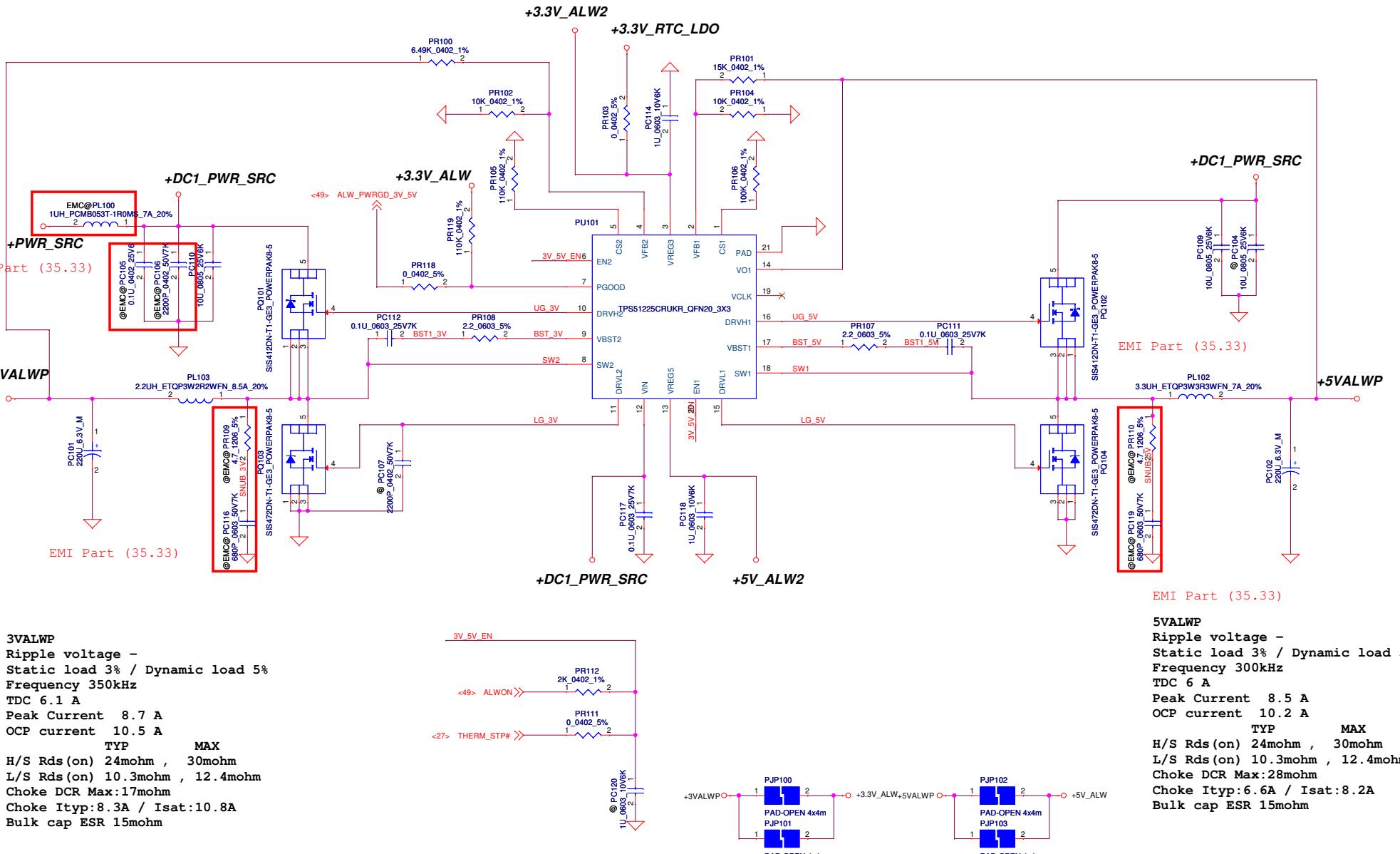




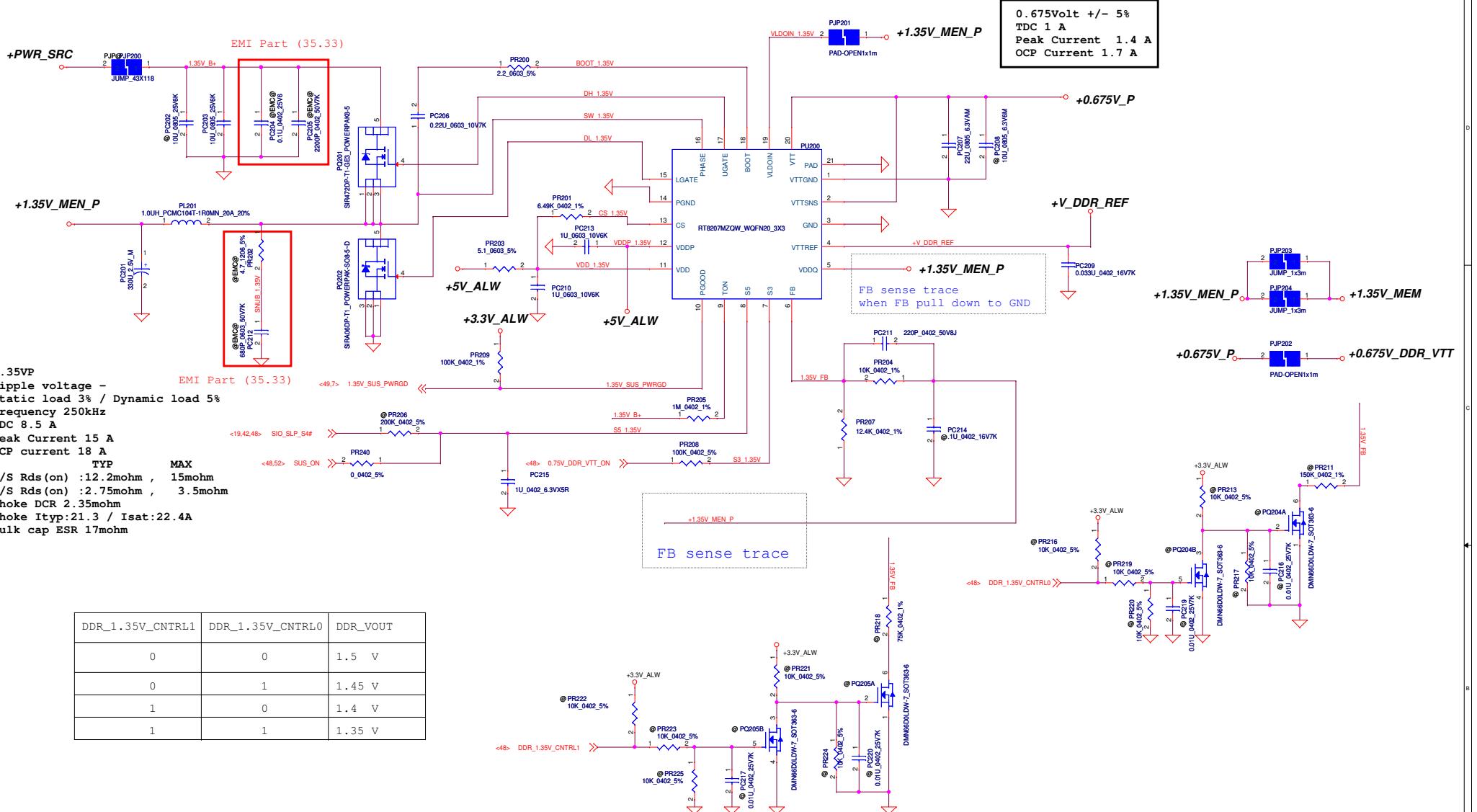
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPALELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT PARTY OR DEPARTMENT EXCEPT AS AUTHORIZED BY COMPALELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPALELECTRONICS, INC.

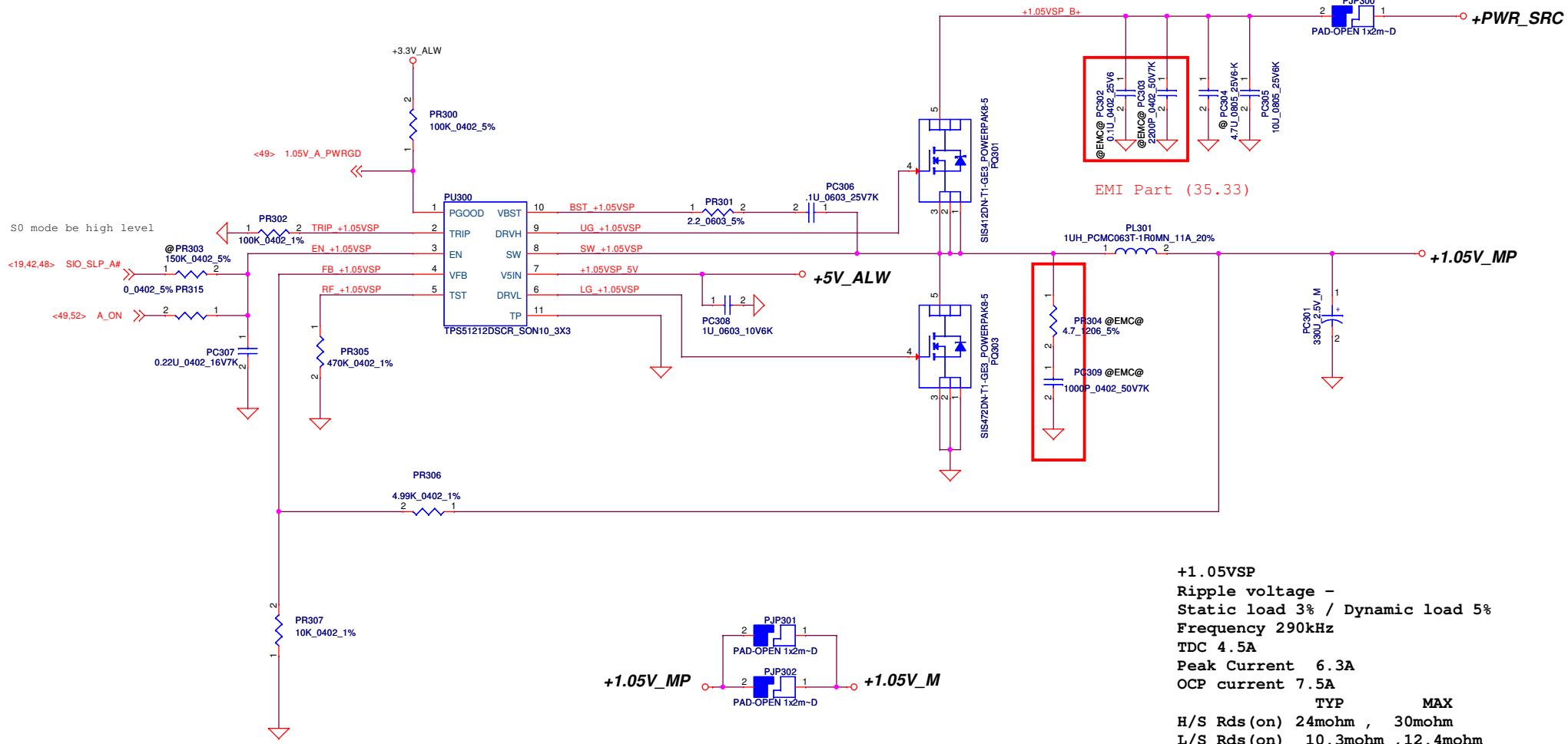
DELL CONFIDENTIAL/PROPRIETARY

	Compaq Electronics, Inc.	
	+DCIN	
Size	Document Number	Rev
	LA-9771P	0.2
Date	Tuesday, January 15, 2013	Sheet 53 of 65

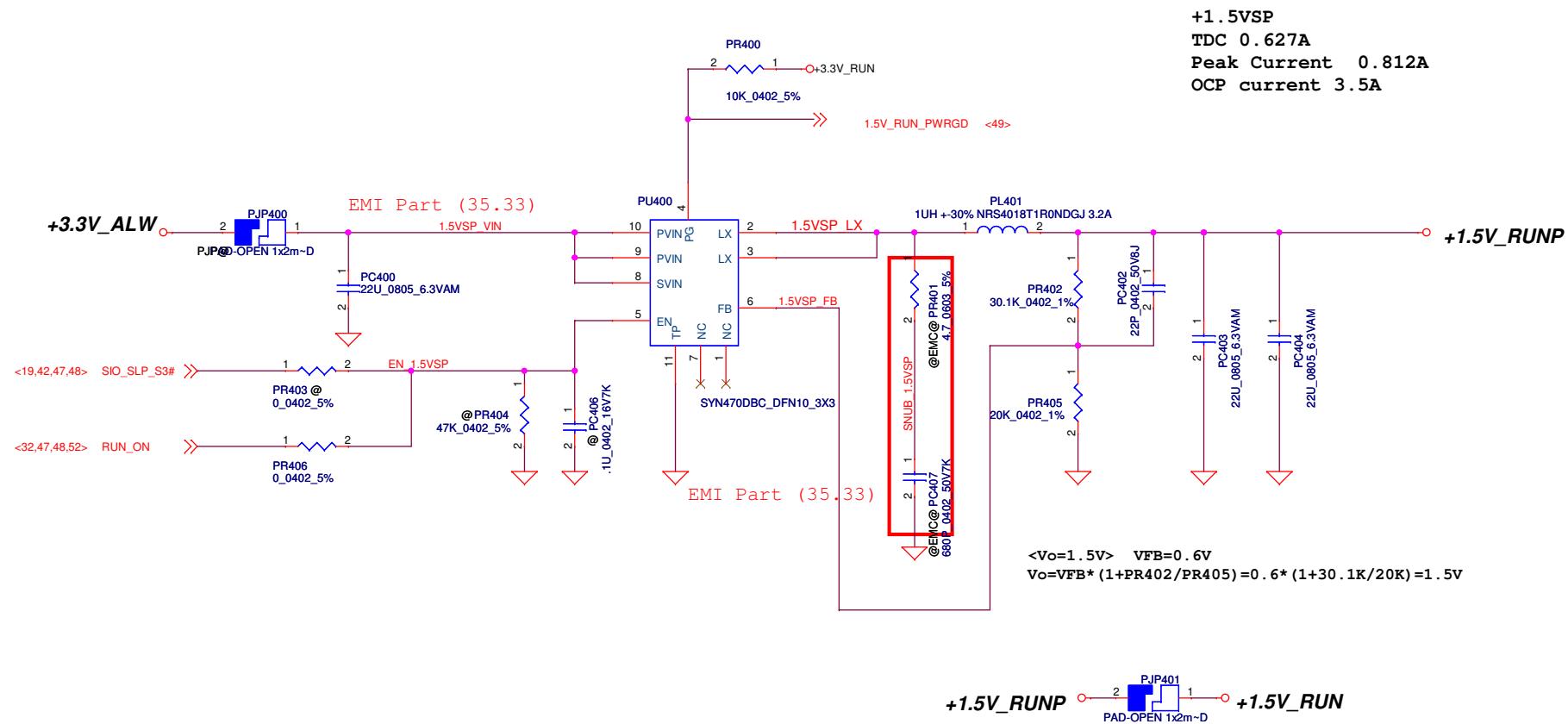


Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2012/01/17	Deciphered Date	2013/01/16 <th>Title</th> <td>PWR-3VALWP/5VALWP</td>	Title	PWR-3VALWP/5VALWP
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF THE COMPANY DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.					
Document Number	LA-9771P	Rev	0.2	Date	Tuesday, January 15, 2013

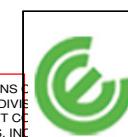




Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2012/01/17	Deciphered Date	2013/01/16	Title	PWR-+1.05VSP
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.					
Size	Document Number	Rev	LA-9771P	Date	Tuesday, January 15, 2013
		0.2		Sheet	56 of 65



DELL CONFIDENTIAL/PROPRIETARY



Compal Electronics, Inc.

Title PWR-1.5VSP

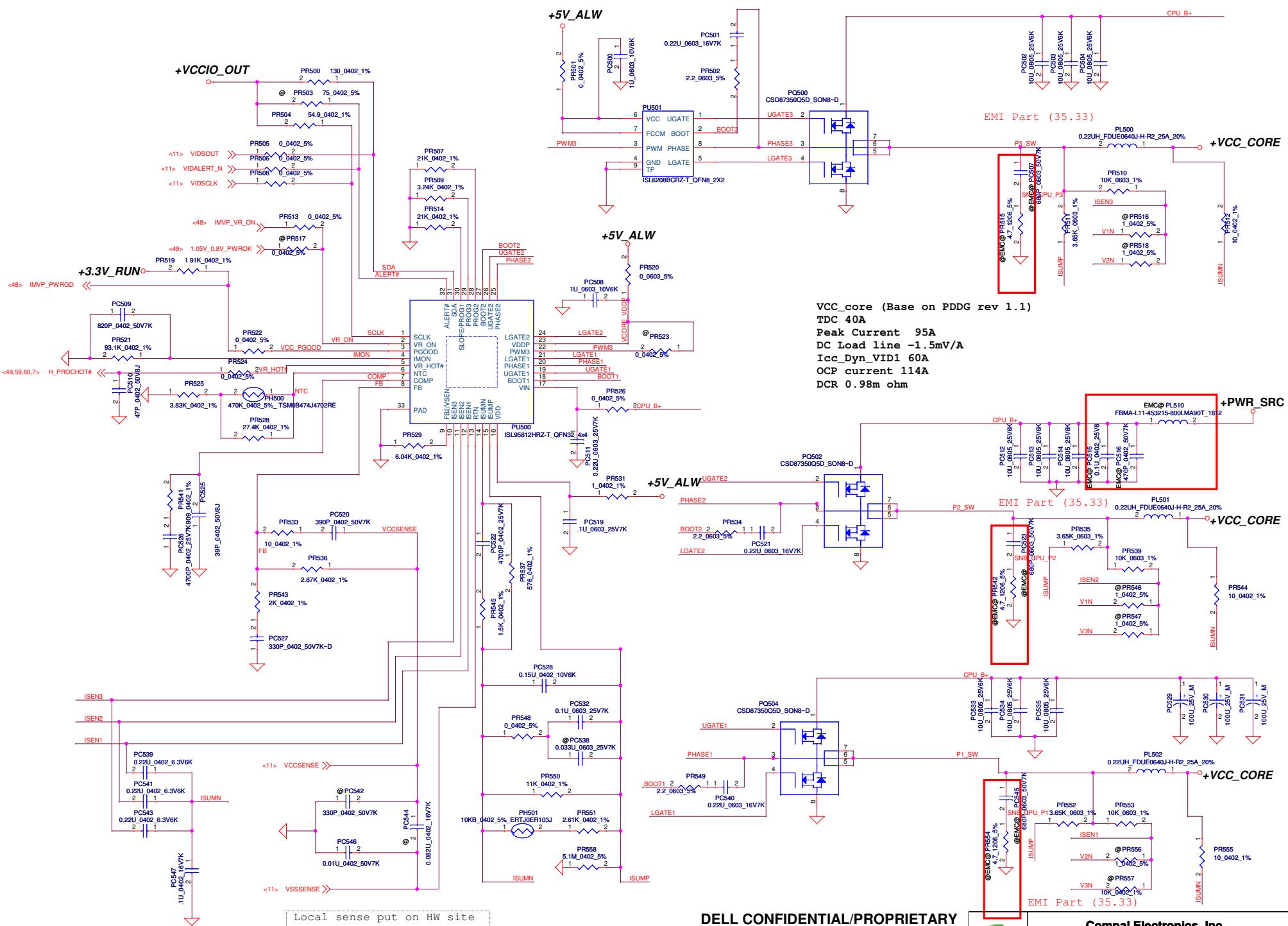
Size Document Number

LA-9771P

Rev 0.2

Date: Tuesday, January 15, 2013 Sheet 57 of 65

THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OR DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.



DELL CONFIDENTIAL/PROPRIETARY



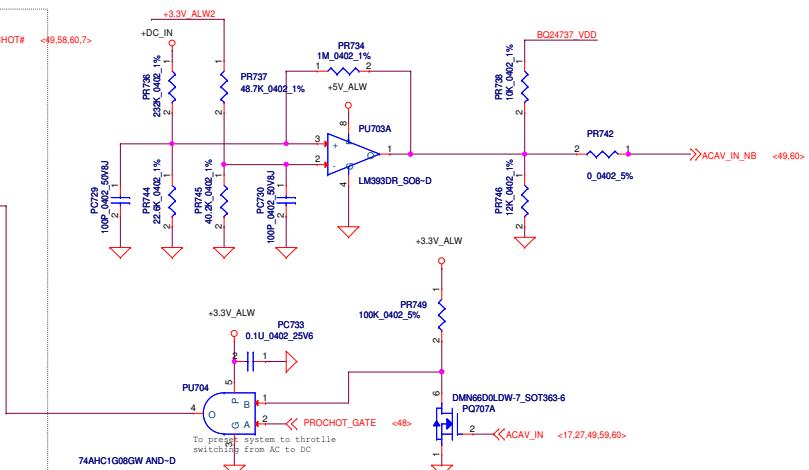
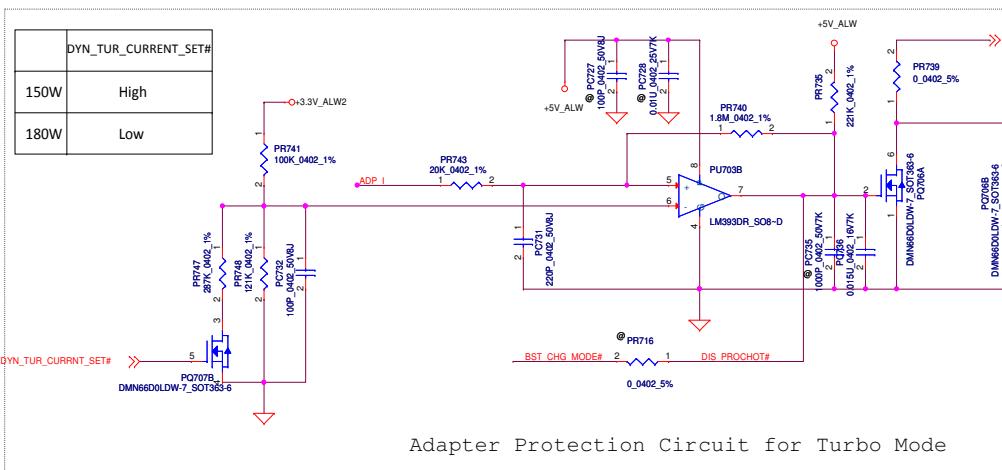
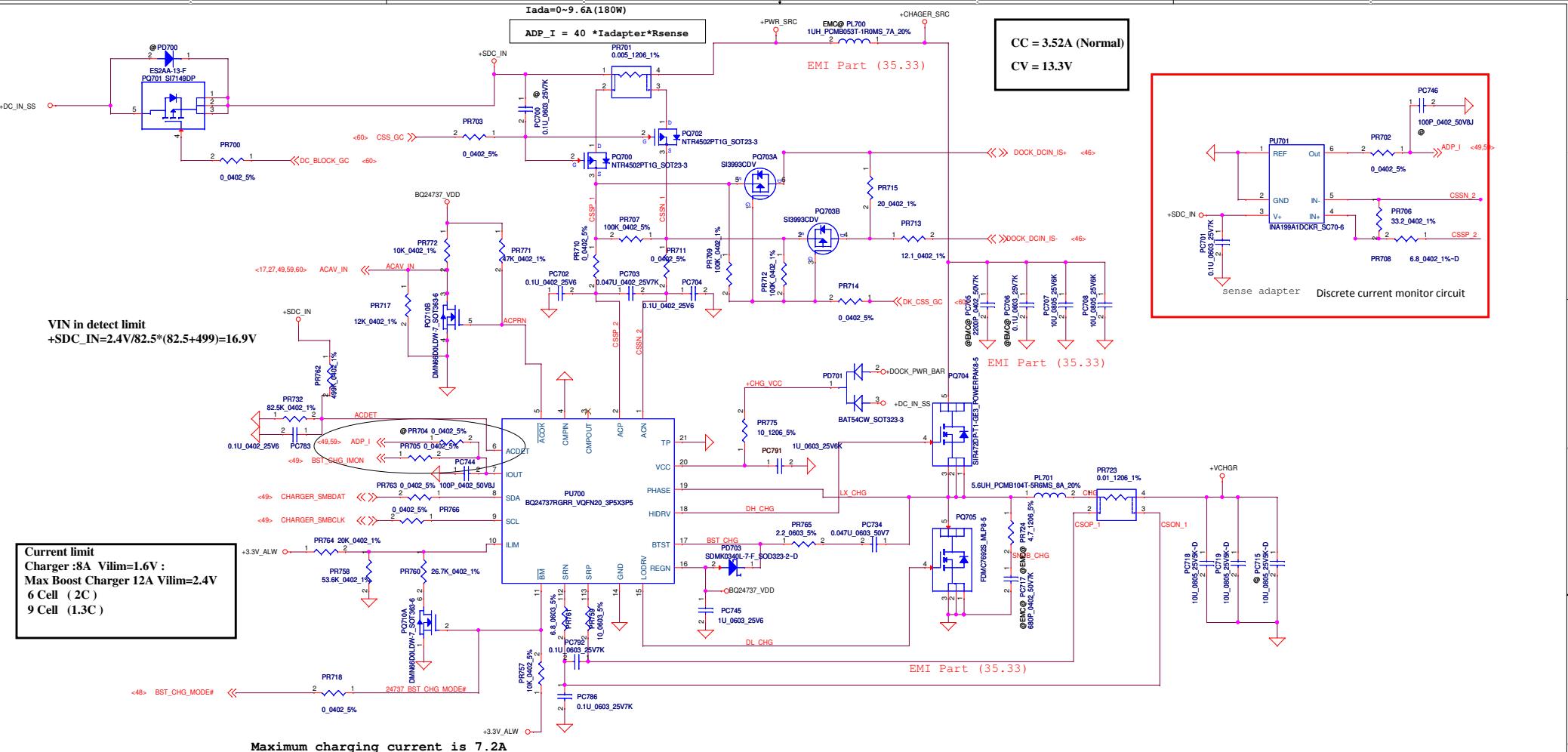
**Compal Electronics, Inc.**

+VCC\_COR

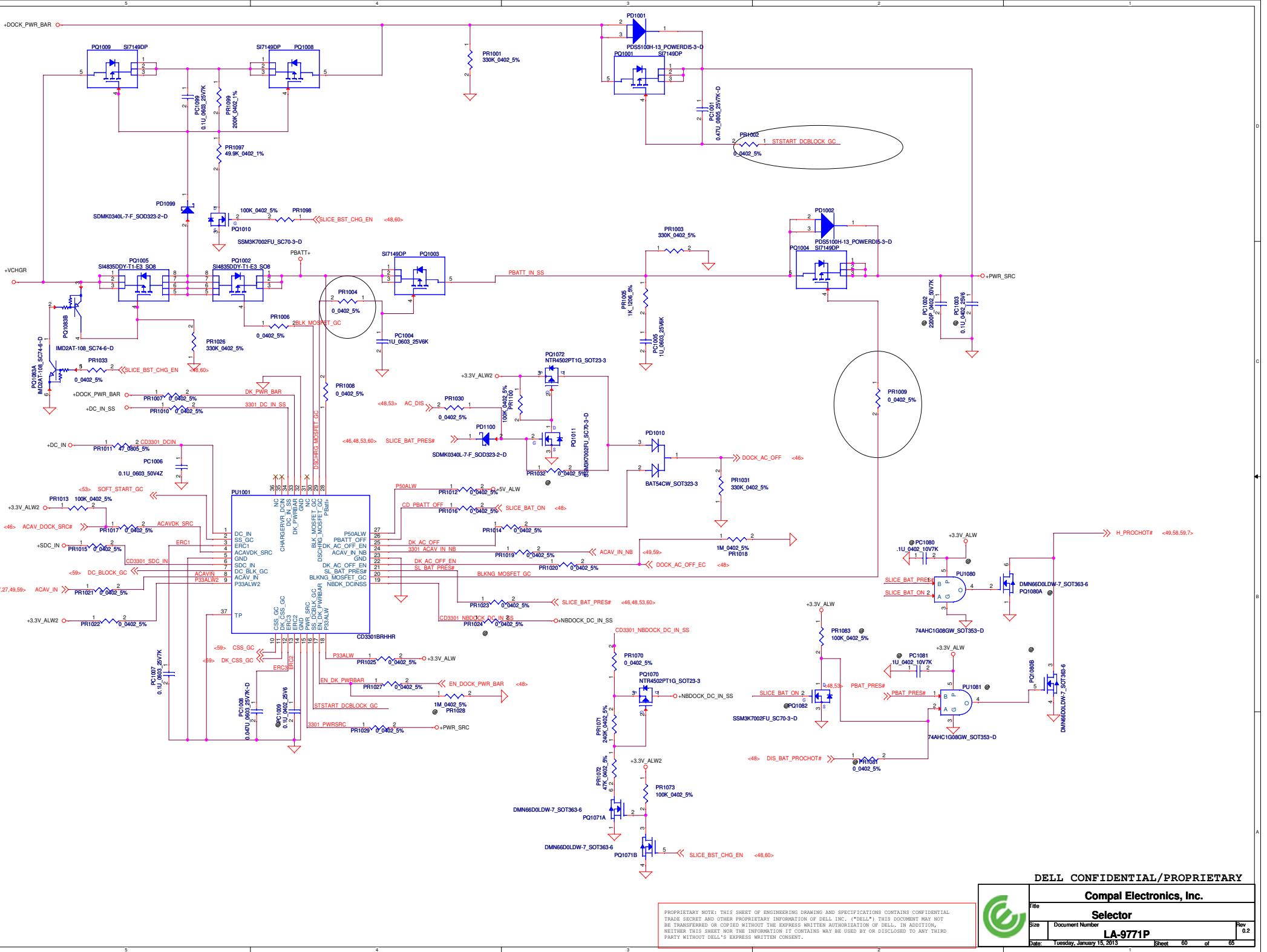
Document Number

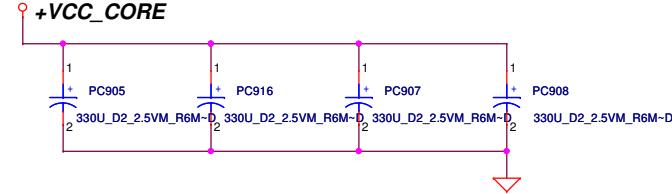
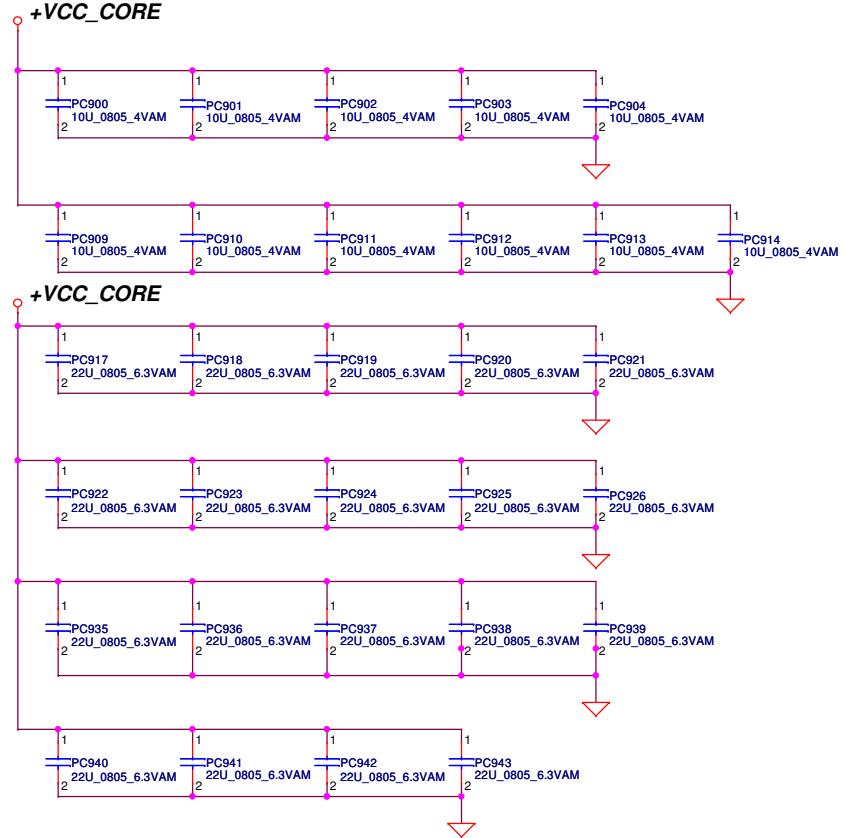
Tuesday, January 15, 2013 Sheet 58

THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPANY DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION CONTAINED HEREIN MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.

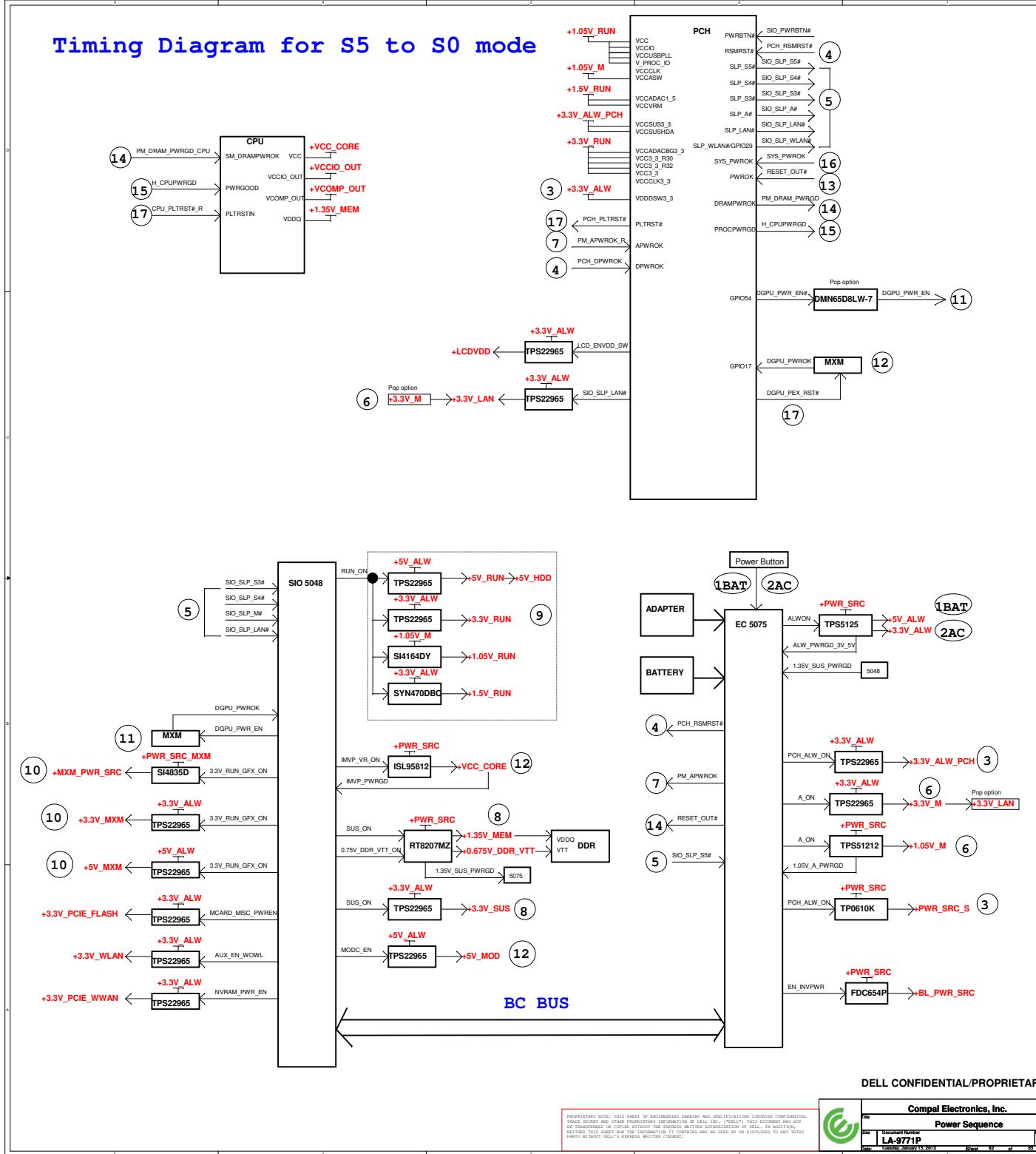


Security Classification	Compal Secret Data			Compal Electronics, Inc.		
Issued Date	2012/01/17	Deciphered Date	2013/01/16	Title	<b>PWR-Charger</b>	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Document Number	Rev. 0.2
				<b>LA-9771P</b>		Date: Tuesday, January 15, 2013   Sheet 59 of 65





## Timing Diagram for S5 to S0 mode



# Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	38	HW	10/30/2012	DELL	Both EC_WAKE# and LAN_WAKE# to be connected to GPIO27 of PCH	pop R556.	X01(0.2)
2	30	HW	11/21/2012	compal	Q24, U46(ECE5048) burned out issue on SSI build IPQC test.	Change JLVDS1.5~JLVDS1.15 pin define.	X01(0.2)
3	30, 49	HW	11/21/2012	compal	add BIST support(I2C solution) for QHD+ panel	add Q6,R161,R162. remove R239,R228. change MXM_EDP_HPD to JEPWRI.1 and BS of R839,R840 to 2@.	X01(0.2)
4	23	HW	11/21/2012	compal	intel ME Crypto TLS cipher suite with confidentiality.	pop RH37 and change to 1Kohm.de-pop RH62.	X01(0.2)
5	45, 52	HW	11/21/2012	compal	component reduce plan-merge load sw from 1ch/1chip to 2ch/1chip.	merge (U63,U42); (U57,U41); (U34,U36); (U35,U40) depend on actual layout routing.	X01(0.2)
6	9, 50, 49, 13 14, 15, 16	HW	11/22/2012	compal	SSI memo	change QC6 to SB00000Q000. de-pop C778,R1986,R1197,R1118,CD80,CD22,CD44,CD66,CD88	X01(0.2)
7	22, 42, 43, 50 51	HW	11/28/2012	DELL	BT 4.0 USB module dropped for ARD REV1.2	change Q318 to SOT323 package remove R2207,R33,R34,R702,C600,R707,R724,R694,D28,C748,C754,C753,R904, R1133,R1134,JBT1	X01(0.2)
8	20, 22, 43, 45 48	HW	11/28/2012	DELL	Pink Panther dropped for ARD REV1.2	change JMINI3 PWR from +3.3V_PCIE_FLASH to +3.3V_RUN remove C765,C547,R733,U56,C636,C626,C625,C635,C639,C634,C624,C637, C638,C633	X01(0.2)
9	30	HW	11/30/2012	compal	PS8723B EQ table error	correct EQ table follow vendor suggestion.LL=9.5dB,LH=13dB,HL=4.5dB,HH=7.5dB.	X01(0.2)
10	13, 14, 15, 16	HW	12/11/2012	INTEL	DDR Layout routing.	follow CRB DQ0~DQ63 distribution(DIMM1,DIMM3) and boardfile routing. DIMM2,DIMM4 depend on DIMM1,DIMM3 routing to define DQ0~DQ63.	X01(0.2)
11	45, 52	HW	12/12/2012	compal	battery life measure.	add PJP1,PJP2,PJP5~PJP9(JUMP_43X79), PJP3,PJP4(JUMP_43X39)	X01(0.2)
12	30	HW	12/12/2012	compal	panel sequence(LCDVDD tr=T1,PWR_SRC tr= T12)	change C555 from 0.1uF to 0.01uF,C297 from 1000pF to 0.47uF.	X01(0.2)
13	18, 20	HW	12/12/2012	compal	crystal EA	change CH4,CH5 from 18pF to 10pF;CH13,CH14 from 18pF to 12pF.	X01(0.2)
14	41	HW	12/14/2012	DELL	Charger current change to 1A.	change U2 to SLG55594AVTR(SA00006L600).	X01(0.2)
15	42	HW	12/19/2012	compal	APS pin define change for DG1.5	change JAPS1.7 to POWER_SW#_MB,remove R19,R31,R29.	X01(0.2)
16	7	HW	12/19/2012	INTEL	VCCIO_OUT 6KHz noise in shark Bay 2-chip platform	change CC66 from 0.1uF to 1uF and pop it.	X01(0.2)
17	49	HW	12/19/2012	compal	Board ID	change R875 from 240Kohm to 130Kohm.	X01(0.2)
18	30, 32, 48	HW	12/19/2012	ESD	ESD EA	remove D87,D13,D10,D11,C749,C750.	X01(0.2)
19	19, 48	HW	12/20/2012	compal	Deep Sleep feature support	pop R802,RH101,RH75,RH131;de-pop RH79,RH91.	X01(0.2)
20	11, 14	HW	12/20/2012	compal	1.35v decoupling cap reduce	de-pop CD34,CC36,CC35,CC40,CC169,CC166,CC165,CD36,CC38,CC33, CC42,CC37,CC41,CC163,CC170,CC171,CC168,CC164	X01(0.2)
21	41	HW	12/20/2012	compal	Layout routing	Swap D15 D+,D-; L39 D+,D-.	X01(0.2)
22	14, 16, 30, 52	HW	1/7/2012	compal	inrush current EA	add R944(20Kohm), change C774 from 2200P to 0.01U for +MXM_PWR_SRC. de-pop CD37,CD38,CD82,CD83 for +0.675V_DDR_VTT. de-pop C300 for +3.3V_RUN glith during turn on +CAMERA_VDD.	X01(0.2)
23	48	HW	12/27/2012	DELL	AC_DIS# polarity is inverted.	AC_DIS# signal change to AC_DIS,due to it's high active for "Peak Shift".	X01(0.2)
24	23, 42	HW	1/2/2013	compal	USH/B drop O2 solution in X5.	remove netname"SMART_DET#".	X01(0.2)

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY		
Compal Electronics, Inc.		
Title		
EE P.I.R (1/1)		
Size	Document Number	Rev.
	LA-9771P	0.2
Date:	Wednesday, January 16, 2013	Sheet
	63	of
	65	

# Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
25	18,51,52	HW	1/3/2013	compal	replace X1 code component for LOAD BOM.	change U4 to SA00005A600, QH2 to SB501380020, Q186 to SB00000FF00.	X01(0.2)
26	38	HW	1/3/2013	compal	LAN EA.	change R570, R575~R581(0ohm) to L63~L70(12nH).	X01(0.2)
27	20,22,43,45 48	HW	1/3/2013	DELL	Add Pink Panther and reserve them.	add R707, R708, C765, C547, R733, U56, C636, C626, C639, C634, C624, C637, C638, C633	X01(0.2)
28	47	HW	1/3/2013	compal	USBP0+/- layout routing.	swap USBP2+/- from JIO1.20/JIO1.18 to JIO1.18/JIO1.20.	X01(0.2)
29	23,42	HW	1/7/2013	compal	reserved routing SP TPM LPC EN on PCH GPIO22 for GPIO MAP3.0	add R2189, RH209, depop RH208, change netname PCH_GPIO22 to PCH_TPM_EN.	X01(0.2)
30	44	ME	1/4/2013	compal	connector List 1217A	change JSIM1 from T-SOL_159-1000302600 to T-SOL_159-1000302602 (SP011212271).	X01(0.2)
31	43	HW	1/7/2013	compal	modify netname and cap placement.	add +3.3V_PCIE_FLASH_R on R708.1 and change C639.1 net to +3.3V_PCIE_FLASH_R.	X01(0.2)
32	50	ME	1/7/2013	compal	screw hole change.	change H3 to 3P3, H4 to 2P3.	X01(0.2)
33	13,16	HW	1/8/2013	compal	DFX repair issue.	pop CD80, depop CD14.	X01(0.2)
34	30	HW	1/8/2013	compal	change main source circuit design for phase in LCDVDD PWR SW 2nd source.	add R709, depop C555.	X01(0.2)
35	37	HW	1/8/2013	compal	R796.1 PWR plane error.	change R796.1 PWR plane from +3.3V_ALW to +3.3V_ALW_PCH.	X01(0.2)
36	19,48	HW	1/8/2013	compal	reserve non-DS3 function circuit	add R802, RH101, RH79, RH91	X01(0.2)
37	42	HW	1/9/2013	compal	TPM chip change version to DX4A12.	change U39 to SA00004WO40(AT97SC3204-DX4A12-ABF).	X01(0.2)
38	23	BIOS	1/10/2013	compal	let EC set U46.B3(MCARD_PCIE_SATA#) as OD to save power same as Goliad/salado.	change RH226.2 from GND to pull up +3.3V_RUN	X01(0.2)
39	30,40,41	EMI	1/11/2013	compal	EMI request change USB2.0 choke.	change L10, L39, L41, L51 to DLW21HN900SQ2L(SM070001N00).	X01(0.2)

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY		
Compal Electronics, Inc.		
Title		
EE P.I.R (1/1)		
Size	Document Number	Rev.
LA-9771P		0.2
Date:	Wednesday, January 16, 2013	Sheet 64 of 65

# Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	55	PWR	11/29/2012	COMPAL	For 1.35V selector	Unpop PR225, PR224, PR218, PR220, PR217, PR211, PR222, PR223, PC217 PQ205, PR221, PC220, PR216, PR219, PC219, PQ204, PR213, PC216	X01
2	54	PWR	11/29/2012	COMPAL	For 3.3V OCP setting	Change PR105 to 90.9K	X01
3	57	PWR	11/29/2012	COMPAL	For 1.5V output voltage setting	Change PR402 to 30.1K, PR405 to 20K	X01
4	54	PWR	11/29/2012	COMPAL	For 3.3V/5V output voltage setting	Change PR102 and PR104 to 10K 1%	X01
5	58	PWR	11/29/2012	COMPAL	Change better Vcore MOSFET	Change PQ500, PQ502, PQ504 to CSD87350Q5D	X01
6	53	PWR	12/11/2012	COMPAL	Main source have x1 code	Change PQ1, PQ1070 to SB0000H500	X01
7	53	PWR	12/11/2012	COMPAL	Main source have x1 code	Change PU1 to SA00003DN00	X01
8	59	PWR	12/11/2012	COMPAL	For part count reduction	Combine PQ707, PQ708 to SB00000DH01	X01
9	56	PWR	12/11/2012	COMPAL	For part count reduction	Unpop PC304, change PC305 to SE00000QK00	X01
10	55	PWR	12/11/2012	COMPAL	For part count reduction	Unpop PC208, change PC207 to SE000008L80	X01
11	55	PWR	12/20/2012	COMPAL	Unite to same part number	Change PQ1, PQ1070 to SB000007900	X01
12	58	PWR	12/20/2012	COMPAL	For EMI test	Pop PC515	X01
13	55	PWR	12/21/2012	COMPAL	For cost down	Change PL201 to SH000004S00, PL701 to SH00000PO00	X01
14	60	PWR	12/26/2012	COMPAL	For Japan's Energy star	Add PQ1072, PQ1011, PD1010, PR1030, PD1100, PR1100, PR1031, PR1032	X01
15	60	PWR	12/26/2012	COMPAL	For boost charger behavior	Add PR1026, PQ1083	X01
16	59	PWR	12/26/2012	COMPAL	For current sense accuracy	Change PR706=33.2ohm, PR708=6.8ohm, PR713=12.1ohm, PR715=20ohm	X01
17	58	PWR	01/03/2013	COMPAL	For Vcore compensation	Add PR558=5.1Mohm, PC509=820pF	X01
18	58	PWR	01/03/2013	COMPAL	For EMI request	Pop PC516=470pF	X01
19	59	PWR	01/07/2013	COMPAL	Unite to same part number	Change PD703 to SCS0340L010	X01
20	53	PWR	01/07/2013	COMPAL	Change to small size bead	Change PL3 to SM01000MB00	X01
21	59	PWR	01/08/2013	COMPAL	Refer to E5	Change PR737.1 to +3.3V_ALW2	X01
A							

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL"). THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY		
Compal Electronics, Inc.		
Title: PWR P.I.R (1/1)		
Size	Document Number	Rev. 0.2
LA-9771P		
Date: Tuesday, January 15, 2013	Sheet 85	of 65